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April 1st, 2010
Renesas Electronics Corporation

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1. Overview

The M32C/84 group (M32C/84, M32C/84T) microcomputer is a single-chip control unit that utilizes high-performance silicon gate CMOS technology with the M32C/80 series CPU core. The M32C/84 group (M32C/84, M32C/84T) is available in 144-pin and 100-pin plastic molded LQFP/QFP packages.

With a 16-Mbyte address space, this microcomputer combines advanced instruction manipulation capabilities to process complex instructions by less bytes and execute instructions at higher speed.

It includes a multiplier and DMAC adequate for office automation, communication devices and industrial equipments, and other high-speed processing applications.

1.1 Applications

Automobiles, audio, cameras, office equipment, communications equipment, portable equipment, etc.

1.2 Performance Overview

Tables 1.1 and 1.2 list performance overview of the M32C/84 group (M32C/84, M32C/84T).

Table 1.1 M32C/84 Group (M32C/84, M32C/84T) Performance (144-Pin Package)

Characteristic		Performance	
		M32C/84	M32C/84T
CPU	Basic Instructions	108 instructions	
	Shortest Instruction Execution Time	31.3 ns (f(BCLK)=32 MHz, V_{CC1}=4.2 V to 5.5 V) 41.7 ns (f(BCLK)=24 MHz, V_{CC1}=3.0 V to 5.5 V)	31.3 ns (f(BCLK)=32 MHz, V_{CC1}=4.2 V to 5.5 V)
	Operation Mode	Single-chip mode, Memory expansion mode and Microprocessor mode	Single-chip mode
	Address Space	16 Mbytes	
	Memory Capacity	See Table 1.3	
Peripheral Function	I/O Port	123 I/O pins and 1 input pin	
	Multifunction Timer	Timer A: 16 bits x 5 channels, Timer B: 16 bits x 6 channels Three-phase motor control circuit	
	Intelligent I/O	Time measurement function or Waveform generating function: 16 bits x 8 channels Communication function (Clock synchronous serial I/O, Clock asynchronous serial I/O, HDLC data processing)	
	Serial I/O	5 Channels Clock synchronous serial I/O, Clock asynchronous serial I/O, IEBus(1), I^2C bus(2)	
	CAN Module	1 channel Supporting CAN 2.0B specification	
	A/D Converter	10-bit A/D converter: 1 circuit, 34 channels	
	D/A Converter	8 bits x 2 channels	
	DMAC	4 channels	
	DMAC II	Can be activated by all peripheral function interrupt sources Immediate transfer, Calculation transfer and Chain transfer functions	
	CRC Calculation Circuit	CRC-CCITT	
	X/Y Converter	16 bits x 16 bits	
	Watchdog Timer	15 bits x 1 channel (with prescaler)	
	Interrupt	38 internal and 8 external sources, 5 software sources Interrupt priority level: 7	
	Clock Generation Circuit	4 circuits Main clock oscillation circuit(*), Sub clock oscillation circuit(*), On-chip oscillator, PLL frequency synthesizer (*)Equipped with a built-in feedback resistor. Ceramic resonator or crystal oscillator must be connected externally	
	Oscillation Stop Detect Function	Main clock oscillation stop detect function	
	Voltage Detection Circuit	Available (optional)	Not available(4)
Electrical Characteristics	Supply Voltage	V_{CC1}=4.2 V to 5.5 V, V_{CC2}=3.0 V to V_{CC1} (f(BCLK)=32 MHz) V_{CC1}=3.0 V to 5.5 V, V_{CC2}=3.0 V to V_{CC1} (f(BCLK)=24 MHz)	V_{CC1}=V_{CC2}=4.2 V to 5.5 V, (f(BCLK)=32 MHz)(3)
	Power Consumption	28 mA (V_{CC1}=V_{CC2}=5 V, f(BCLK)=32 MHz) 22 mA (V_{CC1}=V_{CC2}=3.3 V, f(BCLK)=24 MHz) 10µA (V_{CC1}=V_{CC2}=5 V, f(BCLK)=32 kHz, in wait mode)	28 mA (V_{CC1}=V_{CC2}=5 V, f(BCLK)=32 MHz) 10µA (V_{CC1}=V_{CC2}=5 V, f(BCLK)=32 kHz, in wait mode)
Flash Memory	Program/Erase Supply Voltage	3.3 V ± 0.3 V or 5.0 V ± 0.5 V	5.0 V ± 0.5 V
	Program and Erase Endurance	100 times (all space)	
Operating Ambient Temperature		–20 to 85°C –40 to 85°C (optional)	–40 to 85°C (T version)
Package		144-pin plastic molded LQFP	

NOTES:
1. IEBus is a trademark of NEC Electronics Corporation.
2. I^2C bus is a trademark of Koninklijke Philips Electronics N. V.
3. The supply voltage of M32C/84T (High-reliability version) must be V_{CC1}=V_{CC2}.
4. The cold start-up/warm start-up determine function is available only at the user's option.

All options are on a request basis.

Table 1.2 M32C/84 Group (M32C/84, M32C/84T) Performance (100-Pin Package)

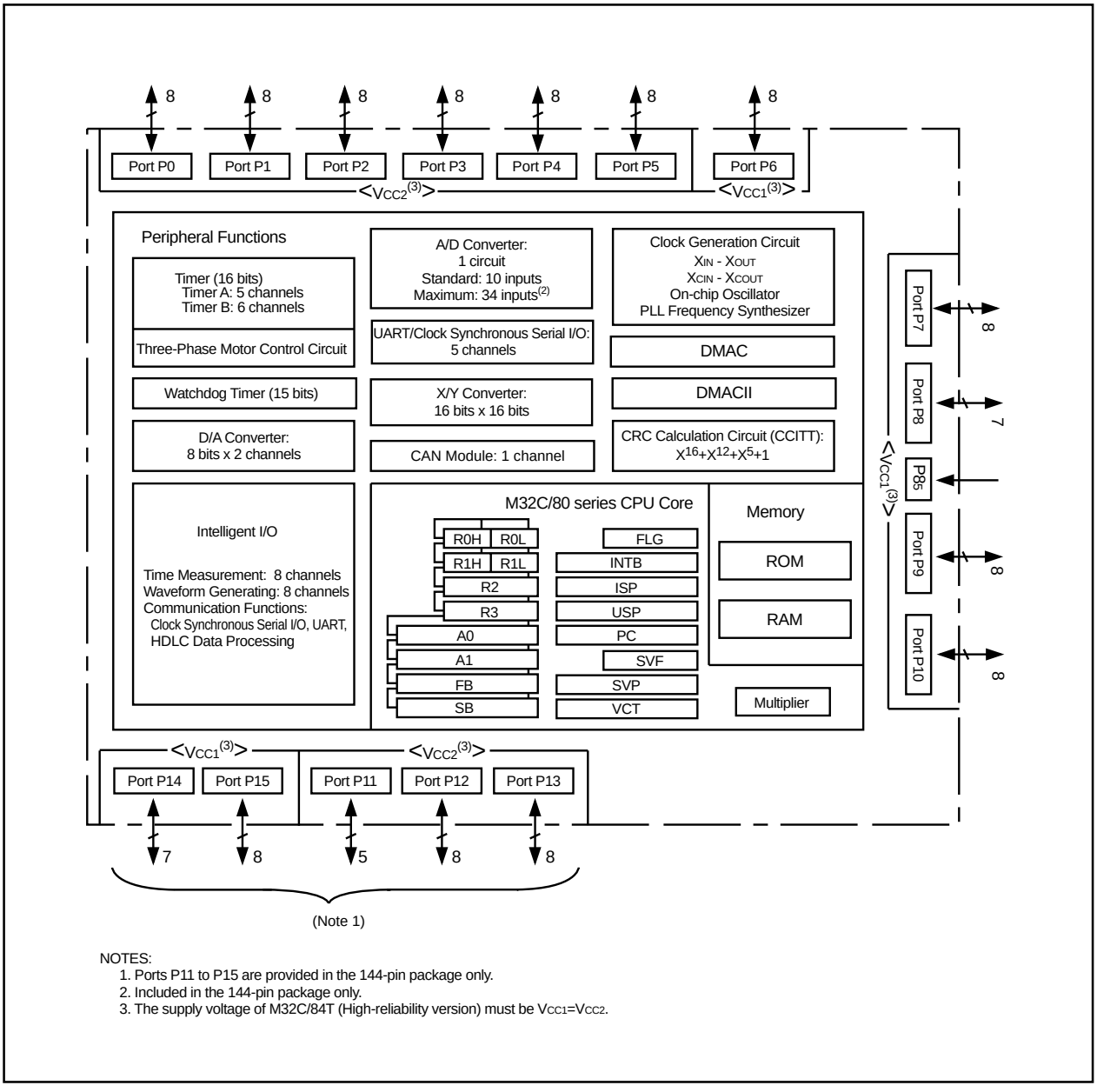
Characteristic		Performance	
		M32C/84	M32C/84T
CPU	Basic Instructions	108 instructions	
	Shortest Instruction Execution Time	31.3 ns (f(BCLK)=32 MHz, V_{CC1}=4.2 V to 5.5 V) 41.7 ns (f(BCLK)=24 MHz, V_{CC1}=3.0 V to 5.5 V)	31.3 ns (f(BCLK)=32 MHz, V_{CC1}=4.2 V to 5.5 V)
	Operation Mode	Single-chip mode, Memory expansion mode and Microprocessor mode	Single-chip mode
	Address Space	16 Mbytes	
	Memory Capacity	See Table 1.3	
Peripheral Function	I/O Port	87 I/O pins and 1 input pin	
	Multifunction Timer	Timer A: 16 bits x 5 channels, Timer B: 16 bits x 6 channels Three-phase motor control circuit	
	Intelligent I/O	Time measurement function or Waveform generating function: 16 bits x 8 channels Communication function (Clock synchronous serial I/O, Clock asynchronous serial I/O, HDLC data processing)	
	Serial I/O	5 Channels Clock synchronous serial I/O, Clock asynchronous serial I/O, IEBus(1), I^2C bus(2)	
	CAN Module	1 channel Supporting CAN 2.0B specification	
	A/D Converter	10-bit A/D converter: 1 circuit, 26 channels	
	D/A Converter	8 bits x 2 channels	
	DMAC	4 channels	
	DMAC II	Can be activated by all peripheral function interrupt sources Immediate transfer, Calculation transfer and Chain transfer functions	
	CRC Calculation Circuit	CRC-CCITT	
	X/Y Converter	16 bits x 16 bits	
	Watchdog Timer	15 bits x 1 channel (with prescaler)	
	Interrupt	38 internal and 8 external sources, 5 software sources Interrupt priority level: 7	
	Clock Generation Circuit	4 circuits Main clock oscillation circuit(*), Sub clock oscillation circuit(*), On-chip oscillator, PLL frequency synthesizer (*)Equipped with a built-in feedback resistor. Ceramic resonator or crystal oscillator must be connected externally	
	Oscillation Stop Detect Function	Main clock oscillation stop detect function	
	Voltage Detection Circuit	Available (optional)	Not available(4)
Electrical Characteristics	Supply Voltage	V_{CC1}=4.2 V to 5.5 V, V_{CC2}=3.0 V to V_{CC1} (f(BCLK)=32 MHz) V_{CC1}=3.0 V to 5.5 V, V_{CC2}=3.0 V to V_{CC1} (f(BCLK)=24 MHz)	V_{CC1}=V_{CC2}=4.2 V to 5.5 V, (f(BCLK)=32 MHz)(3)
	Power Consumption	28 mA (V_{CC1}=V_{CC2}=5 V, f(BCLK)=32 MHz) 22 mA (V_{CC1}=V_{CC2}=3.3 V, f(BCLK)=24 MHz) 10µA (V_{CC1}=V_{CC2}=5 V, f(BCLK)=32 kHz, in wait mode)	28 mA (V_{CC1}=V_{CC2}=5 V, f(BCLK)=32 MHz) 10µA (V_{CC1}=V_{CC2}=5 V, f(BCLK)=32 kHz, in wait mode)
Flash Memory	Program/Erase Supply Voltage	3.3 V ± 0.3 V or 5.0 V ± 0.5 V	5.0 V ± 0.5 V
	Program and Erase Endurance	100 times (all space)	
Operating Ambient Temperature		–20 to 85°C –40 to 85°C (optional)	–40 to 85°C (T version)
Package		100-pin plastic molded LQFP/QFP	

NOTES:
1. IEBus is a trademark of NEC Electronics Corporation.
2. I^2C bus is a trademark of Koninklijke Philips Electronics N. V.
3. The supply voltage of M32C/84T (High-reliability version) must be V_{CC1}=V_{CC2}.
4. The cold start-up/warm start-up determine function is available only at the user's option.

All options are on a request basis.

1.3 Block Diagram

Figure 1.1 shows a block diagram of the M32C/84 group (M32C/84, M32C/84T) microcomputer.



NOTES:
1. Ports P11 to P15 are provided in the 144-pin package only.
2. Included in the 144-pin package only.
3. The supply voltage of M32C/84T (High-reliability version) must be V_{CC1}=V_{CC2}.

Figure 1.1 M32C/84 Group (M32C/84, M32C/84T) Block Diagram

1.4 Product Information

Table 1.3 lists product information. Figure 1.2 shows the product numbering system.

Table 1.3 M32C/84 Group (1) (M32C/84) **As of July, 2005**

Type Number	Package	ROM Capacity	RAM Capacity	Remarks
M30845FJGP	PLQP0144KA-A (144P6Q-A)	512K+4K	24K	Flash Memory
M30843FJGP	PLQP0100KB-A (100P6Q-A)			
M30843FJFP	PRQP0100JB-A (100P6S-A)			
M30845FHGP	PLQP0144KA-A (144P6Q-A)	384K+4K		
M30843FHGP	PLQP0100KB-A (100P6Q-A)			
M30843FHFP	PRQP0100JB-A (100P6S-A)			
M30845FWGP	PLQP0144KA-A (144P6Q-A)	320K+4K		
M30843FWGP	PLQP0100KB-A (100P6Q-A)			
M30845MW-XXXGP	PLQP0144KA-A (144P6Q-A)	320K		Mask ROM
M30843MW-XXXGP	PLQP0100KB-A (100P6Q-A)			
M30843MW-XXXFP	PRQP0100JB-A (100P6S-A)			
M30842ME-XXXGP	PLQP0144KA-A (144P6Q-A)	192K	16K	
M30840ME-XXXGP	PLQP0100KB-A (100P6Q-A)			
M30840ME-XXXFP	PRQP0100JB-A (100P6S-A)			
M30842MC-XXXGP	PLQP0144KA-A (144P6Q-A)	128K	10K	
M30840MC-XXXGP	PLQP0100KB-A (100P6Q-A)			
M30840MC-XXXFP	PRQP0100JB-A (100P6S-A)			
M30842SGP (D)	PLQP0144KA-A (144P6Q-A)	---		ROMless
M30840SGP (D)	PLQP0100KB-A (100P6Q-A)			
M30840SFP (D)	PRQP0100JB-A (100P6S-A)			

(D): Under Development

Table 1.3 M32C/84 Group (2) (T Version, M32C/84T) **As of July, 2005**

Type Number	Package	ROM Capacity	RAM Capacity	Remarks
M30845FJTGP	PLQP0144KA-A (144P6Q-A)	512K+4K	24K	Flash Memory T Version (High-releability 85° C Version)
M30843FJTGP	PLQP0100KB-A (100P6Q-A)			
M30845FHTGP	PLQP0144KA-A (144P6Q-A)	384K+4K		
M30843FHTGP	PLQP0100KB-A (100P6Q-A)			
M30843FWTGP	PLQP0100KB-A (100P6Q-A)	320K+4K		
M30842MCT-XXXGP (D)	PLQP0144KA-A (144P6Q-A)	128K	10K	Mask ROM
M30840MCT-XXXGP (D)	PLQP0100KB-A (100P6Q-A)			

(D): Under Development

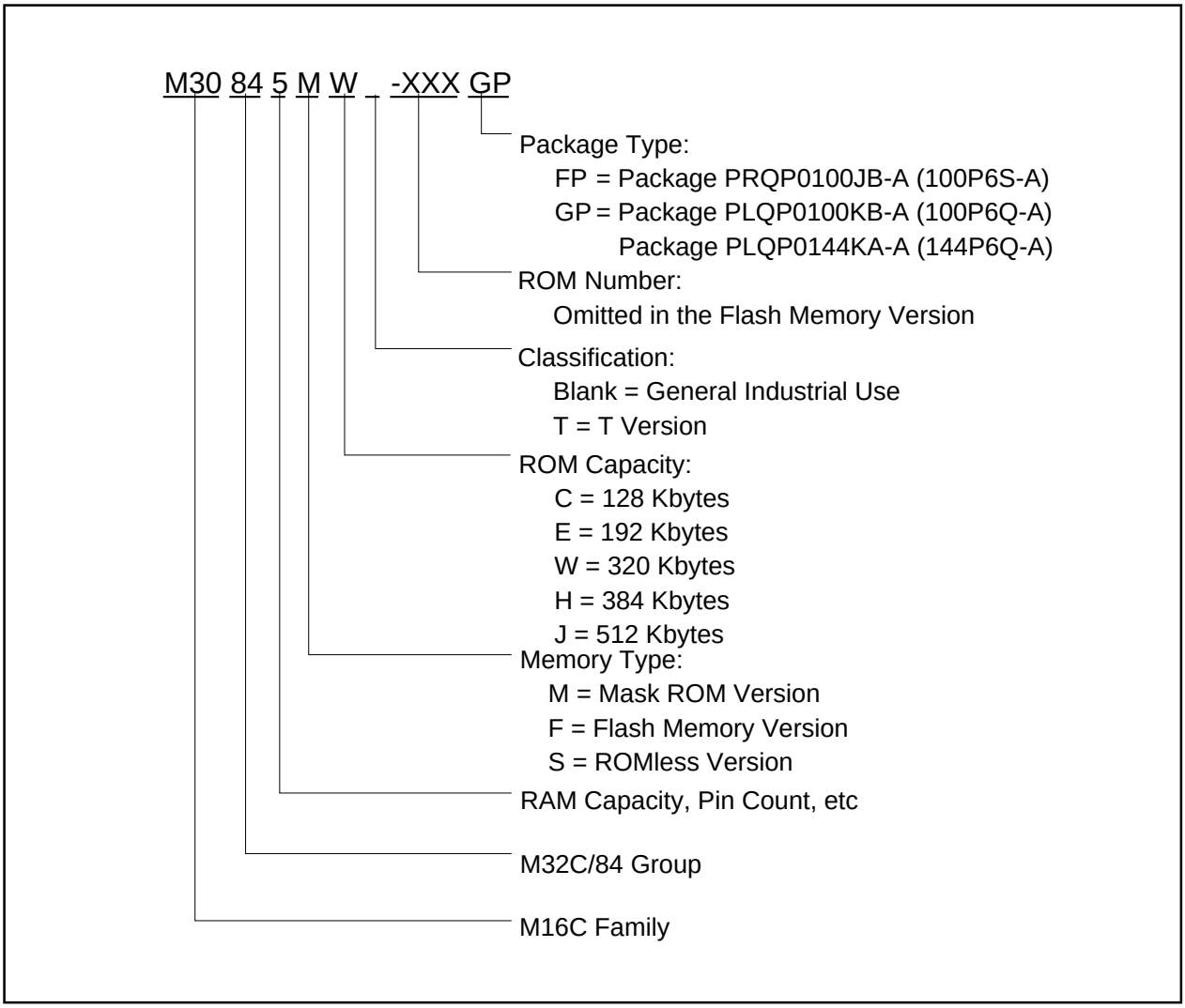


Figure 1.2 Product Numbering System

1.5 Pin Assignments and Descriptions

Figures 1.3 to 1.5 show pin assignments (top view).

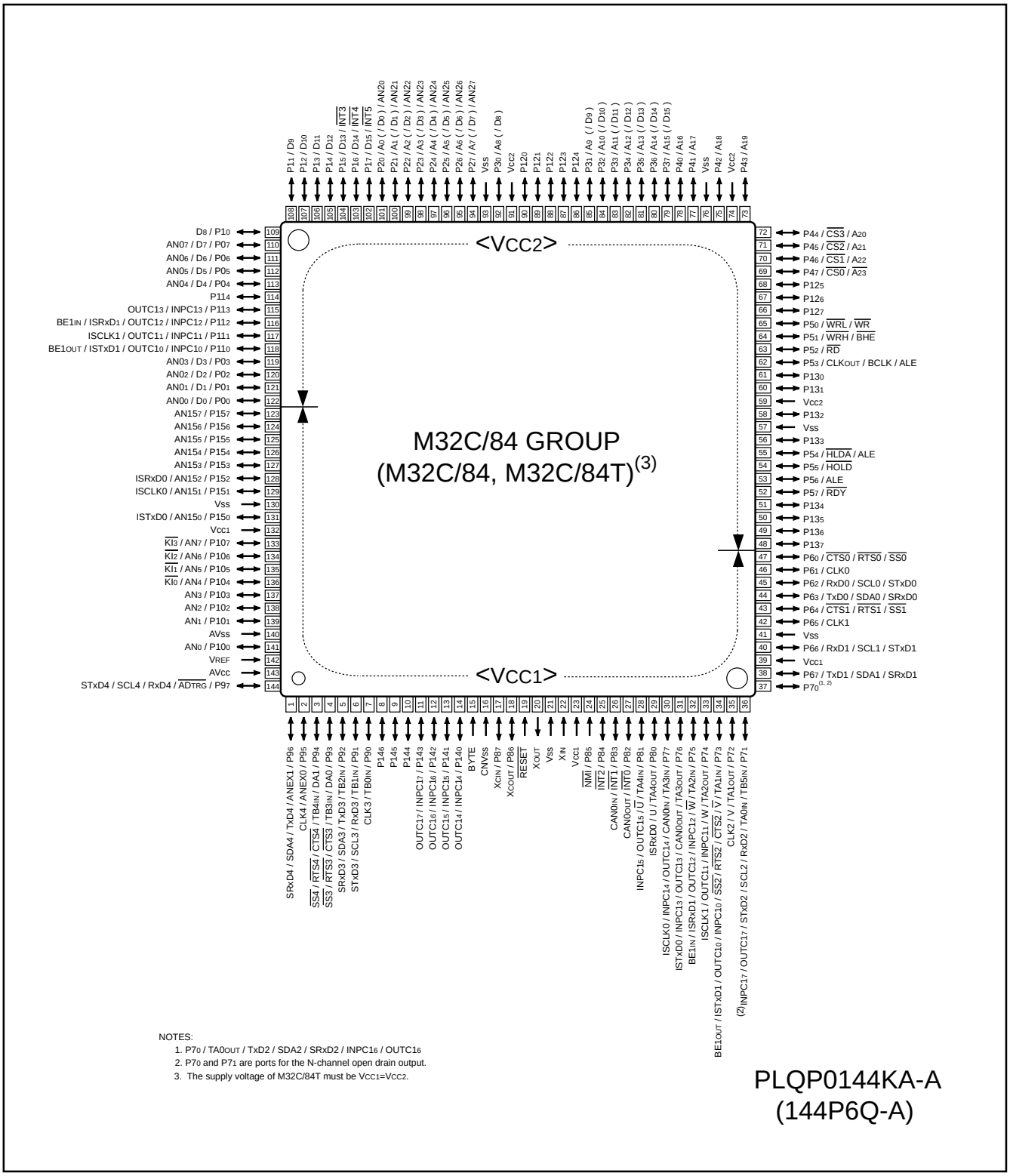


Figure 1.3 Pin Assignment for 144-Pin Package

Table 1.4 Pin Characteristics for 144-Pin Package

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	UART/CAN Pin	Intelligent I/O Pin	Analog Pin	Bus Control Pin(1)
1		P9$_6$			TxD4/SDA4/SRxD4		ANEX1	
2		P9$_5$			CLK4		ANEX0	
3		P9$_4$		TB4$_{IN}$	$\overline{CTS4}$/$\overline{RTS4}$/$\overline{SS4}$		DA1	
4		P9$_3$		TB3$_{IN}$	$\overline{CTS3}$/$\overline{RTS3}$/$\overline{SS3}$		DA0	
5		P9$_2$		TB2$_{IN}$	TxD3/SDA3/SRxD3			
6		P9$_1$		TB1$_{IN}$	RxD3/SCL3/STxD3			
7		P9$_0$		TB0$_{IN}$	CLK3			
8		P14$_6$						
9		P14$_5$						
10		P14$_4$						
11		P14$_3$				INPC17/OUTC17		
12		P14$_2$				INPC16/OUTC16		
13		P14$_1$				INPC15/OUTC15		
14		P14$_0$				INPC14/OUTC14		
15	BYTE							
16	CNV$_{SS}$							
17	X$_{CIN}$	P8$_7$						
18	X$_{COUT}$	P8$_6$						
19	$\overline{RESET}$							
20	X$_{OUT}$							
21	V$_{SS}$							
22	X$_{IN}$							
23	V$_{CC1}$							
24		P8$_5$	$\overline{NMI}$					
25		P8$_4$	$\overline{INT2}$					
26		P8$_3$	$\overline{INT1}$		CAN0$_{IN}$			
27		P8$_2$	$\overline{INT0}$		CAN0$_{OUT}$			
28		P8$_1$		TA4$_{IN}$/$\overline{U}$		INPC15/OUTC15		
29		P8$_0$		TA4$_{OUT}$/U		ISRxD0		
30		P7$_7$		TA3$_{IN}$	CAN0$_{IN}$	INPC14/OUTC14/ISCLK0		
31		P7$_6$		TA3$_{OUT}$	CAN0$_{OUT}$	INPC13/OUTC13/ISTxD0		
32		P7$_5$		TA2$_{IN}$/$\overline{W}$		INPC12/OUTC12/ISRxD1/BE1$_{IN}$		
33		P7$_4$		TA2$_{OUT}$/W		INPC11/OUTC11/ISCLK1		
34		P7$_3$		TA1$_{IN}$/$\overline{V}$	$\overline{CTS2}$/$\overline{RTS2}$/$\overline{SS2}$	INPC10/OUTC10/ISTxD1/BE1$_{OUT}$		
35		P7$_2$		TA1$_{OUT}$/V	CLK2			
36		P7$_1$		TB5$_{IN}$/TA0$_{IN}$	RxD2/SCL2/STxD2	INPC17/OUTC17		
37		P7$_0$		TA0$_{OUT}$	TxD2/SDA2/SRxD2	INPC16/OUTC16		
38		P6$_7$			TxD1/SDA1/SRxD1			
39	V$_{CC1}$							
40		P6$_6$			RxD1/SCL1/STxD1			
41	V$_{SS}$							
42		P6$_5$			CLK1			
43		P6$_4$			$\overline{CTS1}$/$\overline{RTS1}$/$\overline{SS1}$			
44		P6$_3$			TxD0/SDA0/SRxD0			
45		P6$_2$			RxD0/SCL0/STxD0			
46		P6$_1$			CLK0			
47		P6$_0$			$\overline{CTS0}$/$\overline{RTS0}$/$\overline{SS0}$			
48		P13$_7$						

NOTES:
1. Bus control pins in M32C/84T cannot be used.

Table 1.4 Pin Characteristics for 144-Pin Package (Continued)

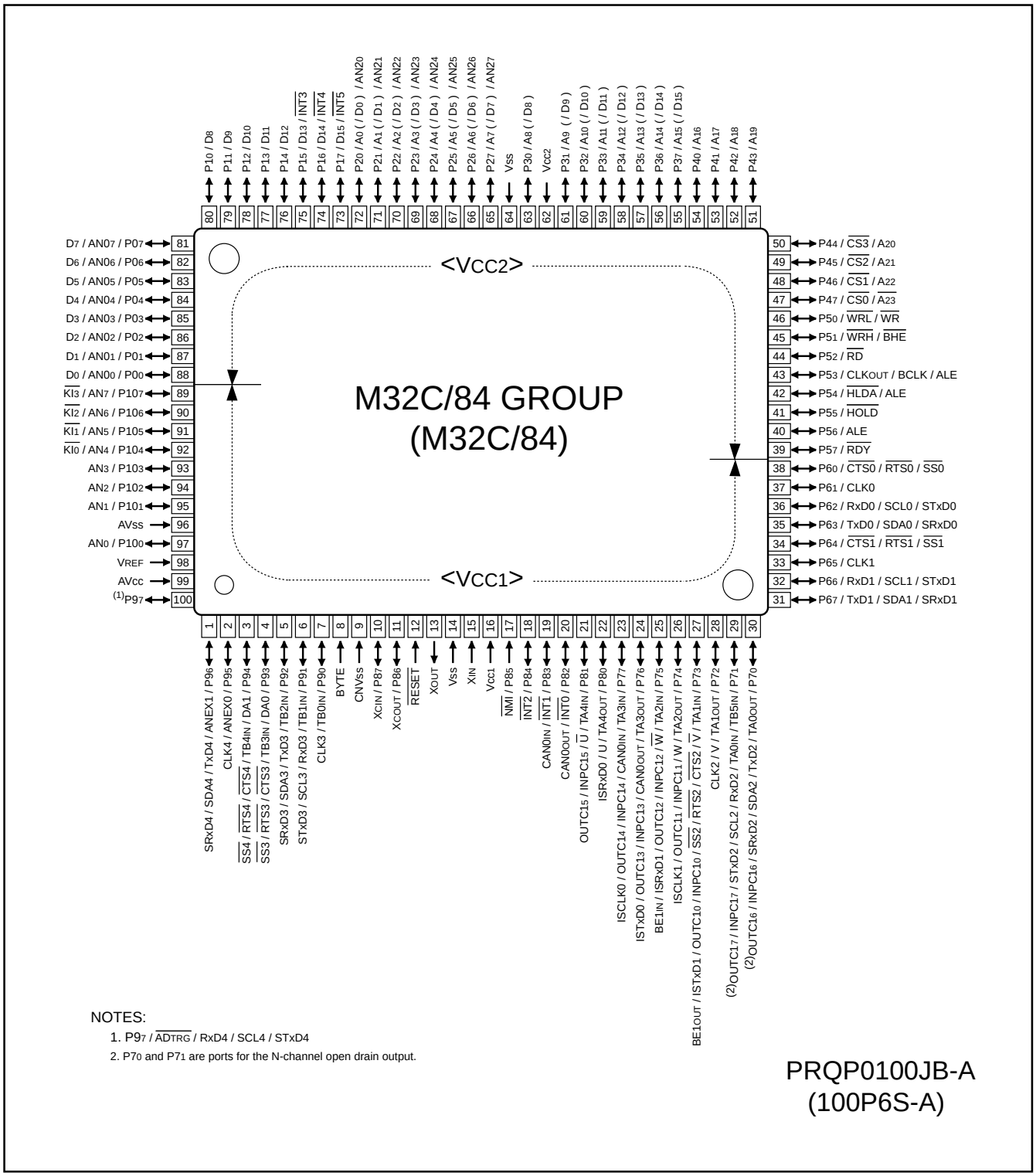
Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	UART/CAN Pin	Intelligent I/O Pin	Analog Pin	Bus Control Pin
49		P13$_6$						
50		P13$_5$						
51		P13$_4$						
52		P5$_7$						$\overline{\text{RDY}}$
53		P5$_6$						ALE
54		P5$_5$						$\overline{\text{HOLD}}$
55		P5$_4$						$\overline{\text{HLDA}}$/ALE
56		P13$_3$						
57	V_{SS}							
58		P13$_2$						
59	V_{CC2}							
60		P13$_1$						
61		P13$_0$						
62		P5$_3$						CLK$_{OUT}$/BCLK/ALE
63		P5$_2$						$\overline{\text{RD}}$
64		P5$_1$						$\overline{\text{WRH}}$/$\overline{\text{BHE}}$
65		P5$_0$						$\overline{\text{WRL}}$/$\overline{\text{WR}}$
66		P12$_7$						
67		P12$_6$						
68		P12$_5$						
69		P4$_7$						$\overline{\text{CS0}}$/A$_{23}$
70		P4$_6$						$\overline{\text{CS1}}$/A$_{22}$
71		P4$_5$						$\overline{\text{CS2}}$/A$_{21}$
72		P4$_4$						$\overline{\text{CS3}}$/A$_{20}$
73		P4$_3$						A$_{19}$
74	V_{CC2}							
75		P4$_2$						A$_{18}$
76	V_{SS}							
77		P4$_1$						A$_{17}$
78		P4$_0$						A$_{16}$
79		P3$_7$						A$_{15}$(/D$_{15}$)
80		P3$_6$						A$_{14}$(/D$_{14}$)
81		P3$_5$						A$_{13}$(/D$_{13}$)
82		P3$_4$						A$_{12}$(/D$_{12}$)
83		P3$_3$						A$_{11}$(/D$_{11}$)
84		P3$_2$						A$_{10}$(/D$_{10}$)
85		P3$_1$						A$_9$(/D$_9$)
86		P12$_4$						
87		P12$_3$						
88		P12$_2$						
89		P12$_1$						
90		P12$_0$						
91	V_{CC2}							
92		P3$_0$						A$_8$(/D$_8$)
93	V_{SS}							
94		P2$_7$					AN2$_7$	A$_7$(/D$_7$)
95		P2$_6$					AN2$_6$	A$_6$(/D$_6$)
96		P2$_5$					AN2$_5$	A$_5$(/D$_5$)

NOTES:
1. Bus control pins in M32C/84T cannot be used.

Table 1.4 Pin Characteristics for 144-Pin Package (Continued)

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	UART/CAN Pin	Intelligent I/O Pin	Analog Pin	Bus Control Pin(1)
97		P2$_4$					AN2$_4$	A$_4$(/D$_4$)
98		P2$_3$					AN2$_3$	A$_3$(/D$_3$)
99		P2$_2$					AN2$_2$	A$_2$(/D$_2$)
100		P2$_1$					AN2$_1$	A$_1$(/D$_1$)
101		P2$_0$					AN2$_0$	A$_0$(/D$_0$)
102		P1$_7$	$\overline{\text{INT5}}$					D$_{15}$
103		P1$_6$	$\overline{\text{INT4}}$					D$_{14}$
104		P1$_5$	$\overline{\text{INT3}}$					D$_{13}$
105		P1$_4$						D$_{12}$
106		P1$_3$						D$_{11}$
107		P1$_2$						D$_{10}$
108		P1$_1$						D$_9$
109		P1$_0$						D$_8$
110		P0$_7$					AN0$_7$	D$_7$
111		P0$_6$					AN0$_6$	D$_6$
112		P0$_5$					AN0$_5$	D$_5$
113		P0$_4$					AN0$_4$	D$_4$
114		P11$_4$						
115		P11$_3$				INPC1$_3$/OUTC1$_3$		
116		P11$_2$				INPC1$_2$/OUTC1$_2$/ISRxD1/BE1$_{IN}$		
117		P11$_1$				INPC1$_1$/OUTC1$_1$/ISCLK1		
118		P11$_0$				INPC1$_0$/OUTC1$_0$/ISTxD1/BE1$_{OUT}$		
119		P0$_3$					AN0$_3$	D$_3$
120		P0$_2$					AN0$_2$	D$_2$
121		P0$_1$					AN0$_1$	D$_1$
122		P0$_0$					AN0$_0$	D$_0$
123		P15$_7$					AN15$_7$	
124		P15$_6$					AN15$_6$	
125		P15$_5$					AN15$_5$	
126		P15$_4$					AN15$_4$	
127		P15$_3$					AN15$_3$	
128		P15$_2$				ISRxD0	AN15$_2$	
129		P15$_1$				ISCLK0	AN15$_1$	
130	V$_{SS}$							
131		P15$_0$				ISTxD0	AN15$_0$	
132	V$_{CC1}$							
133		P10$_7$	$\overline{\text{KI}_3}$				AN$_7$	
134		P10$_6$	$\overline{\text{KI}_2}$				AN$_6$	
135		P10$_5$	$\overline{\text{KI}_1}$				AN$_5$	
136		P10$_4$	$\overline{\text{KI}_0}$				AN$_4$	
137		P10$_3$					AN$_3$	
138		P10$_2$					AN$_2$	
139		P10$_1$					AN$_1$	
140	AV$_{SS}$							
141		P10$_0$					AN$_0$	
142	V$_{REF}$							
143	AV$_{CC}$							
144		P9$_7$			RxD4/SCL4/STxD4		$\overline{\text{AD}_{TRG}}$	

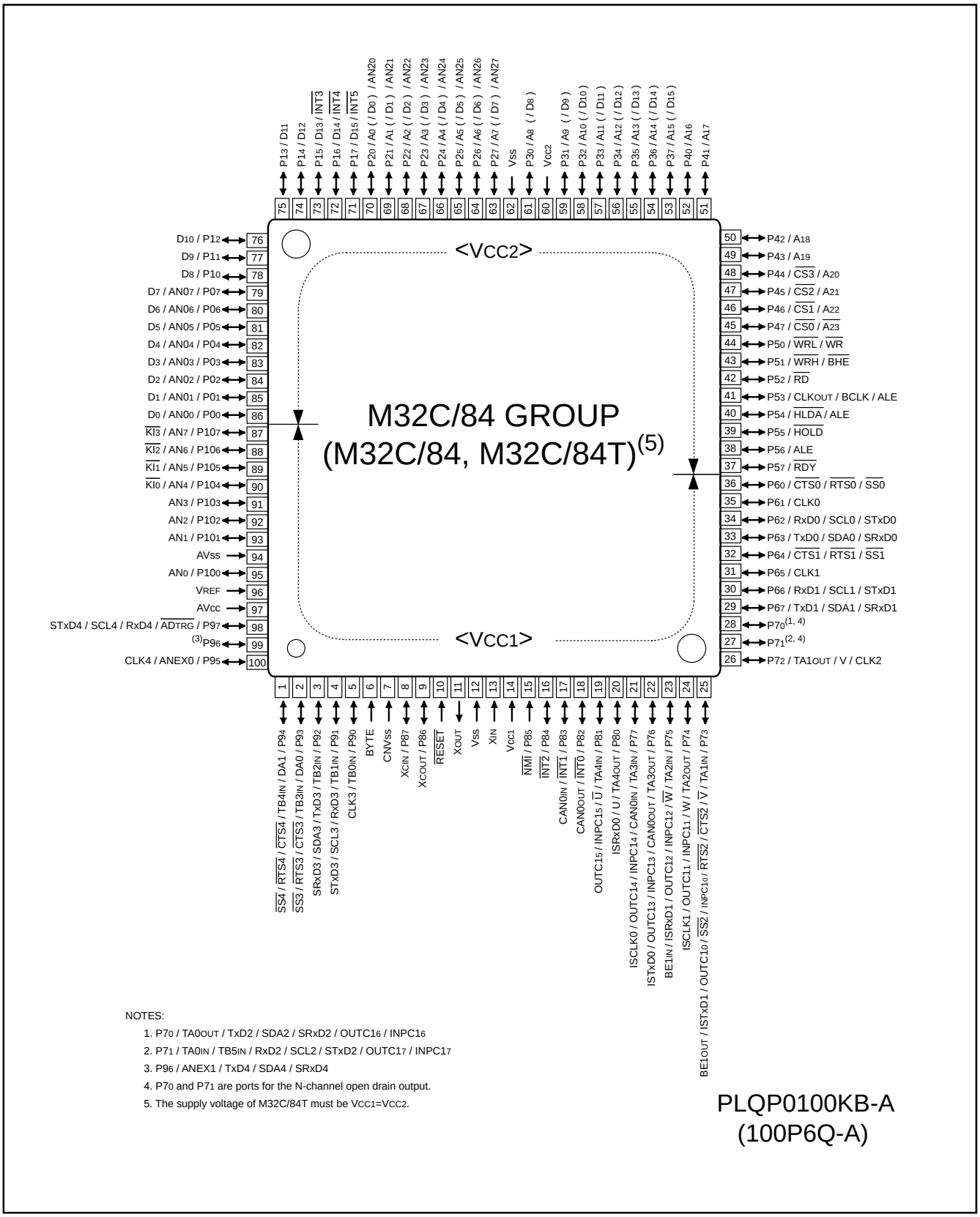
NOTES:
1. Bus control pins in M32C/84T cannot be used.



NOTES:
1. P97 / ADTRG / RxD4 / SCL4 / STxD4
2. P70 and P71 are ports for the N-channel open drain output.

PRQP0100JB-A
(100P6S-A)

Figure 1.4 Pin Assignment for 100-Pin Package



NOTES:
1. P70 / TA0OUT / TxD2 / SDA2 / SRxD2 / OUTC16 / INPC16
2. P71 / TA0IN / TB5IN / RxD2 / SCL2 / STxD2 / OUTC17 / INPC17
3. P96 / ANEX1 / TxD4 / SDA4 / SRxD4
4. P70 and P71 are ports for the N-channel open drain output.
5. The supply voltage of M32C/84T must be VCC1=VCC2.

PLQP0100KB-A
(100P6Q-A)

Figure 1.5 Pin Assignment for 100-Pin Package

Table 1.5 Pin Characteristics for 100-Pin Package

Package Pin No.		Control Pin	Port	Interrupt Pin	Timer Pin	UART/CAN Pin	Intelligent I/O Pin	Analog Pin	Bus Control Pin(1)
FP	GP								
1	99		P9$_6$			TxD4/SDA4/SRxD4		ANEX1	
2	100		P9$_5$			CLK4		ANEX0	
3	1		P9$_4$		TB4$_{IN}$	$\overline{CTS4}$/$\overline{RTS4}$/$\overline{SS4}$		DA1	
4	2		P9$_3$		TB3$_{IN}$	$\overline{CTS3}$/$\overline{RTS3}$/$\overline{SS3}$		DA0	
5	3		P9$_2$		TB2$_{IN}$	TxD3/SDA3/SRxD3			
6	4		P9$_1$		TB1$_{IN}$	RxD3/SCL3/STxD3			
7	5		P9$_0$		TB0$_{IN}$	CLK3			
8	6	BYTE							
9	7	CNV$_{SS}$							
10	8	X$_{CIN}$	P8$_7$						
11	9	X$_{COUT}$	P8$_6$						
12	10	$\overline{RESET}$							
13	11	X$_{OUT}$							
14	12	V$_{SS}$							
15	13	X$_{IN}$							
16	14	V$_{CC1}$							
17	15		P8$_5$	$\overline{NMI}$					
18	16		P8$_4$	$\overline{INT2}$					
19	17		P8$_3$	$\overline{INT1}$		CAN0$_{IN}$			
20	18		P8$_2$	$\overline{INT0}$		CAN0$_{OUT}$			
21	19		P8$_1$		TA4$_{IN}$/$\overline{U}$		INPC1$_5$/OUTC1$_5$		
22	20		P8$_0$		TA4$_{OUT}$/U		ISRxD0		
23	21		P7$_7$		TA3$_{IN}$	CAN0$_{IN}$	INPC1$_4$/OUTC1$_4$/ISCLK0		
24	22		P7$_6$		TA3$_{OUT}$	CAN0$_{OUT}$	INPC1$_3$/OUTC1$_3$/ISTxD0		
25	23		P7$_5$		TA2$_{IN}$/$\overline{W}$		INPC1$_2$/OUTC1$_2$/ISRxD1/BE1$_{IN}$		
26	24		P7$_4$		TA2$_{OUT}$/W		INPC1$_1$/OUTC1$_1$/ISCLK1		
27	25		P7$_3$		TA1$_{IN}$/$\overline{V}$	$\overline{CTS2}$/$\overline{RTS2}$/$\overline{SS2}$	INPC1$_0$/OUTC1$_0$/ISTxD1/BE1$_{OUT}$		
28	26		P7$_2$		TA1$_{OUT}$/V	CLK2			
29	27		P7$_1$		TB5$_{IN}$/TA0$_{IN}$	RxD2/SCL2/STxD2	INPC1$_7$/OUTC1$_7$		
30	28		P7$_0$		TA0$_{OUT}$	TxD2/SDA2/SRxD2	INPC1$_6$/OUTC1$_6$		
31	29		P6$_7$			TxD1/SDA1/SRxD1			
32	30		P6$_6$			RxD1/SCL1/STxD1			
33	31		P6$_5$			CLK1			
34	32		P6$_4$			$\overline{CTS1}$/$\overline{RTS1}$/$\overline{SS1}$			
35	33		P6$_3$			TxD0/SDA0/SRxD0			
36	34		P6$_2$			RxD0/SCL0/STxD0			
37	35		P6$_1$			CLK0			
38	36		P6$_0$			$\overline{CTS0}$/$\overline{RTS0}$/$\overline{SS0}$			
39	37		P5$_7$						$\overline{RDY}$
40	38		P5$_6$						ALE
41	39		P5$_5$						$\overline{HOLD}$
42	40		P5$_4$						$\overline{HLDA}$/ALE
43	41		P5$_3$						CLK$_{OUT}$/BCLK/ALE
44	42		P5$_2$						$\overline{RD}$
45	43		P5$_1$						$\overline{WRH}$/$\overline{BHE}$
46	44		P5$_0$						$\overline{WRL}$/$\overline{WR}$
47	45		P4$_7$						$\overline{CS0}$/A$_{23}$
48	46		P4$_6$						$\overline{CS1}$/A$_{22}$
49	47		P4$_5$						$\overline{CS2}$/A$_{21}$
50	48		P4$_4$						$\overline{CS3}$/A$_{20}$

NOTES:
1. Bus control pins in M32C/84T cannot be used.

Table 1.5 Pin Characteristics for 100-Pin Package (Continued)

Package Pin No.		Control Pin	Port	Interrupt Pin	Timer Pin	UART/CAN Pin	Intelligent I/O Pin	Analog Pin	Bus Control Pin
FP	GP								
51	49		$P4_3$						A_{19}
52	50		$P4_2$						A_{18}
53	51		$P4_1$						A_{17}
54	52		$P4_0$						A_{16}
55	53		$P3_7$						A_{15}(/D_{15})
56	54		$P3_6$						A_{14}(/D_{14})
57	55		$P3_5$						A_{13}(/D_{13})
58	56		$P3_4$						A_{12}(/D_{12})
59	57		$P3_3$						A_{11}(/D_{11})
60	58		$P3_2$						A_{10}(/D_{10})
61	59		$P3_1$						A_9(/D_9)
62	60	V_{CC2}							
63	61		$P3_0$						A_8(/D_8)
64	62	V_{SS}							
65	63		$P2_7$					$AN2_7$	A_7(/D_7)
66	64		$P2_6$					$AN2_6$	A_6(/D_6)
67	65		$P2_5$					$AN2_5$	A_5(/D_5)
68	66		$P2_4$					$AN2_4$	A_4(/D_4)
69	67		$P2_3$					$AN2_3$	A_3(/D_3)
70	68		$P2_2$					$AN2_2$	A_2(/D_2)
71	69		$P2_1$					$AN2_1$	A_1(/D_1)
72	70		$P2_0$					$AN2_0$	A_0(/D_0)
73	71		$P1_7$	$\overline{INT5}$					D_{15}
74	72		$P1_6$	$\overline{INT4}$					D_{14}
75	73		$P1_5$	$\overline{INT3}$					D_{13}
76	74		$P1_4$						D_{12}
77	75		$P1_3$						D_{11}
78	76		$P1_2$						D_{10}
79	77		$P1_1$						D_9
80	78		$P1_0$						D_8
81	79		$P0_7$					$AN0_7$	D_7
82	80		$P0_6$					$AN0_6$	D_6
83	81		$P0_5$					$AN0_5$	D_5
84	82		$P0_4$					$AN0_4$	D_4
85	83		$P0_3$					$AN0_3$	D_3
86	84		$P0_2$					$AN0_2$	D_2
87	85		$P0_1$					$AN0_1$	D_1
88	86		$P0_0$					$AN0_0$	D_0
89	87		$P10_7$	$\overline{KI_3}$				AN_7	
90	88		$P10_6$	$\overline{KI_2}$				AN_6	
91	89		$P10_5$	$\overline{KI_1}$				AN_5	
92	90		$P10_4$	$\overline{KI_0}$				AN_4	
93	91		$P10_3$					AN_3	
94	92		$P10_2$					AN_2	
95	93		$P10_1$					AN_1	
96	94	AV_{SS}							
97	95		$P10_0$					AN_0	
98	96	V_{REF}							
99	97	AV_{CC}							
100	98		$P9_7$			RxD4/SCL4/STxD4		$\overline{ADTRG}$	

NOTES:
1. Bus control pins in M32C/84T cannot be used.

1.6 Pin Description

Table 1.6 Pin Description (100-Pin and 144-Pin Packages)

Classsfication	Symbol	I/O Type	Supply Voltage	Function
Power Supply	V_{CC1}, V_{CC2} V_{SS}	I	–	Apply 3.0 to 5.5V to both V_{CC1} and V_{CC2} pins. Apply 0V to the V_{SS} pin. $V_{CC1} \geq V_{CC2}$(1, 2)
Analog Power Supply	AVCC AVSS	I	V_{CC1}	Supplies power to the A/D converter. Connect the AVCC pin to V_{CC1} and the AVSS pin to V_{SS}
Reset Input	$\overline{RESET}$	I	V_{CC1}	The microcomputer is in a reset state when "L" is applied to the $\overline{RESET}$ pin
CNVSS	CNVSS	I	V_{CC1}	Switches processor mode. Connect the CNVSS pin to V_{SS} to start up in single-chip mode or to V_{CC1} to start up in microprocessor mode
Input to Switch External Data Bus Width(3)	BYTE	I	V_{CC1}	Switches data bus width in external memory space 3. The data bus is 16 bits wide when the BYTE pin is held "L" and 8 bits wide when it is held "H". Set to either. Connect the BYTE pin to V_{SS} to use the microcomputer in single-chip mode
Bus Control Pins(3)	D_0 to D_7	I/O	V_{CC2}	Inputs and outputs data (D_0 to D_7) while accessing an external memory space with separate bus
	D_8 to D_{15}	I/O	V_{CC2}	Inputs and outputs data (D_8 to D_{15}) while accessing an external memory space with 16-bit separate bus
	A_0 to A_{22}	O	V_{CC2}	Outputs address bits A_0 to A_{22}
	$\overline{A_{23}}$	O	V_{CC2}	Outputs inversed address bit A_{23}
	A_0/D_0 to A_7/D_7	I/O	V_{CC2}	Inputs and outputs data (D_0 to D_7) and outputs 8 low-order address bits (A_0 to A_7) by time-sharing while accessing an external memory space with multiplexed bus
	A_8/D_8 to A_{15}/D_{15}	I/O	V_{CC2}	Inputs and outputs data (D_8 to D_{15}) and outputs 8 middle-order address bits (A_8 to A_{15}) by time-sharing while accessing an external memory space with 16-bit multiplexed bus
	$\overline{CS0}$ to $\overline{CS3}$	O	V_{CC2}	Outputs $\overline{CS0}$ to $\overline{CS3}$ that are chip-select signals specifying an external space
	$\overline{WRL}$ / $\overline{WR}$ $\overline{WRH}$ / $\overline{BHE}$ $\overline{RD}$	O	V_{CC2}	Outputs $\overline{WRL}$, $\overline{WRH}$, ($\overline{WR}$, $\overline{BHE}$) and $\overline{RD}$ signals. $\overline{WRL}$ and $\overline{WRH}$ can be switched with $\overline{WR}$ and $\overline{BHE}$ by program ■ $\overline{WRL}$, $\overline{WRH}$ and $\overline{RD}$ selected: If external data bus is 16 bits wide, data is written to an even address in external memory space when $\overline{WRL}$ is held "L". Data is written to an odd address when $\overline{WRH}$ is held "L". Data is read when $\overline{RD}$ is held "L". ■ $\overline{WR}$, $\overline{BHE}$ and $\overline{RD}$ selected: Data is written to external memory space when $\overline{WR}$ is held "L". Data in an external memory space is read when $\overline{RD}$ is held "L". An odd address is accessed when $\overline{BHE}$ is held "L". Select $\overline{WR}$, $\overline{BHE}$ and $\overline{RD}$ for external 8-bit data bus.
	ALE	O	V_{CC2}	ALE is a signal latching the address
	$\overline{HOLD}$	I	V_{CC2}	The microcomputer is placed in a hold state while the $\overline{HOLD}$ pin is held "L"
	$\overline{HLDA}$	O	V_{CC2}	Outputs an "L" signal while the microcomputer is placed in a hold state
	$\overline{RDY}$	I	V_{CC2}	Bus is placed in a wait state while the $\overline{RDY}$ pin is held "L"

I : Input O : Output I/O : Input and output

NOTES:
1. V_{CC1} is hereinafter referred to as V_{CC} unless otherwise noted.
2. Apply 4.2 to 5.5V to the V_{CC1} and V_{CC2} pins when using M32C/84T. V_{CC1}=V_{CC2}.
3. Bus cotrol pins in M32C/84T cannot be used.

Table 1.6 Pin Description (100-Pin and 144-Pin Packages) (Continued)

Classsfication	Symbol	I/O Type	Supply Voltage	Function
Main Clock Input	XIN	I	VCC1	I/O pins for the main clock oscillation circuit. Connect a ceramic resonator or crystal oscillator between XIN and XOUT. To apply external clock, apply it to XIN and leave XOUT open
Main Clock Output	XOUT	O	VCC1	
Sub Clock Input	XCIN	I	VCC1	I/O pins for the sub clock oscillation circuit. Connect a crystal oscillator between XCIN and XCOUT. To apply external clock, apply it to XCIN and leave XCOUT open
Sub Clock Output	XCOUT	O	VCC1	
BCLK Output(1)	BCLK	O	VCC2	Outputs BCLK signal
Clock Output	CLKOUT	O	VCC2	Outputs the clock having the same frequency as fC, f8 or f32
$\overline{INT}$ Interrupt Input	$\overline{INT0}$ to $\overline{INT2}$	I	VCC1	Input pins for the $\overline{INT}$ interrupt
	$\overline{INT3}$ to $\overline{INT5}$	I	VCC2	
$\overline{NMI}$ Interrupt Input	$\overline{NMI}$	I	VCC1	Input pin for the $\overline{NMI}$ interrupt
Key Input Interrupt	$\overline{KI0}$ to $\overline{KI3}$	I	VCC1	Input pins for the key input interrupt
Timer A	TA0OUT to TA4OUT	I/O	VCC1	I/O pins for the timer A0 to A4 (TA0OUT is a pin for the N-channel open drain output.)
	TA0IN to TA4IN	I	VCC1	Input pins for the timer A0 to A4
Timer B	TB0IN to TB5IN	I	VCC1	Input pins for the timer B0 to B5
Three-phase Motor Control Timer Output	U, $\overline{U}$, V, $\overline{V}$, W, $\overline{W}$	O	VCC1	Output pins for the three-phase motor control timer
Serial I/O	$\overline{CTS0}$ to $\overline{CTS4}$	I	VCC1	Iutput pins for data transmission control
	$\overline{RTS0}$ to $\overline{RTS4}$	O	VCC1	Output pins for data reception control
	CLK0 to CLK4	I/O	VCC1	Inputs and outputs the transfer clock
	RxD0 to RxD4	I	VCC1	Inputs serial data
	TxD0 to TxD4	O	VCC1	Outputs serial data (TxD2 is a pin for the N-channel open drain output.)
I^2C Mode	SDA0 to SDA4	I/O	VCC1	Inputs and outputs serial data (SDA2 is a pin for the N-channel open drain output.)
	SCL0 to SCL4	I/O	VCC1	Inputs and outputs the transfer clock (SCL2 is a pin for the N-channel open drain output.)
Serial I/O Special Function	STxD0 to STxD4	O	VCC1	Outputs serial data when slave mode is selected (STxD2 is a pin for the N-channel open drain output.)
	SRxD0 to SRxD4	I	VCC1	Inputs serial data when slave mode is selected
	$\overline{SS0}$ to $\overline{SS4}$	I	VCC1	Input pins to control serial I/O special function

I : Input O : Output I/O : Input and output

NOTES:

1. Bus control pins in M32C/84T cannot be used.

Table 1.6 Pin Description (100-Pin and 144-Pin Packages) (Continued)

Classsfication	Symbol	I/O Type	Supply Voltage	Function
Reference Voltage Input	V_{REF}	I	-	Applies reference voltage to the A/D converter and D/A converter
A/D Converter	AN_0 to AN_7 $AN0_0$ to $AN0_7$ $AN2_0$ to $AN2_7$	I	V_{CC1}	Analog input pins for the A/D converter
	$\overline{ADTRG}$	I	V_{CC1}	Input pin for an external A/D trigger
	ANEX0	I/O	V_{CC1}	Extended analog input pin for the A/D converter and output pin in external op-amp connection mode
	ANEX1	I	V_{CC1}	Extended analog input pin for the A/D converter
D/A Converter	DA0, DA1	O	V_{CC1}	Output pin for the D/A converter
Intelligent I/O	$INPC1_0$ to $INPC1_3$	I	V_{CC1}/V_{CC2}(1)	Input pins for the time measurement function
	$INPC1_4$ to $INPC1_7$	I	V_{CC1}	
	$OUTC1_0$ to $OUTC1_3$	O	V_{CC1}/V_{CC2}(1)	Output pins for the waveform generating function
	$OUTC1_4$ to $OUTC1_7$	O	V_{CC1}	($OUTC1_6$ and $OUTC1_7$ assgined to $P7_0$ and $P7_1$ are pins for the N-channel open drain output.)
	ISCLK0	I/O	V_{CC1}	Inputs and outputs the clock for the intellignet I/O communication function
	ISCLK1	I/O	V_{CC1}/V_{CC2}(1)	
	ISRXD0	I	V_{CC1}	Inputs data for the intellignet I/O communication function
	ISRXD1	I	V_{CC1}/V_{CC2}(1)	
	ISTXD0	O	V_{CC1}	Outputs data for the intellignet I/O communication function
	ISTXD1	O	V_{CC1}/V_{CC2}(1)	
	$BE1_{IN}$	I	V_{CC1}/V_{CC2}(1)	Inputs data for the intellignet I/O communication function
	$BE1_{OUT}$	O	V_{CC1}/V_{CC2}(1)	Outputs data for the intellignet I/O communication function
CAN	$CAN0_{IN}$	I	V_{CC1}	Input pin for the CAN communication function
	$CAN0_{OUT}$	O	V_{CC1}	Output pin for the CAN communication function
I/O Ports	$P0_0$ to $P0_7$ $P1_0$ to $P1_7$ $P2_0$ to $P2_7$ $P3_0$ to $P3_7$ $P4_0$ to $P4_7$ $P5_0$ to $P5_7$	I/O	V_{CC2}	I/O ports for CMOS. Each port can be programmed for input or output under the control of the direction register. An input port can be set, by program, for a pull-up resistor available or for no pull-up resister available in 4-bit units
	$P6_0$ to $P6_7$ $P7_0$ to $P7_7$ $P9_0$ to $P9_7$ $P10_0$ to $P10_7$	I/O	V_{CC1}	I/O ports having equivalent functions to P0 ($P7_0$ and $P7_1$ are ports for the N-channel open drain output.)
	$P8_0$ to $P8_4$ $P8_6$, $P8_7$	I/O	V_{CC1}	I/O ports having equivalent functions to P0
Input Port	$P8_5$	I	V_{CC1}	Shares a pin with $\overline{NMI}$. $\overline{NMI}$ input state can be got by reading $P8_5$

I : Input O : Output I/O : Input and output

NOTES:

1. V_{CC2} is not available in the 100-pin package. V_{CC1} only available.

Table 1.6 Pin Description (144-Pin Package only) (Continued)

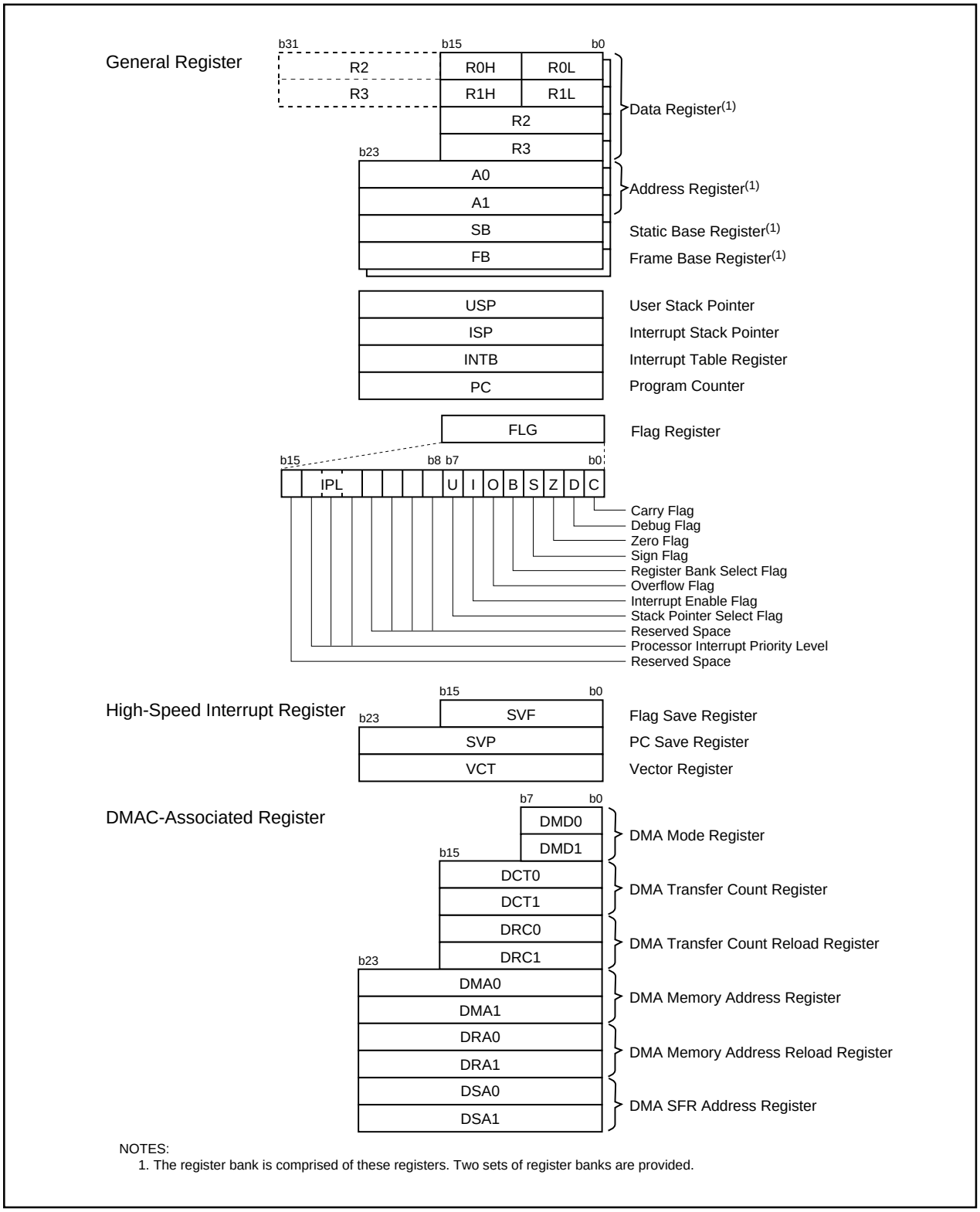
Classsfication	Symbol	I/O Type	Supply Voltage	Function
A/D Converter	$AN15_0$ to $AN15_7$	I	V_{CC1}	Analog input pins for the A/D converter
I/O Ports	$P11_0$ to $P11_4$ $P12_0$ to $P12_7$ $P13_0$ to $P13_7$	I/O	V_{CC2}	I/O ports having equivalent functions to P0
	$P14_0$ to $P14_6$ $P15_0$ to $P15_7$	I/O	V_{CC1}	I/O ports having equivalent functions to P0

I : Input O : Output I/O : Input and output

2. Central Processing Unit (CPU)

Figure 2.1 shows the CPU registers.

The register bank is comprised of 8 registers (R0, R1, R2, R3, A0, A1, SB and FB) out of 28 CPU registers. Two sets of register banks are provided.



NOTES:
1. The register bank is comprised of these registers. Two sets of register banks are provided.

Figure 2.1 CPU Register

2.1 General Registers

2.1.1 Data Registers (R0, R1, R2 and R3)

R0, R1, R2 and R3 are 16-bit registers for transfer, arithmetic and logic operations. R0 and R1 can be split into high-order bits (R0H) and low-order bits (R0L) to be used separately as 8-bit data registers. R0 can be combined with R2 to be used as a 32-bit data register (R2R0). The same applies to R1 and R3.

2.1.2 Address Registers (A0 and A1)

A0 and A1 are 24-bit registers for A0-/A1-indirect addressing, A0-/A1-relative addressing, transfer, arithmetic and logic operations.

2.1.3 Static Base Register (SB)

SB is a 24-bit register for SB-relative addressing.

2.1.4 Frame Base Register (FB)

FB is a 24-bit register for FB-relative addressing.

2.1.5 Program Counter (PC)

PC, 24 bits wide, indicates the address of an instruction to be executed.

2.1.6 Interrupt Table Register (INTB)

INTB is a 24-bit register indicating the starting address of an relocatable interrupt vector table.

2.1.7 User Stack Pointer (USP), Interrupt Stack Pointer (ISP)

The stack pointers (SP), USP and ISP, are 24 bits wide each. The U flag is used to switch between USP and ISP. Refer to **2.1.8 Flag Register (FLG)** for details on the U flag. Set USP and ISP to even addresses to execute an interrupt sequence efficiently.

2.1.8 Flag Register (FLG)

FLG is a 16-bit register indicating a CPU state.

2.1.8.1 Carry Flag (C)

The C flag indicates whether carry or borrow has occurred after executing an instruction.

2.1.8.2 Debug Flag (D)

The D flag is for debug only. Set to "0".

2.1.8.3 Zero Flag (Z)

The Z flag is set to "1" when the value of zero is obtained from an arithmetic operation; otherwise "0".

2.1.8.4 Sign Flag (S)

The S flag is set to "1" when a negative value is obtained from an arithmetic operation; otherwise "0".

2.1.8.5 Register Bank Select Flag (B)

The register bank 0 is selected when the B flag is set to "0". The register bank 1 is selected when this flag is set to "1".

2.1.8.6 Overflow Flag (O)

The O flag is set to "1" when the result of an arithmetic operation overflows; otherwise "0".

2.1.8.7 Interrupt Enable Flag (I)

The I flag enables a maskable interrupt.
Interrupt is disabled when the I flag is set to "0" and enabled when the I flag is set to "1". The I flag is set to "0" when an interrupt is acknowledged.

2.1.8.8 Stack Pointer Select Flag (U)

ISP is selected when the U flag is set to "0". USP is selected when this flag is set to "1".
The U flag is set to "0" when a hardware interrupt is acknowledged or the INT instruction of software interrupt numbers 0 to 31 is executed.

2.1.8.9 Processor Interrupt Priority Level (IPL)

IPL, 3 bits wide, assigns processor interrupt priority levels from level 0 to level 7.
If a requested interrupt has greater priority than IPL, the interrupt is enabled.

2.1.8.10 Reserved Space

When writing to a reserved space, set to "0". When reading, its content is indeterminate.

2.2 High-Speed Interrupt Registers

Registers associated with the high-speed interrupt are as follows:

- Flag save register (SVF)
- PC save register (SVP)
- Vector register (VCT)

2.3 DMAC-Associated Registers

Registers associated with DMAC are as follows:

- DMA mode register (DMD0, DMD1)
- DMA transfer count register (DCT0, DCT1)
- DMA transfer count reload register (DRC0, DRC1)
- DMA memory address register (DMA0, DMA1)
- DMA SFR address register (DSA0, DSA1)
- DMA memory address reload register (DRA0, DRA1)

3. Memory

Figure 3.1 shows a memory map of the M32C/84 group (M32C/84, M32C/84T).

The M32C/84 group (M32C/84, M32C/84T) provides 16-Mbyte address space from addresses 000000$_{16}$ to FFFFFF$_{16}$.

The internal ROM is allocated lower addresses beginning with address FFFFFF$_{16}$. For example, a 64-Kbyte internal ROM is allocated in addresses FF0000$_{16}$ to FFFFFF$_{16}$.

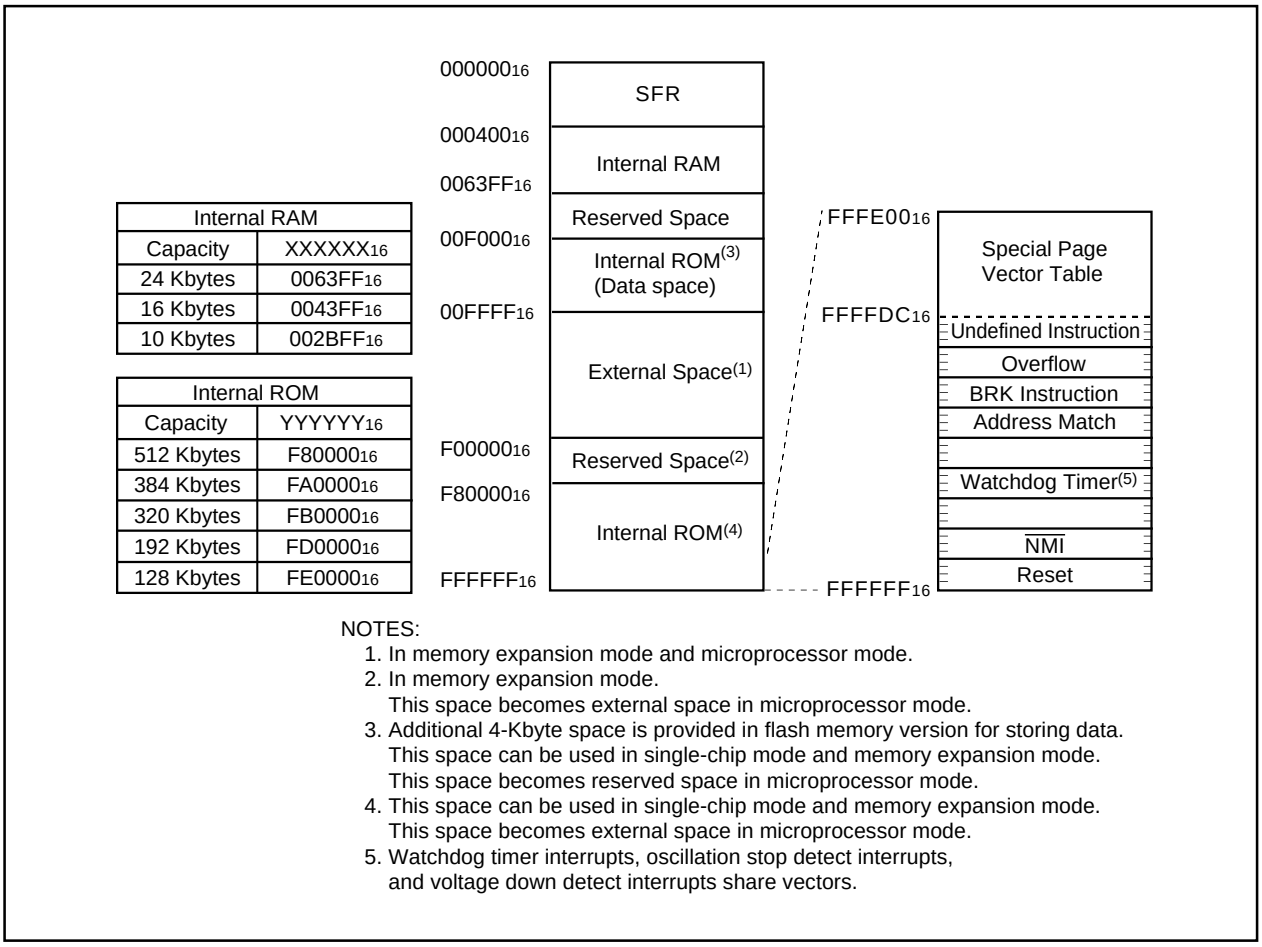
The fixed interrupt vectors are allocated addresses FFFFDC$_{16}$ to FFFFFF$_{16}$. It stores the starting address of each interrupt routine.

The internal RAM is allocated higher addresses beginning with address 000400$_{16}$. For example, a 10-Kbyte internal RAM is allocated addresses 000400$_{16}$ to 002BFF$_{16}$. Besides storing data, it becomes stacks when the subroutine is called or an interrupt is acknowleged.

SFR, consisting of control registers for peripheral functions such as I/O port, A/D converter, serial I/O, and timers, is allocated addresses 000000$_{16}$ to 0003FF$_{16}$. All blank spaces within SFR are reserved and cannot be accessed by users.

The special page vectors are allocated addresses FFFE00$_{16}$ to FFFFDB$_{16}$. It is used for the JMPS instruction and JSRS instruction. Refer to the Renesas publication **M32C/80 Series Software Manual** for details.

In memory expansion mode and microprocessor mode, some spaces are reserved and cannot be accessed by users.



Internal RAM	
Capacity	XXXXXX$_{16}$
24 Kbytes	0063FF$_{16}$
16 Kbytes	0043FF$_{16}$
10 Kbytes	002BFF$_{16}$

Internal ROM	
Capacity	YYYYYY$_{16}$
512 Kbytes	F80000$_{16}$
384 Kbytes	FA0000$_{16}$
320 Kbytes	FB0000$_{16}$
192 Kbytes	FD0000$_{16}$
128 Kbytes	FE0000$_{16}$

NOTES:
1. In memory expansion mode and microprocessor mode.
2. In memory expansion mode.
   This space becomes external space in microprocessor mode.
3. Additional 4-Kbyte space is provided in flash memory version for storing data.
   This space can be used in single-chip mode and memory expansion mode.
   This space becomes reserved space in microprocessor mode.
4. This space can be used in single-chip mode and memory expansion mode.
   This space becomes external space in microprocessor mode.
5. Watchdog timer interrupts, oscillation stop detect interrupts, and voltage down detect interrupts share vectors.

Figure 3.1 Memory Map

4. Special Function Registers (SFR)

Address	Register	Symbol	Value after RESET
000016			
000116			
000216			
000316			
000416	Processor Mode Register 0(1)	PM0	1000 00002(CNVss pin ="L") 0000 00112(CNVss pin ="H")
000516	Processor Mode Register 1	PM1	0016
000616	System Clock Control Register 0	CM0	0000 10002
000716	System Clock Control Register 1	CM1	0010 00002
000816			
000916	Address Match Interrupt Enable Register	AIER	0016
000A16	Protect Register	PRCR	XXXX 00002
000B16	External Data Bus Width Control Register(2)	DS	XXXX 10002(BYTE pin ="L") XXXX 00002(BYTE pin ="H")
000C16	Main Clock Division Register	MCD	XXX0 10002
000D16	Oscillation Stop Detection Register	CM2	0016
000E16	Watchdog Timer Start Register	WDTS	XX16
000F16	Watchdog Timer Control Register	WDC	000X XXXX2
001016 001116 001216	Address Match Interrupt Register 0	RMAD0	00000016
001316	Processor Mode Register 2	PM2	0016
001416 001516 001616	Address Match Interrupt Register 1	RMAD1	00000016
001716	Voltage Detection Register 2(2)	VCR2	0016
001816 001916 001A16	Address Match Interrupt Register 2	RMAD2	00000016
001B16	Voltage Detection Register 1(2)	VCR1	0000 10002
001C16 001D16 001E16	Address Match Interrupt Register 3	RMAD3	00000016
001F16			
002016			
002116			
002216			
002316			
002416			
002516			
002616	PLL Control Register 0	PLC0	0001 X0102
002716	PLL Control Register 1	PLC1	000X 00002
002816 002916 002A16	Address Match Interrupt Register 4	RMAD4	00000016
002B16			
002C16 002D16 002E16	Address Match Interrupt Register 5	RMAD5	00000016
002F16	Voltage Down Detection Interrupt Register(2)	D4INT	0016

X: Indeterminate
Blank spaces are reserved. No access is allowed.
NOTES:
1. The PM01 and PM00 bits in the PM1 register maintain values set before reset even if software reset or watchdog timer reset is performed.
2. These registers in M32C/84T cannot be used.

Address	Register	Symbol	Value after RESET
0030₁₆			
0031₁₆			
0032₁₆			
0033₁₆			
0034₁₆			
0035₁₆			
0036₁₆			
0037₁₆			
0038₁₆ 0039₁₆ 003A₁₆	Address Match Interrupt Register 6	RMAD6	000000₁₆
003B₁₆			
003C₁₆ 003D₁₆ 003E₁₆	Address Match Interrupt Register 7	RMAD7	000000₁₆
003F₁₆			
0040₁₆			
0041₁₆			
0042₁₆			
0043₁₆			
0044₁₆			
0045₁₆			
0046₁₆			
0047₁₆			
0048₁₆	External Space Wait Control Register 0(1)	EWCR0	X0X0 0011₂
0049₁₆	External Space Wait Control Register 1(1)	EWCR1	X0X0 0011₂
004A₁₆	External Space Wait Control Register 2(1)	EWCR2	X0X0 0011₂
004B₁₆	External Space Wait Control Register 3(1)	EWCR3	X0X0 0011₂
004C₁₆	Page Mode Wait Control Register 0(2)	PWCR0	0001 0001₂
004D₁₆	Page Mode Wait Control Register 1(2)	PWCR1	0001 0001₂
004E₁₆			
004F₁₆			
0050₁₆			
0051₁₆			
0052₁₆			
0053₁₆			
0054₁₆			
0055₁₆	Flash Memory Control Register 1	FMR1	0000 0101₂
0056₁₆			
0057₁₆	Flash Memory Control Register 0	FMR0	0000 0001₂(Flash memory version) XXXX XXX0₂(Masked ROM version)
0058₁₆			
0059₁₆			
005A₁₆			
005B₁₆			
005C₁₆			
005D₁₆			
005E₁₆			
005F₁₆			

X: Indeterminate

Blank spaces are reserved. No access is allowed.

NOTES:

1. These registers in M32C/84T cannot be used.
2. These registers can be used only in the ROMless version.

Address	Register	Symbol	Value after RESET
006016			
006116			
006216			
006316			
006416			
006516			
006616			
006716			
006816	DMA0 Interrupt Control Register	DM0IC	XXXX X0002
006916	Timer B5 Interrupt Control Register	TB5IC	XXXX X0002
006A16	DMA2 Interrupt Control Register	DM2IC	XXXX X0002
006B16	UART2 Receive /ACK Interrupt Control Register	S2RIC	XXXX X0002
006C16	Timer A0 Interrupt Control Register	TA0IC	XXXX X0002
006D16	UART3 Receive /ACK Interrupt Control Register	S3RIC	XXXX X0002
006E16	Timer A2 Interrupt Control Register	TA2IC	XXXX X0002
006F16	UART4 Receive /ACK Interrupt Control Register	S4RIC	XXXX X0002
007016	Timer A4 Interrupt Control Register	TA4IC	XXXX X0002
007116	UART0/UART3 Bus Conflict Detect Interrupt Control Register	BCN0IC/BCN3IC	XXXX X0002
007216	UART0 Receive/ACK Interrupt Control Register	S0RIC	XXXX X0002
007316	A/D0 Conversion Interrupt Control Register	AD0IC	XXXX X0002
007416	UART1 Receive/ACK Interrupt Control Register	S1RIC	XXXX X0002
007516	Intelligent I/O Interrupt Control Register 0	IIO0IC	XXXX X0002
007616	Timer B1 Interrupt Control Register	TB1IC	XXXX X0002
007716	Intelligent I/O Interrupt Control Register 2	IIO2IC	XXXX X0002
007816	Timer B3 Interrupt Control Register	TB3IC	XXXX X0002
007916	Intelligent I/O Interrupt Control Register 4	IIO4IC	XXXX X0002
007A16	INT5 Interrupt Control Register	INT5IC	XX00 X0002
007B16			
007C16	INT3 Interrupt Control Register	INT3IC	XX00 X0002
007D16	Intelligent I/O Interrupt Control Register 8	IIO8IC	XXXX X0002
007E16	INT1 Interrupt Control Register	INT1IC	XX00 X0002
007F16	Intelligent I/O Interrupt Control Register 10/ CAN Interrupt 1 Control Register	IIO10IC CAN1IC	XXXX X0002
008016			
008116	CAN Interrupt 2 Control Register	CAN2IC	XXXX X0002
008216			
008316			
008416			
008516			
008616			
008716			
008816	DMA1 Interrupt Control Register	DM1IC	XXXX X0002
008916	UART2 Transmit /NACK Interrupt Control Register	S2TIC	XXXX X0002
008A16	DMA3 Interrupt Control Register	DM3IC	XXXX X0002
008B16	UART3 Transmit /NACK Interrupt Control Register	S3TIC	XXXX X0002
008C16	Timer A1 Interrupt Control Register	TA1IC	XXXX X0002
008D16	UART4 Transmit /NACK Interrupt Control Register	S4TIC	XXXX X0002
008E16	Timer A3 Interrupt Control Register	TA3IC	XXXX X0002
008F16	UART2 Bus Conflict Detect Interrupt Control Register	BCN2IC	XXXX X0002

X: Indeterminate

Blank spaces are reserved. No access is allowed.

Address	Register	Symbol	Value after RESET
009016	UART0 Transmit /NACK Interrupt Control Register	S0TIC	XXXX X0002
009116	UART1/UART4 Bus Conflict Detect Interrupt Control Register	BCN1IC/BCN4IC	XXXX X0002
009216	UART1 Transmit/NACK Interrupt Control Register	S1TIC	XXXX X0002
009316	Key Input Interrupt Control Register	KUPIC	XXXX X0002
009416	Timer B0 Interrupt Control Register	TB0IC	XXXX X0002
009516	Intelligent I/O Interrupt Control Register 1	IIO1IC	XXXX X0002
009616	Timer B2 Interrupt Control Register	TB2IC	XXXX X0002
009716	Intelligent I/O Interrupt Control Register 3	IIO3IC	XXXX X0002
009816	Timer B4 Interrupt Control Register	TB4IC	XXXX X0002
009916			
009A16	INT4 Interrupt Control Register	INT4IC	XX00 X0002
009B16			
009C16	INT2 Interrupt Control Register	INT2IC	XX00 X0002
009D16	Intelligent I/O Interrupt Control Register 9/ CAN Interrupt 0 Control Register	IIO9IC CAN0IC	XXXX X0002
009E16	INT0 Interrupt Control Register	INT0IC	XX00 X0002
009F16	Exit Priority Control Register	RLVL	XXXX 00002
00A016	Interrupt Request Register 0	IIO0IR	0000 000X2
00A116	Interrupt Request Register 1	IIO1IR	0000 000X2
00A216	Interrupt Request Register 2	IIO2IR	0000 000X2
00A316	Interrupt Request Register 3	IIO3IR	0000 000X2
00A416	Interrupt Request Register 4	IIO4IR	0000 000X2
00A516			
00A616			
00A716			
00A816	Interrupt Request Register 8	IIO8IR	0000 000X2
00A916	Interrupt Request Register 9	IIO9IR	0000 000X2
00AA16	Interrupt Request Register 10	IIO10IR	0000 000X2
00AB16	Interrupt Request Register 11	IIO11IR	0000 000X2
00AC16			
00AD16			
00AE16			
00AF16			
00B016	Interrupt Enable Register 0	IIO0IE	0016
00B116	Interrupt Enable Register 1	IIO1IE	0016
00B216	Interrupt Enable Register 2	IIO2IE	0016
00B316	Interrupt Enable Register 3	IIO3IE	0016
00B416	Interrupt Enable Register 4	IIO4IE	0016
00B516			
00B616			
00B716			
00B816	Interrupt Enable Register 8	IIO8IE	0016
00B916	Interrupt Enable Register 9	IIO9IE	0016
00BA16	Interrupt Enable Register 10	IIO10IE	0016
00BB16	Interrupt Enable Register 11	IIO11IE	0016
00BC16			
00BD16			
00BE16			
00BF16			

X: Indeterminate

Blank spaces are reserved. No access is allowed.

Address	Register	Symbol	Value after RESET
00C0₁₆			
00C1₁₆			
00C2₁₆			
00C3₁₆			
00C4₁₆			
00C5₁₆			
00C6₁₆			
00C7₁₆			
00C8₁₆			
00C9₁₆			
00CA₁₆			
00CB₁₆			
00CC₁₆			
00CD₁₆			
00CE₁₆			
00CF₁₆			
00D0₁₆			
00D1₁₆			
00D2₁₆			
00D3₁₆			
00D4₁₆			
00D5₁₆			
00D6₁₆			
00D7₁₆			
00D8₁₆			
00D9₁₆			
00DA₁₆			
00DB₁₆			
00DC₁₆			
00DD₁₆			
00DE₁₆			
00DF₁₆			
00E0₁₆			
00E1₁₆			
00E2₁₆			
00E3₁₆			
00E4₁₆			
00E5₁₆			
00E6₁₆			
00E7₁₆			
00E8₁₆ 00E9₁₆	SI/O Receive Buffer Register 0	G0RB	XXXX XXXX₂ X000 XXXX₂
00EA₁₆	Transmit Buffer/Receive Data Register 0	G0TB/G0DR	XX₁₆
00EB₁₆			
00EC₁₆	Receive Input Register 0	G0RI	XX₁₆
00ED₁₆	SI/O Communication Mode Register 0	G0MR	00₁₆
00EE₁₆	Transmit Output Register 0	G0TO	XX₁₆
00EF₁₆	SI/O Communication Control Register 0	G0CR	0000 X011₂

X: Indeterminate

Blank spaces are reserved. No access is allowed.

Address	Register	Symbol	Value after RESET
00F0$_{16}$	Data Compare Register 00	G0CMP0	XX$_{16}$
00F1$_{16}$	Data Compare Register 01	G0CMP1	XX$_{16}$
00F2$_{16}$	Data Compare Register 02	G0CMP2	XX$_{16}$
00F3$_{16}$	Data Compare Register 03	G0CMP3	XX$_{16}$
00F4$_{16}$	Data Mask Register 00	G0MSK0	XX$_{16}$
00F5$_{16}$	Data Mask Register 01	G0MSK1	XX$_{16}$
00F6$_{16}$	Communication Clock Select Register	CCS	XXXX 0000$_2$
00F7$_{16}$			
00F8$_{16}$ 00F9$_{16}$	Receive CRC Code Register 0	G0RCRC	XX$_{16}$ XX$_{16}$
00FA$_{16}$ 00FB$_{16}$	Transmit CRC Code Register 0	G0TCRC	00$_{16}$ 00$_{16}$
00FC$_{16}$	SI/O Extended Mode Register 0	G0EMR	00$_{16}$
00FD$_{16}$	SI/O Extended Receive Control Register 0	G0ERC	00$_{16}$
00FE$_{16}$	SI/O Special Communication Interrupt Detect Register 0	G0IRF	00$_{16}$
00FF$_{16}$	SI/O Extended Transmit Control Register 0	G0ETC	0000 0XXX$_2$
0100$_{16}$ 0101$_{16}$	Time Measurement/Waveform Generating Register 10	G1TM0/G1PO0	XX$_{16}$ XX$_{16}$
0102$_{16}$ 0103$_{16}$	Time Measurement/Waveform Generating Register 11	G1TM1/G1PO1	XX$_{16}$ XX$_{16}$
0104$_{16}$ 0105$_{16}$	Time Measurement/Waveform Generating Register 12	G1TM2/G1PO2	XX$_{16}$ XX$_{16}$
0106$_{16}$ 0107$_{16}$	Time Measurement/Waveform Generating Register 13	G1TM3/G1PO3	XX$_{16}$ XX$_{16}$
0108$_{16}$ 0109$_{16}$	Time Measurement/Waveform Generating Register 14	G1TM4/G1PO4	XX$_{16}$ XX$_{16}$
010A$_{16}$ 010B$_{16}$	Time Measurement/Waveform Generating Register 15	G1TM5/G1PO5	XX$_{16}$ XX$_{16}$
010C$_{16}$ 010D$_{16}$	Time Measurement/Waveform Generating Register 16	G1TM6/G1PO6	XX$_{16}$ XX$_{16}$
010E$_{16}$ 010F$_{16}$	Time Measurement/Waveform Generating Register 17	G1TM7/G1PO7	XX$_{16}$ XX$_{16}$
0110$_{16}$	Waveform Generating Control Register 10	G1POCR0	0000 X000$_2$
0111$_{16}$	Waveform Generating Control Register 11	G1POCR1	0X00 X000$_2$
0112$_{16}$	Waveform Generating Control Register 12	G1POCR2	0X00 X000$_2$
0113$_{16}$	Waveform Generating Control Register 13	G1POCR3	0X00 X000$_2$
0114$_{16}$	Waveform Generating Control Register 14	G1POCR4	0X00 X000$_2$
0115$_{16}$	Waveform Generating Control Register 15	G1POCR5	0X00 X000$_2$
0116$_{16}$	Waveform Generating Control Register 16	G1POCR6	0X00 X000$_2$
0117$_{16}$	Waveform Generating Control Register 17	G1POCR7	0X00 X000$_2$
0118$_{16}$	Time Measurement Control Register 10	G1TMCR0	00$_{16}$
0119$_{16}$	Time Measurement Control Register 11	G1TMCR1	00$_{16}$
011A$_{16}$	Time Measurement Control Register 12	G1TMCR2	00$_{16}$
011B$_{16}$	Time Measurement Control Register 13	G1TMCR3	00$_{16}$
011C$_{16}$	Time Measurement Control Register 14	G1TMCR4	00$_{16}$
011D$_{16}$	Time Measurement Control Register 15	G1TMCR5	00$_{16}$
011E$_{16}$	Time Measurement Control Register 16	G1TMCR6	00$_{16}$
011F$_{16}$	Time Measurement Control Register 17	G1TMCR7	00$_{16}$

X: Indeterminate

Blank spaces are reserved. No access is allowed.

Address	Register	Symbol	Value after RESET
012016	Base Timer Register 1	G1BT	XX16
012116			XX16
012216	Base Timer Control Register 10	G1BCR0	0016
012316	Base Timer Control Register 11	G1BCR1	X000 000X2
012416	Time Measurement Prescaler Register 16	G1TPR6	0016
012516	Time Measurement Prescaler Register 17	G1TPR7	0016
012616	Function Enable Register 1	G1FE	0016
012716	Function Select Register 1	G1FS	0016
012816	SI/O Receive Buffer Register 1	G1RB	XXXX XXXX2
012916			X000 XXXX2
012A16	Transmit Buffer/Receive Data Register 1	G1TB/G1DR	XX16
012B16			
012C16	Receive Input Register 1	G1RI	XX16
012D16	SI/O Communication Mode Register 1	G1MR	0016
012E16	Transmit Output Register 1	G1TO	XX16
012F16	SI/O Communication Control Register 1	G1CR	0000 X0112
013016	Data Compare Register 10	G1CMP0	XX16
013116	Data Compare Register 11	G1CMP1	XX16
013216	Data Compare Register 12	G1CMP2	XX16
013316	Data Compare Register 13	G1CMP3	XX16
013416	Data Mask Register 10	G1MSK0	XX16
013516	Data Mask Register 11	G1MSK1	XX16
013616			
013716			
013816	Receive CRC Code Register 1	G1RCRC	XX16
013916			XX16
013A16	Transmit CRC Code Register 1	G1TCRC	0016
013B16			0016
013C16	SI/O Extended Mode Register 1	G1EMR	0016
013D16	SI/O Extended Receive Control Register 1	G1ERC	0016
013E16	SI/O Special Communication Interrupt Detect Register 1	G1IRF	0016
013F16	SI/O Extended Transmit Control Register 1	G1ETC	0000 0XXX2
014016			
014116			
014216			
014316			
014416			
014516			
014616			
014716			
014816			
014916			
014A16			
014B16			
014C16			
014D16			
014E16			
014F16			

X: Indeterminate

Blank spaces are reserved. No access is allowed.

Address	Register	Symbol	Value after RESET
0150₁₆			
0151₁₆			
0152₁₆			
0153₁₆			
0154₁₆			
0155₁₆			
0156₁₆			
0157₁₆			
0158₁₆			
0159₁₆			
015A₁₆			
015B₁₆			
015C₁₆			
015D₁₆			
015E₁₆			
015F₁₆			
0160₁₆			
0161₁₆			
0162₁₆			
0163₁₆			
0164₁₆			
0165₁₆			
0166₁₆			
0167₁₆			
0168₁₆			
0169₁₆			
016A₁₆			
016B₁₆			
016C₁₆			
016D₁₆			
016E₁₆			
016F₁₆			
0170₁₆			
0171₁₆			
0172₁₆			
0173₁₆			
0174₁₆			
0175₁₆			
0176₁₆			
0177₁₆			
0178₁₆	Input Function Select Register	IPS	00₁₆
0179₁₆	Input Function Select Register A	IPSA	00₁₆
017A₁₆			
017B₁₆			
017C₁₆			
017D₁₆ to 01DF₁₆			

X: Indeterminate

Blank spaces are reserved. No access is allowed.

Address	Register	Symbol	Value after RESET
01E0₁₆	CAN0 Message Slot Buffer 0 Standard ID0	C0SLOT0_0	XX₁₆
01E1₁₆	CAN0 Message Slot Buffer 0 Standard ID1	C0SLOT0_1	XX₁₆
01E2₁₆	CAN0 Message Slot Buffer 0 Extended ID0	C0SLOT0_2	XX₁₆
01E3₁₆	CAN0 Message Slot Buffer 0 Extended ID1	C0SLOT0_3	XX₁₆
01E4₁₆	CAN0 Message Slot Buffer 0 Extended ID2	C0SLOT0_4	XX₁₆
01E5₁₆	CAN0 Message Slot Buffer 0 Data Length Code	C0SLOT0_5	XX₁₆
01E6₁₆	CAN0 Message Slot Buffer 0 Data 0	C0SLOT0_6	XX₁₆
01E7₁₆	CAN0 Message Slot Buffer 0 Data 1	C0SLOT0_7	XX₁₆
01E8₁₆	CAN0 Message Slot Buffer 0 Data 2	C0SLOT0_8	XX₁₆
01E9₁₆	CAN0 Message Slot Buffer 0 Data 3	C0SLOT0_9	XX₁₆
01EA₁₆	CAN0 Message Slot Buffer 0 Data 4	C0SLOT0_10	XX₁₆
01EB₁₆	CAN0 Message Slot Buffer 0 Data 5	C0SLOT0_11	XX₁₆
01EC₁₆	CAN0 Message Slot Buffer 0 Data 6	C0SLOT0_12	XX₁₆
01ED₁₆	CAN0 Message Slot Buffer 0 Data 7	C0SLOT0_13	XX₁₆
01EE₁₆	CAN0 Message Slot Buffer 0 Time Stamp High-Order	C0SLOT0_14	XX₁₆
01EF₁₆	CAN0 Message Slot Buffer 0 Time Stamp Low-Order	C0SLOT0_15	XX₁₆
01F0₁₆	CAN0 Message Slot Buffer 1 Standard ID0	C0SLOT1_0	XX₁₆
01F1₁₆	CAN0 Message Slot Buffer 1 Standard ID1	C0SLOT1_1	XX₁₆
01F2₁₆	CAN0 Message Slot Buffer 1 Extended ID0	C0SLOT1_2	XX₁₆
01F3₁₆	CAN0 Message Slot Buffer 1 Extended ID1	C0SLOT1_3	XX₁₆
01F4₁₆	CAN0 Message Slot Buffer 1 Extended ID2	C0SLOT1_4	XX₁₆
01F5₁₆	CAN0 Message Slot Buffer 1 Data Length Code	C0SLOT1_5	XX₁₆
01F6₁₆	CAN0 Message Slot Buffer 1 Data 0	C0SLOT1_6	XX₁₆
01F7₁₆	CAN0 Message Slot Buffer 1 Data 1	C0SLOT1_7	XX₁₆
01F8₁₆	CAN0 Message Slot Buffer 1 Data 2	C0SLOT1_8	XX₁₆
01F9₁₆	CAN0 Message Slot Buffer 1 Data 3	C0SLOT1_9	XX₁₆
01FA₁₆	CAN0 Message Slot Buffer 1 Data 4	C0SLOT1_10	XX₁₆
01FB₁₆	CAN0 Message Slot Buffer 1 Data 5	C0SLOT1_11	XX₁₆
01FC₁₆	CAN0 Message Slot Buffer 1 Data 6	C0SLOT1_12	XX₁₆
01FD₁₆	CAN0 Message Slot Buffer 1 Data 7	C0SLOT1_13	XX₁₆
01FE₁₆	CAN0 Message Slot Buffer 1 Time Stamp High-Order	C0SLOT1_14	XX₁₆
01FF₁₆	CAN0 Message Slot Buffer 1 Time Stamp Low-Order	C0SLOT1_15	XX₁₆
0200₁₆ 0201₁₆	CAN0 Control Register 0	C0CTLR0	XX01 0X01₂(1) XXXX 0000₂(1)
0202₁₆ 0203₁₆	CAN0 Status Register	C0STR	0000 0000₂(1) X000 0X01₂(1)
0204₁₆ 0205₁₆	CAN0 Extended ID Register	C0IDR	00₁₆(1) 00₁₆(1)
0206₁₆ 0207₁₆	CAN0 Configuration Register	C0CONR	0000 XXXX₂(1) 0000 0000₂(1)
0208₁₆ 0209₁₆	CAN0 Time Stamp Register	C0TSR	00₁₆(1) 00₁₆(1)
020A₁₆	CAN0 Transmit Error Count Register	C0TEC	00₁₆(1)
020B₁₆	CAN0 Receive Error Count Register	C0REC	00₁₆(1)
020C₁₆ 020D₁₆	CAN0 Slot Interrupt Status Register	C0SISTR	00₁₆(1) 00₁₆(1)
020E₁₆			
020F₁₆			

X: Indeterminate

Blank spaces are reserved. No access is allowed.

NOTES:

1. Values are obtained by setting the SLEEP bit in the C0SLPR register to "1" (sleep mode exited) after reset and supplying the clock to the CAN module.

Address	Register	Symbol	Value after RESET
021016 021116	CAN0 Slot Interrupt Mask Register	C0SIMKR	0016(2) 0016(2)
021216			
021316			
021416	CAN0 Error Interrupt Mask Register	C0EIMKR	XXXX X0002(2)
021516	CAN0 Error Interrupt Status Register	C0EISTR	XXXX X0002(2)
021616	CAN0 Error Cause Register	C0EFR	0016(2)
021716	CAN0 Baud Rate Prescaler	C0BRP	0000 00012(2)
021816			
021916	CAN0 Mode Register	C0MDR	XXXX XX002(2)
021A16			
021B16			
021C16			
021D16			
021E16			
021F16			
022016 022116	CAN0 Single-Shot Control Register	C0SSCTLR	0016(2) 0016(2)
022216			
022316			
022416 022516	CAN0 Single-Shot Status Register	C0SSSTR	0016(2) 0016(2)
022616			
022716			
022816	CAN0 Global Mask Register Standard ID0	C0GMR0	XXX0 00002(2)
022916	CAN0 Global Mask Register Standard ID1	C0GMR1	XX00 00002(2)
022A16	CAN0 Global Mask Register Extended ID0	C0GMR2	XXXX 00002(2)
022B16	CAN0 Global Mask Register Extended ID1	C0GMR3	0016(2)
022C16	CAN0 Global Mask Register Extended ID2	C0GMR4	XX00 00002(2)
022D16			
022E16			
022F16			
023016	CAN0 Message Slot 0 Control Register / CAN0 Local Mask Register A Standard ID0	C0MCTL0/ C0LMAR0	0000 00002(2) XXX0 00002(2)
023116	CAN0 Message Slot 1 Control Register / CAN0 Local Mask Register A Standard ID1	C0MCTL1/ C0LMAR1	0000 00002(2) XX00 00002(2)
023216	CAN0 Message Slot 2 Control Register / CAN0 Local Mask Register A Extended ID0	C0MCTL2/ C0LMAR2	0000 00002(2) XXXX 00002(2)
023316	CAN0 Message Slot 3 Control Register / CAN0 local Mask Register A Extended ID1	C0MCTL3/ C0LMAR3	0016(2) 0016(2)
023416	CAN0 Message Slot 4 Control Register / CAN0 Local Mask Register A Extended ID2	C0MCTL4/ C0LMAR4	0000 00002(2) XX00 00002(2)
023516	CAN0 Message Slot 5 Control Register	C0MCTL5	0016(2)
023616	CAN0 Message Slot 6 Control Register	C0MCTL6	0016(2)
023716	CAN0 Message Slot 7 Control Register	C0MCTL7	0016(2)
023816	CAN0 Message Slot 8 Control Register / CAN0 Local Mask Register B Standard ID0	C0MCTL8/ C0LMBR0	0000 00002(2) XXX0 00002(2)

(Note 1)

X: Indeterminate

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NOTES:

1. The BANKSEL bit in the C0CTLR1 register switches functions for addresses 022016 to 023F16.
2. Values are obtained by setting the SLEEP bit in the C0SLPR register to "1" (sleep mode exited) after reset and supplying the clock to the CAN module.

Address	Register	Symbol	Value after RESET
023916	CAN0 Message Slot 9 Control Register / CAN0 Local Mask Register B Standard ID1	C0MCTL9/ C0LMBR1	0000 00002(2) XX00 00002(2)
023A16	CAN0 Message Slot 10 Control Register / CAN0 Local Mask Register B Extended ID0	C0MCTL10/ C0LMBR2	0000 00002(2) XXXX 00002(2)
023B16	CAN0 Message Slot 11 Control Register / CAN0 Local Mask Register B Extended ID1	C0MCTL11/ C0LMBR3	0016(2) 0016(2)
023C16	CAN0 Message Slot 12 Control Register / CAN0 Local Mask Register B Extended ID2	C0MCTL12/ C0LMBR4	0000 00002(2) XX00 00002(2)
023D16	CAN0 Message Slot 13 Control Register	C0MCTL13	0016(2)
023E16	CAN0 Message Slot 14 Control Register	C0MCTL14	0016(2)
023F16	CAN0 Message Slot 15 Control Register	C0MCTL15	0016(2)
024016	CAN0 Slot Buffer Select Register	C0SBS	0016(2)
024116	CAN0 Control Register 1	C0CTLR1	X000 00XX2(2)
024216	CAN0 Sleep Control Register	C0SLPR	XXXX XXX02
024316			
024416 024516	CAN0 Acceptance Filter Support Register	C0AFS	0016(2) 0116(2)
024616			
024716			
024816			
024916			
024A16			
024B16			
024C16			
024D16			
024E16			
024F16			
025016			
025116			
025216			
025316			
025416			
025516			
025616			
025716			
025816			
025916			
025A16			
025B16			
025C16			
025D16 to 02BF16			

(Note 1)

X: Indeterminate

Blank spaces are reserved. No access is allowed.

NOTES:

1. The BANKSEL bit in the C0CTLR1 register switches functions for addresses 022016 to 023F16.
2. Values are obtained by setting the SLEEP bit in the C0SLPR register to "1" (sleep mode exited) after reset and supplying the clock to the CAN module.

Address	Register	Symbol	Value after RESET
02C0$_{16}$ 02C1$_{16}$	X0 Register Y0 Register	X0R,Y0R	XX$_{16}$ XX$_{16}$
02C2$_{16}$ 02C3$_{16}$	X1 Register Y1 Register	X1R,Y1R	XX$_{16}$ XX$_{16}$
02C4$_{16}$ 02C5$_{16}$	X2 Register Y2 Register	X2R,Y2R	XX$_{16}$ XX$_{16}$
02C6$_{16}$ 02C7$_{16}$	X3 Register Y3 Register	X3R,Y3R	XX$_{16}$ XX$_{16}$
02C8$_{16}$ 02C9$_{16}$	X4 Register Y4 Register	X4R,Y4R	XX$_{16}$ XX$_{16}$
02CA$_{16}$ 02CB$_{16}$	X5 Register Y5 Register	X5R,Y5R	XX$_{16}$ XX$_{16}$
02CC$_{16}$ 02CD$_{16}$	X6 Register Y6 Register	X6R,Y6R	XX$_{16}$ XX$_{16}$
02CE$_{16}$ 02CF$_{16}$	X7 Register Y7 Register	X7R,Y7R	XX$_{16}$ XX$_{16}$
02D0$_{16}$ 02D1$_{16}$	X8 Register Y8 Register	X8R,Y8R	XX$_{16}$ XX$_{16}$
02D2$_{16}$ 02D3$_{16}$	X9 Register Y9 Register	X9R,Y9R	XX$_{16}$ XX$_{16}$
02D4$_{16}$ 02D5$_{16}$	X10 Register Y10 Register	X10R,Y10R	XX$_{16}$ XX$_{16}$
02D6$_{16}$ 02D7$_{16}$	X11 Register Y11 Register	X11R,Y11R	XX$_{16}$ XX$_{16}$
02D8$_{16}$ 02D9$_{16}$	X12 Register Y12 Register	X12R,Y12R	XX$_{16}$ XX$_{16}$
02DA$_{16}$ 02DB$_{16}$	X13 Register Y13 Register	X13R,Y13R	XX$_{16}$ XX$_{16}$
02DC$_{16}$ 02DD$_{16}$	X14 Register Y14 Register	X14R,Y14R	XX$_{16}$ XX$_{16}$
02DE$_{16}$ 02DF$_{16}$	X15 Register Y15 Register	X15R,Y15R	XX$_{16}$ XX$_{16}$
02E0$_{16}$	X/Y Control Register	XYC	XXXX XX00$_2$
02E1$_{16}$			
02E2$_{16}$			
02E3$_{16}$			
02E4$_{16}$	UART1 Special Mode Register 4	U1SMR4	00$_{16}$
02E5$_{16}$	UART1 Special Mode Register 3	U1SMR3	00$_{16}$
02E6$_{16}$	UART1 Special Mode Register 2	U1SMR2	00$_{16}$
02E7$_{16}$	UART1 Special Mode Register	U1SMR	00$_{16}$
02E8$_{16}$	UART1 Transmit/Receive Mode Register	U1MR	00$_{16}$
02E9$_{16}$	UART1 Bit Rate Register	U1BRG	XX$_{16}$
02EA$_{16}$ 02EB$_{16}$	UART1 Transmit Buffer Register	U1TB	XX$_{16}$ XX$_{16}$
02EC$_{16}$	UART1 Transmit/Receive Control Register 0	U1C0	0000 1000$_2$
02ED$_{16}$	UART1 Transmit/Receive Control Register 1	U1C1	0000 0010$_2$
02EE$_{16}$ 02EF$_{16}$	UART1 Receive Buffer Register	U1RB	XX$_{16}$ XX$_{16}$

X: Indeterminate

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Address	Register	Symbol	Value after RESET
02F0₁₆			
02F1₁₆			
02F2₁₆			
02F3₁₆			
02F4₁₆	UART4 Special Mode Register 4	U4SMR4	00₁₆
02F5₁₆	UART4 Special Mode Register 3	U4SMR3	00₁₆
02F6₁₆	UART4 Special Mode Register 2	U4SMR2	00₁₆
02F7₁₆	UART4 Special Mode Register	U4SMR	00₁₆
02F8₁₆	UART4 Transmit/Receive Mode Register	U4MR	00₁₆
02F9₁₆	UART4 Bit Rate Register	U4BRG	XX₁₆
02FA₁₆	UART4 Transmit Buffer Register	U4TB	XX₁₆
02FB₁₆			XX₁₆
02FC₁₆	UART4 Transmit/Receive Control Register 0	U4C0	0000 1000₂
02FD₁₆	UART4 Transmit/Receive Control Register 1	U4C1	0000 0010₂
02FE₁₆	UART4 Receive Buffer Register	U4RB	XX₁₆
02FF₁₆			XX₁₆
0300₁₆	Timer B3, B4, B5 Count Start Flag	TBSR	000X XXXX₂
0301₁₆			
0302₁₆	Timer A1-1 Register	TA11	XX₁₆
0303₁₆			XX₁₆
0304₁₆	Timer A2-1 Register	TA21	XX₁₆
0305₁₆			XX₁₆
0306₁₆	Timer A4-1 Register	TA41	XX₁₆
0307₁₆			XX₁₆
0308₁₆	Three-Phase PWM Control Register 0	INVC0	00₁₆
0309₁₆	Three-Phase PWM Control Register 1	INVC1	00₁₆
030A₁₆	Three-Phase Output Buffer Register 0	IDB0	XX11 1111₂
030B₁₆	Three-Phase Output Buffer Register 1	IDB1	XX11 1111₂
030C₁₆	Dead Time Timer	DTT	XX₁₆
030D₁₆	Timer B2 Interrupt Generation Frequency Set Counter	ICTB2	XX₁₆
030E₁₆			
030F₁₆			
0310₁₆	Timer B3 Register	TB3	XX₁₆
0311₁₆			XX₁₆
0312₁₆	Timer B4 Register	TB4	XX₁₆
0313₁₆			XX₁₆
0314₁₆	Timer B5 Register	TB5	XX₁₆
0315₁₆			XX₁₆
0316₁₆			
0317₁₆			
0318₁₆			
0319₁₆			
031A₁₆			
031B₁₆	Timer B3 Mode Register	TB3MR	00XX 0000₂
031C₁₆	Timer B4 Mode Register	TB4MR	00XX 0000₂
031D₁₆	Timer B5 Mode Register	TB5MR	00XX 0000₂
031E₁₆			
031F₁₆	External Interrupt Cause Select Register	IFSR	00₁₆

X: Indeterminate

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Address	Register	Symbol	Value after RESET
0320₁₆			
0321₁₆			
0322₁₆			
0323₁₆			
0324₁₆	UART3 Special Mode Register 4	U3SMR4	00₁₆
0325₁₆	UART3 Special Mode Register 3	U3SMR3	00₁₆
0326₁₆	UART3 Special Mode Register 2	U3SMR2	00₁₆
0327₁₆	UART3 Special Mode Register	U3SMR	00₁₆
0328₁₆	UART3 Transmit/Receive Mode Register	U3MR	00₁₆
0329₁₆	UART3 Bit Rate Register	U3BRG	XX₁₆
032A₁₆ 032B₁₆	UART3 Transmit Buffer Register	U3TB	XX₁₆ XX₁₆
032C₁₆	UART3 Transmit/Receive Control Register 0	U3C0	0000 1000₂
032D₁₆	UART3 Transmit/Receive Control Register 1	U3C1	0000 0010₂
032E₁₆ 032F₁₆	UART3 Receive Buffer Register	U3RB	XX₁₆ XX₁₆
0330₁₆			
0331₁₆			
0332₁₆			
0333₁₆			
0334₁₆	UART2 Special Mode Register 4	U2SMR4	00₁₆
0335₁₆	UART2 Special Mode Register 3	U2SMR3	00₁₆
0336₁₆	UART2 Special Mode Register 2	U2SMR2	00₁₆
0337₁₆	UART2 Special Mode Register	U2SMR	00₁₆
0338₁₆	UART2 Transmit/Receive Mode Register	U2MR	00₁₆
0339₁₆	UART2 Bit Rate Register	U2BRG	XX₁₆
033A₁₆ 033B₁₆	UART2 Transmit Buffer Register	U2TB	XX₁₆ XX₁₆
033C₁₆	UART2 Transmit/Receive Control Register 0	U2C0	0000 1000₂
033D₁₆	UART2 Transmit/Receive Control Register 1	U2C1	0000 0010₂
033E₁₆ 033F₁₆	UART2 Receive Buffer Register	U2RB	XX₁₆ XX₁₆
0340₁₆	Count Start Flag	TABSR	00₁₆
0341₁₆	Clock Prescaler Reset Flag	CPSRF	0XXX XXXX₂
0342₁₆	One-Shot Start Flag	ONSF	00₁₆
0343₁₆	Trigger Select Register	TRGSR	00₁₆
0344₁₆	Up/Down Flag	UDF	00₁₆
0345₁₆			
0346₁₆ 0347₁₆	Timer A0 Register	TA0	XX₁₆ XX₁₆
0348₁₆ 0349₁₆	Timer A1 Register	TA1	XX₁₆ XX₁₆
034A₁₆ 034B₁₆	Timer A2 Register	TA2	XX₁₆ XX₁₆
034C₁₆ 034D₁₆	Timer A3 Register	TA3	XX₁₆ XX₁₆
034E₁₆ 034F₁₆	Timer A4 Register	TA4	XX₁₆ XX₁₆

X: Indeterminate

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Address	Register	Symbol	Value after RESET
035016 035116	Timer B0 Register	TB0	XX16 XX16
035216 035316	Timer B1 Register	TB1	XX16 XX16
035416 035516	Timer B2 Register	TB2	XX16 XX16
035616	Timer A0 Mode Register	TA0MR	0016
035716	Timer A1 Mode Register	TA1MR	0016
035816	Timer A2 Mode Register	TA2MR	0016
035916	Timer A3 Mode Register	TA3MR	0016
035A16	Timer A4 Mode Register	TA4MR	0016
035B16	Timer B0 Mode Register	TB0MR	00XX 00002
035C16	Timer B1 Mode Register	TB1MR	00XX 00002
035D16	Timer B2 Mode Register	TB2MR	00XX 00002
035E16	Timer B2 Special Mode Register	TB2SC	XXXX XXX02
035F16	Count Source Prescaler Register(1)	TCSPR	0XXX 00002
036016			
036116			
036216			
036316			
036416	UART0 Special Mode Register 4	U0SMR4	0016
036516	UART0 Special Mode Register 3	U0SMR3	0016
036616	UART0 Special Mode Register 2	U0SMR2	0016
036716	UART0 Special Mode Register	U0SMR	0016
036816	UART0 Transmit/Receive Mode Register	U0MR	0016
036916	UART0 Bit Rate Register	U0BRG	XX16
036A16 036B16	UART0 Transmit Buffer Register	U0TB	XX16 XX16
036C16	UART0 Transmit/Receive Control Register 0	U0C0	0000 10002
036D16	UART0 Transmit/Receive Control Register 1	U0C1	0000 00102
036E16 036F16	UART0 Receive Buffer Register	U0RB	XX16 XX16
037016			
037116			
037216			
037316			
037416			
037516			
037616			
037716			
037816	DMA0 Request Source Select Register	DM0SL	0X00 00002
037916	DMA1 Request Source Select Register	DM1SL	0X00 00002
037A16	DMA2 Request Source Select Register	DM2SL	0X00 00002
037B16	DMA3 Request Source Select Register	DM3SL	0X00 00002
037C16 037D16	CRC Data Register	CRCD	XX16 XX16
037E16	CRC Input Register	CRCIN	XX16
037F16			

X: Indeterminate

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NOTES:

1. The TCSPR register maintains values set before reset, even after software reset or watchdog timer reset has been performed.

Address	Register	Symbol	Value after RESET
038016 038116	A/D0 Register 0	AD00	XXXX XXXX2 0000 00002
038216 038316	A/D0 Register 1	AD01	XX16 XX16
038416 038516	A/D0 Register 2	AD02	XX16 XX16
038616 038716	A/D0 Register 3	AD03	XX16 XX16
038816 038916	A/D0 Register 4	AD04	XX16 XX16
038A16 038B16	A/D0 Register 5	AD05	XX16 XX16
038C16 038D16	A/D0 Register 6	AD06	XX16 XX16
038E16 038F16	A/D0 Register 7	AD07	XX16 XX16
039016			
039116			
039216	A/D0 Control Register 4	AD0CON4	XXXX 00XX2
039316			
039416	A/D0 Control Register 2	AD0CON2	XX0X X0002
039516	A/D0 Control Register 3	AD0CON3	XXXX X0002
039616	A/D0 Control Register 0	AD0CON0	0016
039716	A/D0 Control Register 1	AD0CON1	0016
039816	D/A Register 0	DA0	XX16
039916			
039A16	D/A Register 1	DA1	XX16
039B16			
039C16	D/A Control Register	DACON	XXXX XX002
039D16			
039E16			
039F16			

X: Indeterminate

Blank spaces are reserved. No access is allowed.

<144-pin Package>

Address	Register	Symbol	Value after RESET
03A0$_{16}$	Function Select Register A8	PS8	X000 0000$_2$
03A1$_{16}$	Function Select Register A9	PS9	00$_{16}$
03A2$_{16}$			
03A3$_{16}$			
03A4$_{16}$			
03A5$_{16}$			
03A6$_{16}$			
03A7$_{16}$	Function Select Register D1	PSD1	X0XX XX00$_2$
03A8$_{16}$			
03A9$_{16}$			
03AA$_{16}$			
03AB$_{16}$			
03AC$_{16}$	Function Select Register C2	PSC2	XXXX X00X$_2$
03AD$_{16}$	Function Select Register C3	PSC3	X0XX XXXX$_2$
03AE$_{16}$			
03AF$_{16}$	Function Select Register C	PSC	00X0 0000$_2$
03B0$_{16}$	Function Select Register A0	PS0	00$_{16}$
03B1$_{16}$	Function Select Register A1	PS1	00$_{16}$
03B2$_{16}$	Function Select Register B0	PSL0	00$_{16}$
03B3$_{16}$	Function Select Register B1	PSL1	00$_{16}$
03B4$_{16}$	Function Select Register A2	PS2	00X0 0000$_2$
03B5$_{16}$	Function Select Register A3	PS3	00$_{16}$
03B6$_{16}$	Function Select Register B2	PSL2	00X0 0000$_2$
03B7$_{16}$	Function Select Register B3	PSL3	00$_{16}$
03B8$_{16}$			
03B9$_{16}$	Function Select Register A5	PS5	XXX0 0000$_2$
03BA$_{16}$			
03BB$_{16}$			
03BC$_{16}$			
03BD$_{16}$			
03BE$_{16}$			
03BF$_{16}$			
03C0$_{16}$	Port P6 Register	P6	XX$_{16}$
03C1$_{16}$	Port P7 Register	P7	XX$_{16}$
03C2$_{16}$	Port P6 Direction Register	PD6	00$_{16}$
03C3$_{16}$	Port P7 Direction Register	PD7	00$_{16}$
03C4$_{16}$	Port P8 Register	P8	XX$_{16}$
03C5$_{16}$	Port P9 Register	P9	XX$_{16}$
03C6$_{16}$	Port P8 Direction Register	PD8	00X0 0000$_2$
03C7$_{16}$	Port P9 Direction Register	PD9	00$_{16}$
03C8$_{16}$	Port P10 Register	P10	XX$_{16}$
03C9$_{16}$	Port P11 Register	P11	XX$_{16}$
03CA$_{16}$	Port P10 Direction Register	PD10	00$_{16}$
03CB$_{16}$	Port P11 Direction Register	PD11	XXX0 0000$_2$
03CC$_{16}$	Port P12 Register	P12	XX$_{16}$
03CD$_{16}$	Port P13 Register	P13	XX$_{16}$
03CE$_{16}$	Port P12 Direction Register	PD12	00$_{16}$
03CF$_{16}$	Port P13 Direction Register	PD13	00$_{16}$

X: Indeterminate

Blank spaces are reserved. No access is allowed.

<144-pin Package>

Address	Register	Symbol	Value after RESET
03D0₁₆	Port P14 Register	P14	XX₁₆
03D1₁₆	Port P15 Register	P15	XX₁₆
03D2₁₆	Port P14 Direction Register	PD14	X000 0000₂
03D3₁₆	Port P15 Direction Register	PD15	00₁₆
03D4₁₆			
03D5₁₆			
03D6₁₆			
03D7₁₆			
03D8₁₆			
03D9₁₆			
03DA₁₆	Pull-Up Control Register 2	PUR2	00₁₆
03DB₁₆	Pull-Up Control Register 3	PUR3	00₁₆
03DC₁₆	Pull-Up Control Register 4	PUR4	XXXX 0000₂
03DD₁₆			
03DE₁₆			
03DF₁₆			
03E0₁₆	Port P0 Register	P0	XX₁₆
03E1₁₆	Port P1 Register	P1	XX₁₆
03E2₁₆	Port P0 Direction Register	PD0	00₁₆
03E3₁₆	Port P1 Direction Register	PD1	00₁₆
03E4₁₆	Port P2 Register	P2	XX₁₆
03E5₁₆	Port P3 Register	P3	XX₁₆
03E6₁₆	Port P2 Direction Register	PD2	00₁₆
03E7₁₆	Port P3 Direction Register	PD3	00₁₆
03E8₁₆	Port P4 Register	P4	XX₁₆
03E9₁₆	Port P5 Register	P5	XX₁₆
03EA₁₆	Port P4 Direction Register	PD4	00₁₆
03EB₁₆	Port P5 Direction Register	PD5	00₁₆
03EC₁₆			
03ED₁₆			
03EE₁₆			
03EF₁₆			
03F0₁₆	Pull-Up Control Register 0	PUR0	00₁₆
03F1₁₆	Pull-Up Control Register 1	PUR1	XXXX 0000₂
03F2₁₆			
03F3₁₆			
03F4₁₆			
03F5₁₆			
03F6₁₆			
03F7₁₆			
03F8₁₆			
03F9₁₆			
03FA₁₆			
03FB₁₆			
03FC₁₆			
03FD₁₆			
03FE₁₆			
03FF₁₆	Port Control Register	PCR	XXXX XXX0₂

X: Indeterminate

Blank spaces are reserved. No access is allowed.

<100-pin Package>

Address	Register	Symbol	Value after RESET
03A0$_{16}$			
03A1$_{16}$			
03A2$_{16}$			
03A3$_{16}$			
03A4$_{16}$			
03A5$_{16}$			
03A6$_{16}$			
03A7$_{16}$	Function Select Register D1	PSD1	X0XX XX00$_2$
03A8$_{16}$			
03A9$_{16}$			
03AA$_{16}$			
03AB$_{16}$			
03AC$_{16}$	Function Select Register C2	PSC2	XXXX X00X$_2$
03AD$_{16}$	Function Select Register C3	PSC3	X0XX XXXX$_2$
03AE$_{16}$			
03AF$_{16}$	Function Select Register C	PSC	00X0 0000$_2$
03B0$_{16}$	Function Select Register A0	PS0	00$_{16}$
03B1$_{16}$	Function Select Register A1	PS1	00$_{16}$
03B2$_{16}$	Function Select Register B0	PSL0	00$_{16}$
03B3$_{16}$	Function Select Register B1	PSL1	00$_{16}$
03B4$_{16}$	Function Select Register A2	PS2	00X0 0000$_2$
03B5$_{16}$	Function Select Register A3	PS3	00$_{16}$
03B6$_{16}$	Function Select Register B2	PSL2	00X0 0000$_2$
03B7$_{16}$	Function Select Register B3	PSL3	00$_{16}$
03B8$_{16}$			
03B9$_{16}$			
03BA$_{16}$			
03BB$_{16}$			
03BC$_{16}$			
03BD$_{16}$			
03BE$_{16}$			
03BF$_{16}$			
03C0$_{16}$	Port P6 Register	P6	XX$_{16}$
03C1$_{16}$	Port P7 Register	P7	XX$_{16}$
03C2$_{16}$	Port P6 Direction Register	PD6	00$_{16}$
03C3$_{16}$	Port P7 Direction Register	PD7	00$_{16}$
03C4$_{16}$	Port P8 Register	P8	XX$_{16}$
03C5$_{16}$	Port P9 Register	P9	XX$_{16}$
03C6$_{16}$	Port P8 Direction Register	PD8	00X0 0000$_2$
03C7$_{16}$	Port P9 Direction Register	PD9	00$_{16}$
03C8$_{16}$	Port P10 Register	P10	XX$_{16}$
03C9$_{16}$			
03CA$_{16}$	Port P10 Direction Register	PD10	00$_{16}$
03CB$_{16}$	Set default value to "FF$_{16}$"		
03CC$_{16}$			
03CD$_{16}$			
03CE$_{16}$	Set default value to "FF$_{16}$"		
03CF$_{16}$	Set default value to "FF$_{16}$"		

X: Indeterminate

Blank spaces are reserved. No access is allowed.

<100-pin Package>

Address	Register	Symbol	Value after RESET
03D0$_{16}$			
03D1$_{16}$			
03D2$_{16}$	Set default value to "FF$_{16}$"		
03D3$_{16}$	Set default value to "FF$_{16}$"		
03D4$_{16}$			
03D5$_{16}$			
03D6$_{16}$			
03D7$_{16}$			
03D8$_{16}$			
03D9$_{16}$			
03DA$_{16}$	Pull-Up Control Register 2	PUR2	00$_{16}$
03DB$_{16}$	Pull-Up Control Register 3	PUR3	00$_{16}$
03DC$_{16}$	Set default value to "00$_{16}$"		
03DD$_{16}$			
03DE$_{16}$			
03DF$_{16}$			
03E0$_{16}$	Port P0 Register	P0	XX$_{16}$
03E1$_{16}$	Port P1 Register	P1	XX$_{16}$
03E2$_{16}$	Port P0 Direction Register	PD0	00$_{16}$
03E3$_{16}$	Port P1 Direction Register	PD1	00$_{16}$
03E4$_{16}$	Port P2 Register	P2	XX$_{16}$
03E5$_{16}$	Port P3 Register	P3	XX$_{16}$
03E6$_{16}$	Port P2 Direction Register	PD2	00$_{16}$
03E7$_{16}$	Port P3 Direction Register	PD3	00$_{16}$
03E8$_{16}$	Port P4 Register	P4	XX$_{16}$
03E9$_{16}$	Port P5 Register	P5	XX$_{16}$
03EA$_{16}$	Port P4 Direction Register	PD4	00$_{16}$
03EB$_{16}$	Port P5 Direction Register	PD5	00$_{16}$
03EC$_{16}$			
03ED$_{16}$			
03EE$_{16}$			
03EF$_{16}$			
03F0$_{16}$	Pull-up Control Register 0	PUR0	00$_{16}$
03F1$_{16}$	Pull-up Control Register 1	PUR1	XXXX 0000$_{2}$
03F2$_{16}$			
03F3$_{16}$			
03F4$_{16}$			
03F5$_{16}$			
03F6$_{16}$			
03F7$_{16}$			
03F8$_{16}$			
03F9$_{16}$			
03FA$_{16}$			
03FB$_{16}$			
03FC$_{16}$			
03FD$_{16}$			
03FE$_{16}$			
03FF$_{16}$	Port Control Register	PCR	XXXX XXX0$_{2}$

X: Indeterminate

Blank spaces are reserved. No access is allowed.

5. Electrical Characteristics

5.1 Electrical Characteristics (M32C/84)

Table 5.1 Absolute Maximum Ratings

Symbol	Parameter		Condition	Value	Unit
V_{CC1}, V_{CC2}	Supply Voltage		V_{CC1}=AV$_{CC}$	-0.3 to 6.0	V
V_{CC2}	Supply Voltage		-	-0.3 to V_{CC1}	V
AV$_{CC}$	Analog Supply Voltage		V_{CC1}=AV$_{CC}$	-0.3 to 6.0	V
V_I	Input Voltage	$\overline{RESET}$, CNV$_{SS}$, BYTE, P6$_0$-P6$_7$, P7$_2$-P7$_7$, P8$_0$-P8$_7$, P9$_0$-P9$_7$, P10$_0$-P10$_7$, P14$_0$-P14$_6$, P15$_0$-P15$_7$(1), V_{REF}, X_{IN}		-0.3 to V_{CC1}+0.3	V
		P0$_0$-P0$_7$, P1$_0$-P1$_7$, P2$_0$-P2$_7$, P3$_0$-P3$_7$, P4$_0$-P4$_7$, P5$_0$-P5$_7$, P11$_0$-P11$_4$, P12$_0$-P12$_7$, P13$_0$-P13$_7$(1)		-0.3 to V_{CC2}+0.3	
		P7$_0$, P7$_1$		-0.3 to 6.0	
V_O	Output Voltage	P6$_0$-P6$_7$, P7$_2$-P7$_7$, P8$_0$-P8$_4$, P8$_6$, P8$_7$, P9$_0$-P9$_7$, P10$_0$-P10$_7$, P14$_0$-P14$_6$, P15$_0$-P15$_7$(1), X_{OUT}		-0.3 to V_{CC1}+0.3	V
		P0$_0$-P0$_7$, P1$_0$-P1$_7$, P2$_0$-P2$_7$, P3$_0$-P3$_7$, P4$_0$-P4$_7$, P5$_0$-P5$_7$, P11$_0$-P11$_4$, P12$_0$-P12$_7$, P13$_0$-P13$_7$(1)		-0.3 to V_{CC2}+0.3	
		P7$_0$, P7$_1$		-0.3 to 6.0	
Pd	Power Dissipation		Topr=25° C	500	mW
Topr	Operating Ambient Temperature	during CPU operation		-20 to 85/ -40 to 85(2)	° C
		during flash memory program and erase operation		0 to 60	
Tstg	Storage Temperature			-65 to 150	° C

NOTES:
1. P11 to P15 are provided in the 144-pin package only.
2. Contact Renesas Technology Sales Co., Ltd, if temperature range of -40 to 85° C is required.

Table 5.2 Recommended Operating Conditions

(V_{CC1}= V_{CC2}=3.0V to 5.5V at Topr=– 20 to 85°C unless otherwise specified)

Symbol	Parameter		Standard			Unit
			Min.	Typ.	Max.	
V_{CC1}, V_{CC2}	Supply Voltage (V_{CC1}≥ V_{CC2})		3.0	5.0	5.5	V
AVCC	Analog Supply Voltage			V_{CC1}		V
VSS	Supply Voltage			0		V
AVSS	Analog Supply Voltage			0		V
V_{IH}	Input High ("H") Voltage	$P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$(4)	0.8V_{CC2}		V_{CC2}	V
		$P6_0$-$P6_7$, $P7_2$-$P7_7$, $P8_0$-$P8_7$(3), $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(4), X_{IN}, $\overline{RESET}$, CNV_{SS}, BYTE	0.8V_{CC1}		V_{CC1}	
		$P7_0$, $P7_1$	0.8V_{CC1}		6.0	
		$P0_0$-$P0_7$, $P1_0$-$P1_7$ (in single-chip mode)	0.8V_{CC2}		V_{CC2}	
		$P0_0$-$P0_7$, $P1_0$-$P1_7$ (in memory expansion mode and microprocesor mode)	0.5V_{CC2}		V_{CC2}	
V_{IL}	Input Low ("L") Voltage	$P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$(4)	0		0.2V_{CC2}	V
		$P6_0$-$P6_7$, $P7_0$-$P7_7$, $P8_0$-$P8_7$(3), $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(4), X_{IN}, $\overline{RESET}$, CNV_{SS}, BYTE	0		0.2V_{CC1}	
		$P0_0$-$P0_7$, $P1_0$-$P1_7$ (in single-chip mode)	0		0.2V_{CC2}	
		$P0_0$-$P0_7$, $P1_0$-$P1_7$ (in memory expansion mode and microprocesor mode)	0		0.16V_{CC2}	
$I_{OH(peak)}$	Peak Output High ("H") Current(2)	$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P6_0$-$P6_7$, $P7_2$-$P7_7$, $P8_0$-$P8_4$, $P8_6$, $P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(4)			-10.0	mA
$I_{OH(avg)}$	Average Output High ("H") Current(1)	$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P6_0$-$P6_7$, $P7_2$-$P7_7$, $P8_0$-$P8_4$, $P8_6$, $P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(4)			-5.0	mA
$I_{OL(peak)}$	Peak Output Low ("L") Current(2)	$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P6_0$-$P6_7$, $P7_0$-$P7_7$, $P8_0$-$P8_4$, $P8_6$, $P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(4)			10.0	mA
$I_{OL(avg)}$	Average Output Low ("L") Current(1)	$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P6_0$-$P6_7$, $P7_0$-$P7_7$, $P8_0$-$P8_4$, $P8_6$, $P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(4)			5.0	mA

NOTES:

1. Typical values when average output current is 100ms.
2. Total $I_{OL(peak)}$ for P0, P1, P2, $P8_6$, $P8_7$, P9, P10, P11, P14 and P15 must be 80mA or less.
   Total $I_{OL(peak)}$ for P3, P4, P5, P6, P7, $P8_0$ to $P8_4$, P12 and P13 must be 80mA or less.
   Total $I_{OH(peak)}$ for P0, P1, P2, and P11 must be -40mA or less.
   Total $I_{OH(peak)}$ for $P8_6$, $P8_7$, P9, P10, P14 and P15 must be -40mA or less.
   Total $I_{OH(peak)}$ for P3, P4, P5, P12 and P13 must be -40mA or less.
   Total $I_{OH(peak)}$ for P6, P7, and $P8_0$ to $P8_4$ must be -40mA or less.
3. V_{IH} and V_{IL} reference for $P8_7$ applies when $P8_7$ is used as a programmable input port.
   It does not apply when $P8_7$ is used as X_{CIN}.
4. P11 to P15 are provided in the 144-pin package only.

Table 5.2 Recommended Operating Conditions (Continued)
(V_{CC1}=V_{CC2}=3.0V to 5.5V at Topr=–20 to 85°C unless otherwise specified)

Symbol	Parameter		Standard			Unit
			Min.	Typ.	Max.	
$f(BCLK)$	CPU Clock Frequency	V_{CC1}=4.2 to 5.5V	0		32	MHz
		V_{CC1}=3.0 to 5.5V	0		24	MHz
$f(X_{IN})$	Main Clock Input Frequency	V_{CC1}=4.2 to 5.5V	0		32	MHz
		V_{CC1}=3.0 to 5.5V	0		24	MHz
$f(X_{CIN})$	Sub Clock Frequency			32.768	50	kHz
$f(Ring)$	On-chip Oscillator Frequency (V_{CC1}=V_{CC2}=5.0V, Topr=25° C)		0.5	1	2	MHz
$f(PLL)$	PLL Clock Frequency	V_{CC1}=4.2 to 5.5V	10		32	MHz
		V_{CC1}=3.0 to 5.5V	10		24	MHz
$t_{SU(PLL)}$	Wait Time to Stabilize PLL Frequency Synthesizer	V_{CC1}=5.0V			5	ms
		V_{CC1}=3.3V			10	ms

$V_{CC1}=V_{CC2}=5V$

Table 5.3 Electrical Characteristics

($V_{CC1}=V_{CC2}=4.2$ to 5.5V, $V_{SS}=0V$ at Topr= –20 to 85°C, f(BCLK)=32MHz unless otherwise specified)

Symbol	Parameter		Condition	Standard			Unit
				Min.	Typ.	Max.	
V_{OH}	Output High ("H") Voltage	$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$	I_{OH}=-5mA	V_{CC2}-2.0		V_{CC2}	V
		$P6_0$-$P6_7$, $P7_2$-$P7_7$, $P8_0$-$P8_4$, $P8_6$, $P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(1)	I_{OH}=-5mA	V_{CC1}-2.0		V_{CC1}	
		$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$	I_{OH}=-200µA	V_{CC2}-0.3		V_{CC2}	V
		$P6_0$-$P6_7$, $P7_2$-$P7_7$, $P8_0$-$P8_4$, $P8_6$, $P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$,$P14_0$-$P14_6$, $P15_0$-$P15_7$(1)	I_{OH}=-200µA	V_{CC1}-0.3		V_{CC1}	
		X_{OUT}	I_{OH}=-1mA	3.0		V_{CC1}	V
		X_{COUT} High Power	No load applied		2.5		V
		X_{COUT} Low Power	No load applied		1.6		
V_{OL}	Output Low ("L") Voltage	$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P6_0$-$P6_7$, $P7_0$-$P7_7$, $P8_0$-$P8_4$, $P8_6$, $P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(1)	I_{OL}=5mA			2.0	V
		$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P6_0$-$P6_7$, $P7_0$-$P7_7$, $P8_0$-$P8_4$, $P8_6$, $P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(1)	I_{OL}=200µA			0.45	V
		X_{OUT}	I_{OL}=1mA			2.0	V
		X_{COUT} High Power	No load applied		0		V
		X_{COUT} Low Power	No load applied		0		
V_{T+}-V_{T-}	Hysteresis	$\overline{HOLD}$, $\overline{RDY}$, $TA0_{IN}$-$TA4_{IN}$, $TB0_{IN}$-$TB5_{IN}$, $\overline{INT0}$-$\overline{INT5}$, $\overline{ADTRG}$, $\overline{CTS0}$-$\overline{CTS4}$, CLK0-CLK4, $TA0_{OUT}$-$TA4_{OUT}$, $\overline{NMI}$, $\overline{KI0}$-$\overline{KI3}$, RxD0-RxD4, SCL0-SCL4, SDA0-SDA4		0.2		1.0	V
		$\overline{RESET}$		0.2		1.8	V
I_{IH}	Input High ("H") Current	$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P6_0$-$P6_7$, $P7_0$-$P7_7$, $P8_0$-$P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(1), X_{IN}, $\overline{RESET}$, CNV_{SS}, BYTE	V_I=5V			5.0	µA
I_{IL}	Input Low ("L") Current	$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P6_0$-$P6_7$, $P7_0$-$P7_7$, $P8_0$-$P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(1), X_{IN}, $\overline{RESET}$, CNV_{SS}, BYTE	V_I=0V			-5.0	µA
R_{PULLUP}	Pull-up Resistance	$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P6_0$-$P6_7$, $P7_2$-$P7_7$, $P8_0$-$P8_4$, $P8_6$, $P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(1)	V_I=0V Flash Memory	30	50	167	kΩ
			Masked ROM	20	40	167	
Rf_{XIN}	Feedback Resistance	X_{IN}			1.5		MΩ
Rf_{XCIN}	Feedback Resistance	X_{CIN}			10		MΩ
V_{RAM}	RAM Standby Voltage	In stop mode		2.0			V

NOTES:

1. P11 to P15 are provided in the 144-pin package only.

$V_{CC1}=V_{CC2}=5V$

Table 5.3 Electrical Characteristics (Continued)

($V_{CC1}=V_{CC2}=4.2$ to 5.5V, $V_{SS}=0V$ at Topr= –20 to 85°C, f(BCLK)=32MHz unless otherwise specified)

Symbol	Parameter	Measurement Condition		Standard			Unit
				Min.	Typ.	Max.	
I_{CC}	Power Supply Current	In single-chip mode, output pins are left open and other pins are connected to V_{SS}.	f(BCLK)=32 MHz, Square wave, No division		28	45	mA
			f(BCLK)=32 kHz, In low-power consumption mode, Program running on ROM — Flash Memory		430		µA
			f(BCLK)=32 kHz, In low-power consumption mode, Program running on ROM — Masked ROM		25		µA
			f(BCLK)=32 kHz, In low-power consumption mode, Program running on RAM(1)		25		µA
			f(BCLK)=32 kHz, In wait mode, Topr=25° C		10		µA
			While clock stops, Topr=25° C		0.8	5	µA
			While clock stops, Topr=85° C			50	µA

NOTES:

1. Value is obtained when setting the FMSTP bit in the FMR0 register to "1" (flash memory stopped).

$V_{CC1}=V_{CC2}=5V$

Table 5.4 A/D Conversion Characteristics ($V_{CC1}=V_{CC2}=AV_{CC}=V_{REF}$=4.2 to 5.5V, V_{SS}= AV_{SS} = 0V at Topr=–20 to 85°C, f(BCLK) = 32MHz unless otherwise specified)

Symbol	Parameter	Measurement Condition		Standard			Unit
				Min.	Typ.	Max.	
-	Resolution	$V_{REF}=V_{CC1}$				10	Bits
INL	Integral Nonlinearity Error	$V_{REF}=V_{CC1}=V_{CC2}$=5V	AN_0 to AN_7, $AN0_0$ to $AN0_7$, $AN2_0$ to $AN2_7$, $AN15_0$ to $AN15_7$, ANEX0, ANEX1			±3	LSB
							LSB
			External op-amp connection mode			±7	LSB
							LSB
DNL	Differential Nonlinearity Error					±1	LSB
-	Offset Error					±3	LSB
-	Gain Error					±3	LSB
R_{LADDER}	Resistor Ladder	$V_{REF}=V_{CC1}$		8		40	kΩ
t_{CONV}	10-bit Conversion Time(1, 2)			2.06			µs
t_{CONV}	8-bit Conversion Time(1, 2)			1.75			µs
t_{SAMP}	Sampling Time(1)			0.188			µs
V_{REF}	Reference Voltage			2		V_{CC1}	V
V_{IA}	Analog Input Voltage			0		V_{REF}	V

NOTES:
1. Divide f(X_{IN}), if exceeding 16 MHz, to keep ϕAD frequency at 16 MHz or less.
2. With using the sample and hold function.

Table 5.5 D/A Conversion Characteristics ($V_{CC1}=V_{CC2}=V_{REF}$=4.2 to 5.5V, $V_{SS}=AV_{SS}$=0V at Topr=–20 to 85°C, f(BCLK) = 32MHz unless otherwise specified)

Symbol	Parameter	Measurement Condition	Standard			Unit
			Min.	Typ.	Max.	
-	Resolution				8	Bits
-	Absolute Accuracy				1.0	%
t_{SU}	Setup Time				3	µs
R_O	Output Resistance		4	10	20	kΩ
I_{VREF}	Reference Power Supply Input Current	(Note 1)			1.5	mA

NOTES:
1. Measurement when using one D/A converter. The DAi register (i=0, 1) of the D/A converter, not being used, is set to "00_{16}". The resistor ladder in the A/D converter is excluded.
I_{VREF} flows even if the VCUT bit in the AD0CON1 register is set to "0" (no V_{REF} connection).

$V_{CC1}=V_{CC2}=5V$

Table 5.6 Flash Memory Version Electrical Characteristics (V_{CC1}=4.5 to 5.5V, 3.3 to 3.6V at Topr=0 to 60°C unless otherwise specified)

Symbol	Parameter		Standard			Unit
			Min.	Typ.	Max.	
-	Program and Erase Endurance(2)		100			cycles
-	Word Program Time (V_{CC1}=5.0V, Topr=25° C)			25	200	µs
-	Lock Bit Program Time			25	200	µs
-	Block Erase Time (V_{CC1}=5.0V, Topr=25° C)	4-Kbyte Block		0.3	4	s
		8-Kbyte Block		0.3	4	s
		32-Kbyte Block		0.5	4	s
		64-Kbyte Block		0.8	4	s
-	All-Unlocked-Block Erase Time(1)				4 x *n*	s
t_{PS}	Wait Time to Stabilize Flash Memory Circuit				15	µs
-	Data Hold Time (Topr=-40 to 85 ° C)		10			years

NOTES:
1. *n* denotes the number of block to be erased.
2. Number of program-erase cycles per block.
   If Program and Erase Endurance is *n* cycle (*n*=100), each block can be erased and programmed *n* cycles. For example, if a 4-Kbyte block A is erased after programming a word data 2,048 times, each to a different address, this counts as one program and erase endurance. Data can not be programmed to the same address more than once without erasing the block. (rewrite prohibited).

$V_{CC1}=V_{CC2}=5V$

Table 5.7 Voltage Detection Circuit Electrical Characteristics ($V_{CC1}=V_{CC2}=3.0$ to 5.5V, Vss=0V at Topr=25°C unless otherwise specified)

Symbol	Parameter	Measurement Condition	Standard			Unit
			Min.	Typ.	Max.	
Vdet4	Low Voltage Detection Voltage(1)	V_{CC1}=3.0 to 5.5V		3.8		V
Vdet3	Reset Space Detection Voltage(1)			3.0		V
Vdet3s	Low Voltage Reset Hold Voltage		2.0			V
Vdet3r	Low Voltage Reset Release Voltage(2)			3.1		V

NOTES:
1. Vdet4 >Vdet3
2. Vdet3r >Vdet3 is not guaranteed.

Table 5.8 Power Supply Timing

Symbol	Parameter	Measurement Condition	Standard			Unit
			Min.	Typ.	Max.	
td(P-R)	Wait Time to Stabilize Internal Supply Voltage when Power-on	V_{CC1}=3.0 to 5.5V			2	ms
td(S-R)	Wait Time to Release Brown-out. Detection Reset	V_{CC1}=Vdet3r to 5.5V		6(1)	20	ms
td(E-A)	Start-up Time for Low Voltage Detection Circuit Operation	V_{CC1}=3.0 to 5.5V			20	µs

NOTES:
1. V_{CC1}=5V

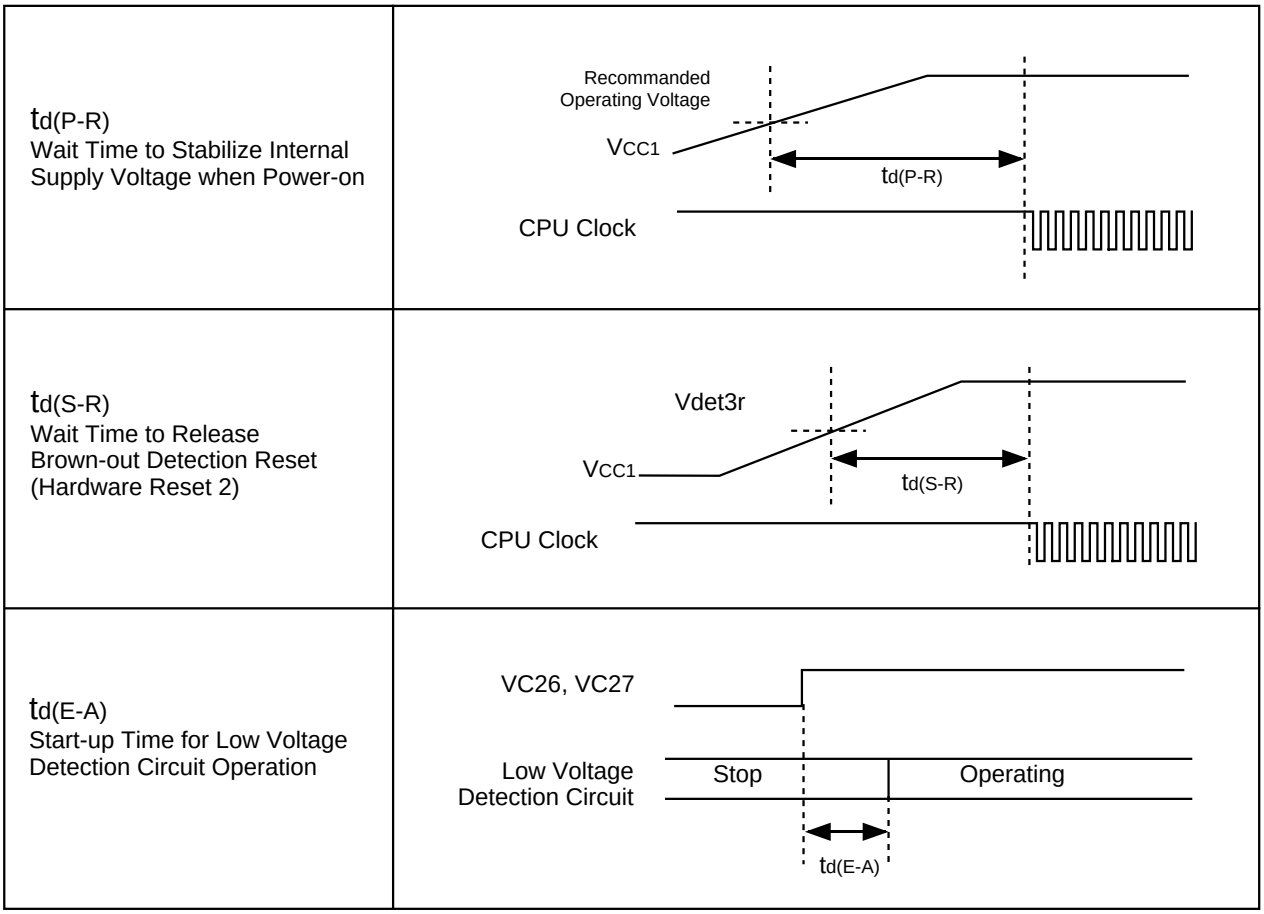


Figure 5.1 Power Supply Timing Diagram

$V_{CC1}=V_{CC2}=5V$

Timing Requirements

($V_{CC1}=V_{CC2}=4.2$ to 5.5V, $V_{SS}=0V$ at Topr=–20 to 85°C unless otherwise specified)

Table 5.9 External Clock Input

Symbol	Parameter	Standard		Unit
		Min.	Max.	
tc	External Clock Input Cycle Time	31.25		ns
$t_{W(H)}$	External Clock Input High ("H") Width	13.75		ns
$t_{W(L)}$	External Clock Input Low ("L") Width	13.75		ns
tr	External Clock Rise Time		5	ns
tf	External Clock Fall Time		5	ns

Table 5.10 Memory Expansion Mode and Microprocessor Mode

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{AC1(RD-DB)}$	Data Input Access Time (RD standard)		(Note 1)	ns
$t_{AC1(AD-DB)}$	Data Input Access Time (AD standard, CS standard)		(Note 1)	ns
$t_{AC2(RD-DB)}$	Data Input Access Time (RD standard, when accessing a space with the multiplexrd bus)		(Note 1)	ns
$t_{AC2(AD-DB)}$	Data Input Access Time (AD standard, when accessing a space with the multiplexed bus)		(Note 1)	ns
$t_{SU(DB-BCLK)}$	Data Input Setup Time	26		ns
$t_{SU(RDY-BCLK)}$	$\overline{RDY}$ Input Setup Time	26		ns
$t_{SU(HOLD-BCLK)}$	$\overline{HOLD}$ Input Setup Time	30		ns
$t_{H(RD-DB)}$	Data Input Hold Time	0		ns
$t_{H(BCLK-RDY)}$	$\overline{RDY}$ Input Hold Time	0		ns
$t_{H(BCLK-HOLD)}$	$\overline{HOLD}$ Input Hold Time	0		ns
$t_{D(BCLK-HLDA)}$	$\overline{HLDA}$ Output Delay Time		25	ns

NOTES:
1. Values can be obtained from the following equations, according to BCLK frequecncy and external bus cycles. Insert a wait state or lower the operation frequency, $f_{(BCLK)}$, if the calculated value is negative.

$$t_{AC1(RD-DB)} = \frac{10^9 \times m}{f_{(BCLK)} \times 2} - 35$$ [ns] (if external bus cycle is aϕ + bϕ, m=(bx2)+1)

$$t_{AC1(AD-DB)} = \frac{10^9 \times n}{f_{(BCLK)}} - 35$$ [ns] (if external bus cycle is aϕ + bϕ, n=a+b)

$$t_{AC2(RD-DB)} = \frac{10^9 \times m}{f_{(BCLK)} \times 2} - 35$$ [ns] (if external bus cycle is aϕ + bϕ, m=(bx2)-1)

$$t_{AC2(AD-DB)} = \frac{10^9 \times p}{f_{(BCLK)} \times 2} - 35$$ [ns] (if external bus cycle is aϕ + bϕ, p={(a+b-1)x2}+1)

$V_{CC1}=V_{CC2}=5V$

Timing Requirements

($V_{CC1}=V_{CC2}=4.2$ to 5.5V, $V_{SS}=0V$ at Topr=–20 to 85°C unless otherwise specified)

Table 5.11 Timer A Input (Count Source Input in Event Counter Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TA)}$	TAiIN Input Cycle Time	100		ns
$t_{w(TAH)}$	TAiIN Input High ("H") Width	40		ns
$t_{w(TAL)}$	TAiIN Input Low ("L") Width	40		ns

Table 5.12 Timer A Input (Gate Input in Timer Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TA)}$	TAiIN Input Cycle Time	400		ns
$t_{w(TAH)}$	TAiIN Input High ("H") Width	200		ns
$t_{w(TAL)}$	TAiIN Input Low ("L") Width	200		ns

Table 5.13 Timer A Input (External Trigger Input in One-Shot Timer Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TA)}$	TAiIN Input Cycle Time	200		ns
$t_{w(TAH)}$	TAiIN Input High ("H") Width	100		ns
$t_{w(TAL)}$	TAiIN Input Low ("L") Width	100		ns

Table 5.14 Timer A Input (External Trigger Input in Pulse Width Modulation Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{w(TAH)}$	TAiIN Input High ("H") Width	100		ns
$t_{w(TAL)}$	TAiIN Input Low ("L") Width	100		ns

Table 5.15 Timer A Input (Counter Increment/Decrement Input in Event Counter Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(UP)}$	TAiOUT Input Cycle Time	2000		ns
$t_{w(UPH)}$	TAiOUT Input High ("H") Width	1000		ns
$t_{w(UPL)}$	TAiOUT Input Low ("L") Width	1000		ns
$t_{su(UP-TIN)}$	TAiOUT Input Setup Time	400		ns
$t_{h(TIN-UP)}$	TAiOUT Input Hold Time	400		ns

$V_{CC1}=V_{CC2}=5V$

Timing Requirements

(V_{CC1} = V_{CC2} = 4.2 to 5.5V, V_{SS} = 0V at Topr = –20 to 85°C unless otherwise specified)

Table 5.16 Timer B Input (Count Source Input in Event Counter Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TB)}$	TBi_{IN} Input Cycle Time (counted on one edge)	100		ns
$t_{w(TBH)}$	TBi_{IN} Input High ("H") Width (counted on one edge)	40		ns
$t_{w(TBL)}$	TBi_{IN} Input Low ("L") Width (counted on one edge)	40		ns
$t_{c(TB)}$	TBi_{IN} Input Cycle Time (counted on both edges)	200		ns
$t_{w(TBH)}$	TBi_{IN} Input High ("H") Width (counted on both edges)	80		ns
$t_{w(TBL)}$	TBi_{IN} Input Low ("L") Width (counted on both edges)	80		ns

Table 5.17 Timer B Input (Pulse Period Measurement Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TB)}$	TBi_{IN} Input Cycle Time	400		ns
$t_{w(TBH)}$	TBi_{IN} Input High ("H") Width	200		ns
$t_{w(TBL)}$	TBi_{IN} Input Low ("L") Width	200		ns

Table 5.18 Timer B Input (Pulse Width Measurement Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TB)}$	TBi_{IN} Input Cycle Time	400		ns
$t_{w(TBH)}$	TBi_{IN} Input High ("H") Width	200		ns
$t_{w(TBL)}$	TBi_{IN} Input Low ("L") Width	200		ns

Table 5.19 A/D Trigger Input

Symbol	Parameter	Standard		Unit
		Min.	Max	
$t_{c(AD)}$	$\overline{ADTRG}$ Input Cycle Time (required for trigger)	1000		ns
$t_{w(ADL)}$	$\overline{ADTRG}$ Input Low ("L") Width	125		ns

Table 5.20 Serial I/O

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(CK)}$	CLKi Input Cycle Time	200		ns
$t_{w(CKH)}$	CLKi Input High ("H") Width	100		ns
$t_{w(CKL)}$	CLKi Input Low ("L") Width	100		ns
$t_{d(C-Q)}$	TxDi Output Delay Time		80	ns
$t_{h(C-Q)}$	TxDi Hold Time	0		ns
$t_{su(D-C)}$	RxDi Input Setup Time	30		ns
$t_{h(C-Q)}$	RxDi Input Hold Time	90		ns

Table 5.21 External Interrupt $\overline{INTi}$ Input

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{w(INH)}$	$\overline{INTi}$ Input High ("H") Width	250		ns
$t_{w(INL)}$	$\overline{INTi}$ Input Low ("L") Width	250		ns

$V_{CC1}=V_{CC2}=5V$

Switching Characteristics

(V_{CC1} = V_{CC2} = 4.2 to 5.5V, V_{SS} = 0V at Topr = –20 to 85°C unless otherwise specified)

Table 5.22 Memory Expansion Mode and Microprocessor Mode (when accessing external memory space)

Symbol	Parameter	Measurement Condition	Standard		Unit
			Min.	Max.	
$t_{d(BCLK-AD)}$	Address Output Delay Time	See Figure 5.2		18	ns
$t_{h(BCLK-AD)}$	Address Output Hold Time (BCLK standard)		-3		ns
$t_{h(RD-AD)}$	Address Output Hold Time (RD standard)(3)		0		ns
$t_{h(WR-AD)}$	Address Output Hold Time (WR standard)(3)		(Note 1)		ns
$t_{d(BCLK-CS)}$	Chip-Select Signal Output Delay Time			18	ns
$t_{h(BCLK-CS)}$	Chip-Select Signal Output Hold Time (BCLK standard)		-3		ns
$t_{h(RD-CS)}$	Chip-Select Signal Output Hold Time (RD standard)(3)		0		ns
$t_{h(WR-CS)}$	Chip-Select Signal Output Hold Time (WR standard)(3)		(Note 1)		ns
$t_{d(BCLK-RD)}$	RD Signal Output Delay Time			18	ns
$t_{h(BCLK-RD)}$	RD Signal Output Hold Time		-5		ns
$t_{d(BCLK-WR)}$	WR Signal Output Delay Time			18	ns
$t_{h(BCLK-WR)}$	WR Signal Output Hold Time		-5		ns
$t_{d(DB-WR)}$	Data Output Delay Time (WR standard)		(Note 2)		ns
$t_{h(WR-DB)}$	Data Output Hold Time (WR standard)(3)		(Note 1)		ns
$t_{w(WR)}$	WR Output Width		(Note 2)		ns

NOTES:

1. Values can be obtained from the following equations, according to BCLK frequency.

$$t_{h(WR-DB)} = \frac{10^9}{f_{(BCLK)} \times 2} - 10 \quad [ns]$$

$$t_{h(WR-AD)} = \frac{10^9}{f_{(BCLK)} \times 2} - 10 \quad [ns]$$

$$t_{h(WR-CS)} = \frac{10^9}{f_{(BCLK)} \times 2} - 10 \quad [ns]$$

2. Values can be obtained from the following equations, according to BCLK frequency and external bus cycles.

$$t_{w(WR)} = \frac{10^9 \times n}{f_{(BCLK)} \times 2} - 15 \quad [ns]$$ (if external bus cycle is aϕ + bϕ, n=(bx2)-1)

$$t_{d(DB-WR)} = \frac{10^9 \times m}{f_{(BCLK)}} - 20 \quad [ns]$$ (if external bus cycle is aϕ + bϕ, m= b)

3. *tc* ns is added when recovery cycle is inserted.

$V_{CC1}=V_{CC2}=5V$

Switching Characteristics

(V_{CC} = 4.2 to 5.5V, V_{SS} = 0V at Topr = –20 to 85°C unless otherwise specified)

Table 5.23 Memory Expansion Mode and Microprocessor Mode

(when accessing an external memory space with the multiplexed bus)

Symbol	Parameter	Measurement Condition	Standard		Unit
			Min.	Max.	
td(BCLK-AD)	Address Output Delay Time	See Figure 5.2		18	ns
th(BCLK-AD)	Address Output Hold Time (BCLK standard)		-3		ns
th(RD-AD)	Address Output Hold Time (RD standard)(5)		(Note 1)		ns
th(WR-AD)	Address Output Hold Time (WR standard)(5)		(Note 1)		ns
td(BCLK-CS)	Chip-Select Signal Output Delay Time			18	ns
th(BCLK-CS)	Chip-Select Signal Output Hold Time (BCLK standard)		-3		ns
th(RD-CS)	Chip-Select Signal Output Hold Time (RD standard)(5)		(Note 1)		ns
th(WR-CS)	Chip-Select Signal Output Hold Time (WR standard)(5)		(Note 1)		ns
td(BCLK-RD)	RD Signal Output Delay Time			18	ns
th(BCLK-RD)	RD Signal Output Hold Time		-5		ns
td(BCLK-WR)	WR Signal Output Delay Time			18	ns
th(BCLK-WR)	WR Signal Output Hold Time		-5		ns
td(DB-WR)	Data Output Delay Time (WR standard)		(Note 2)		ns
th(WR-DB)	Data Output Hold Time (WR standard)(5)		(Note 1)		ns
td(BCLK-ALE)	ALE Signal Output Delay Time (BCLK standard)			18	ns
th(BCLK-ALE)	ALE Signal Output Hold Time (BCLK standard)		-2		ns
td(AD-ALE)	ALE Signal Output Delay Time (address standard)		(Note 3)		ns
th(ALE-AD)	ALE Signal Output Hold Time (address standard)		(Note 4)		ns
tdz(RD-AD)	Address Output Float Start Time			8	ns

NOTES:

1. Values can be obtained from the following equations, according to BCLK frequency.

$$th(RD-AD) = \frac{10^9}{f(BCLK) \times 2} - 10 \quad [ns]$$

$$th(WR-AD) = \frac{10^9}{f(BCLK) \times 2} - 10 \quad [ns]$$

$$th(RD-CS) = \frac{10^9}{f(BCLK) \times 2} - 10 \quad [ns]$$

$$th(WR-CS) = \frac{10^9}{f(BCLK) \times 2} - 10 \quad [ns]$$

$$th(WR-DB) = \frac{10^9}{f(BCLK) \times 2} - 10 \quad [ns]$$

2. Values can be obtained from the following equations, according to BCLK frequency and external bus cycle.

$$td(DB-WR) = \frac{10^9 \times m}{f(BCLK) \times 2} - 25 \quad [ns]$$ (if external bus cycle is aϕ + bϕ, m= (bx2)-1)

3. Values can be obtained from the following equations, according to BCLK frequency and external bus cycle.

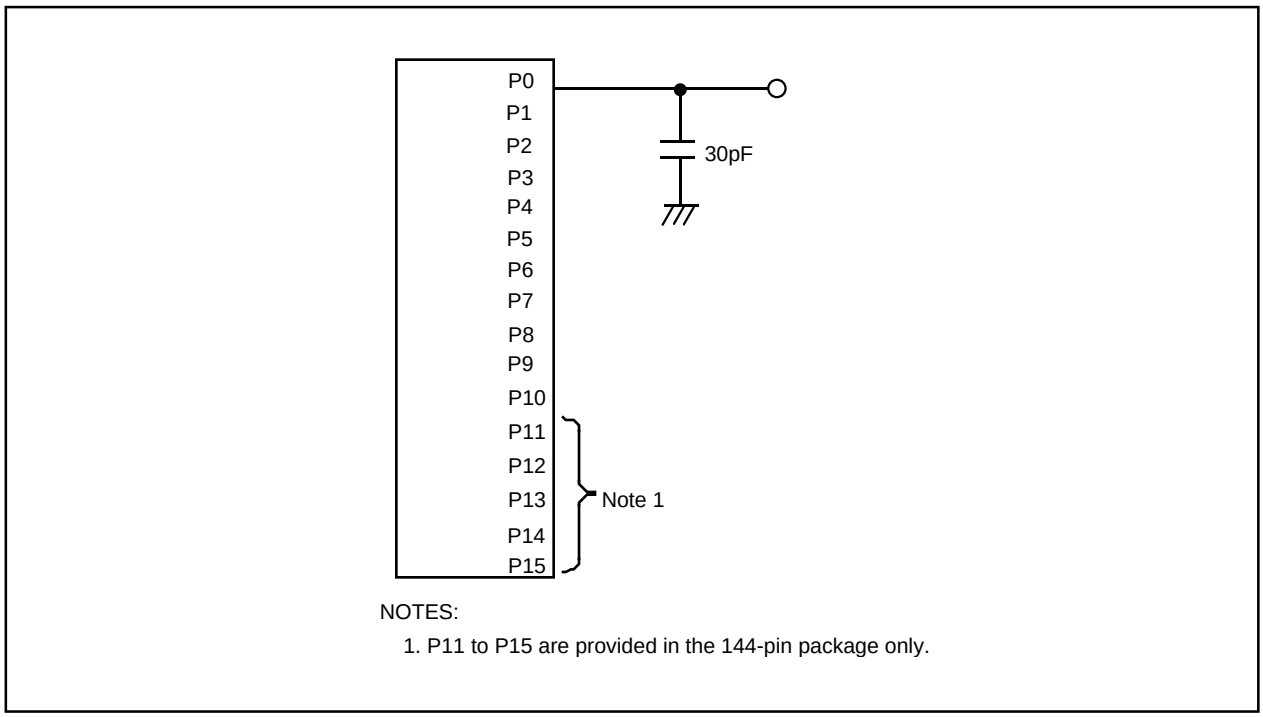
$$td(AD-ALE) = \frac{10^9 \times n}{f(BCLK) \times 2} - 20 \quad [ns]$$ (if external bus cycle is aϕ + bϕ, n= a)

4. Values can be obtained from the following equations, according to BCLK frequency and external bus cycle.

$$th(ALE-AD) = \frac{10^9 \times n}{f(BCLK) \times 2} - 10 \quad [ns]$$ (if external bus cycle is aϕ + bϕ, n= a)

5. *tc* ns is added when recovery cycle is inserted.

$V_{CC1}=V_{CC2}=5V$



NOTES:
1. P11 to P15 are provided in the 144-pin package only.

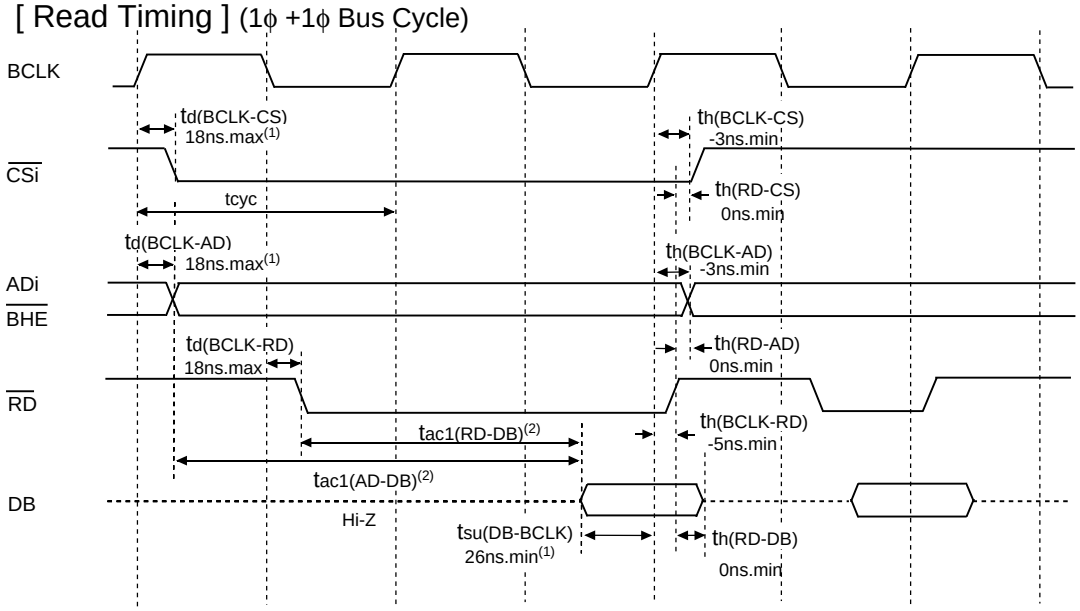
Figure 5.2 P0 to P15 Measurement Circuit

Vcc1=Vcc2=5V

Memory Expansion Mode and Microprocessor Mode

(when accessing an external memory space)

[Read Timing] (1ϕ +1ϕ Bus Cycle)



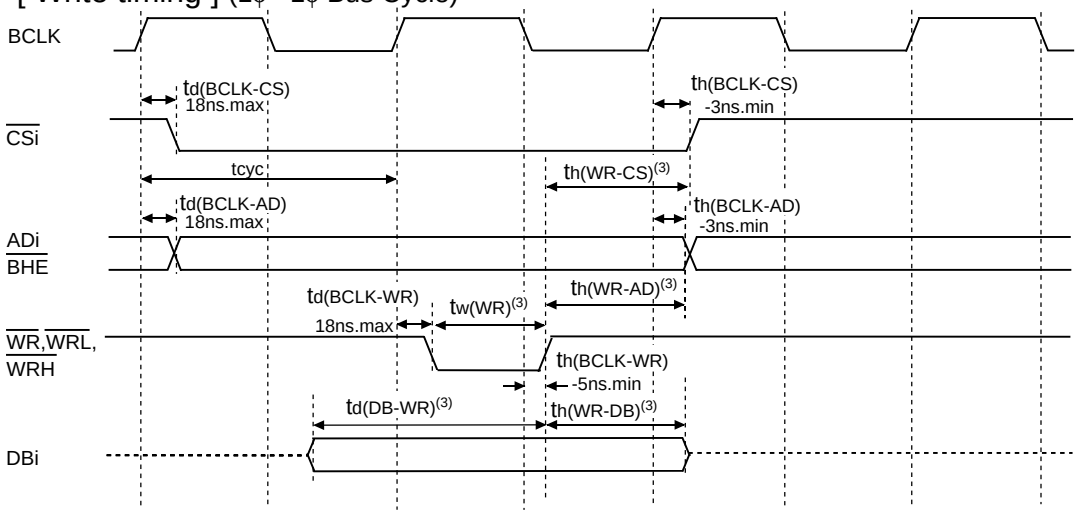
NOTES:

1. Values guaranteed only when the microcomputer is used independently.
A maximum of 35ns is guaranteed for $t_{d(BCLK-AD)}+t_{su(DB-BCLK)}$.
2. Varies with operation frequency:

$t_{ac1(RD-DB)}$=(tcyc/2 x m-35)ns.max (if external bus cycle is aϕ + bϕ, m=(b x 2)+1)

$t_{ac1(AD-DB)}$=(tcyc x n-35)ns.max (if external bus cycle is aϕ + bϕ, n=a+b)

[Write timing] (1ϕ +1ϕ Bus Cycle)



NOTES:

3. Varies with operation frequency:
$t_{d(DB-WR)}$=(tcyc x m-20)ns.min
(if external bus cycle is aϕ+bϕ, m=b)
$t_{h(WR-DB)}$=(tcyc/2-10)ns.min
$t_{h(WR-AD)}$=(tcyc/2-10)ns.min
$t_{h(WR-CS)}$=(tcyc/2-10)ns.min
$t_{w(WR)}$=(tcyc/2 x n-15)ns.min
(if external bus cycle is aϕ+bϕ , n=(bx2)-1)

Measurement Conditions:

- V_{CC1}=V_{CC2}=4.2 to 5.5V
- Input high and low voltage: V_{IH}=2.5V, V_{IL}=0.8V
- Output high and low voltage: V_{OH}=2.0V, V_{OL}=0.8V

$$tcyc = \frac{10^9}{f(BCLK)}$$

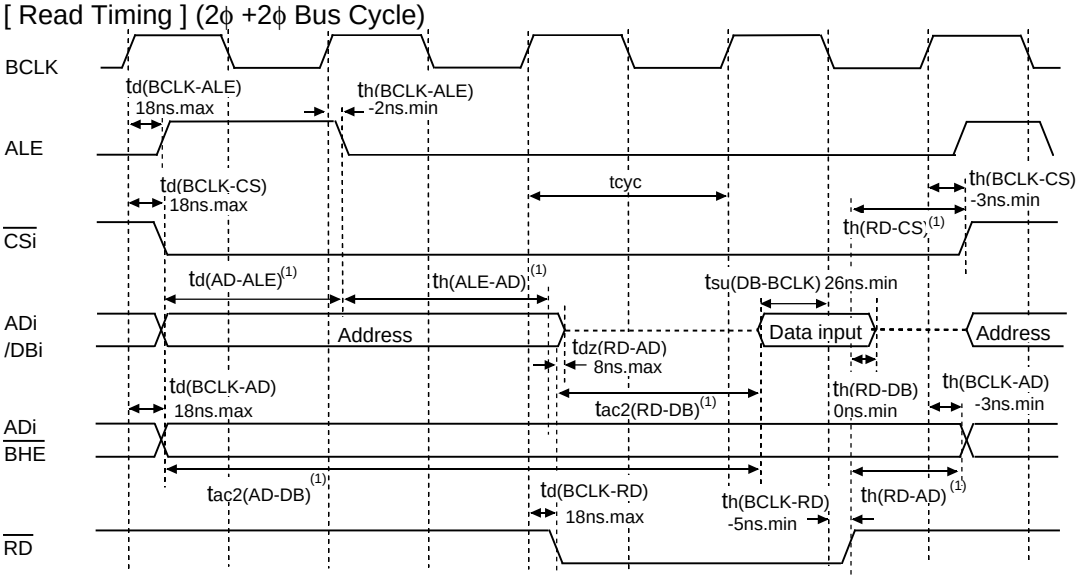
Figure 5.3 Vcc1=Vcc2=5V Timing Diagram (1)

Vcc1=Vcc2=5V

Memory Expansion Mode and Microprocessor Mode

(when accessing an external memory space with the multiplexed bus)

[Read Timing] (2ϕ +2ϕ Bus Cycle)



NOTES:

1. Varies with operation frequency:

$t_{d(AD-ALE)}$=(tcyc/2 x n-20)ns.min (if external bus cycle is aϕ + bϕ, n=a)

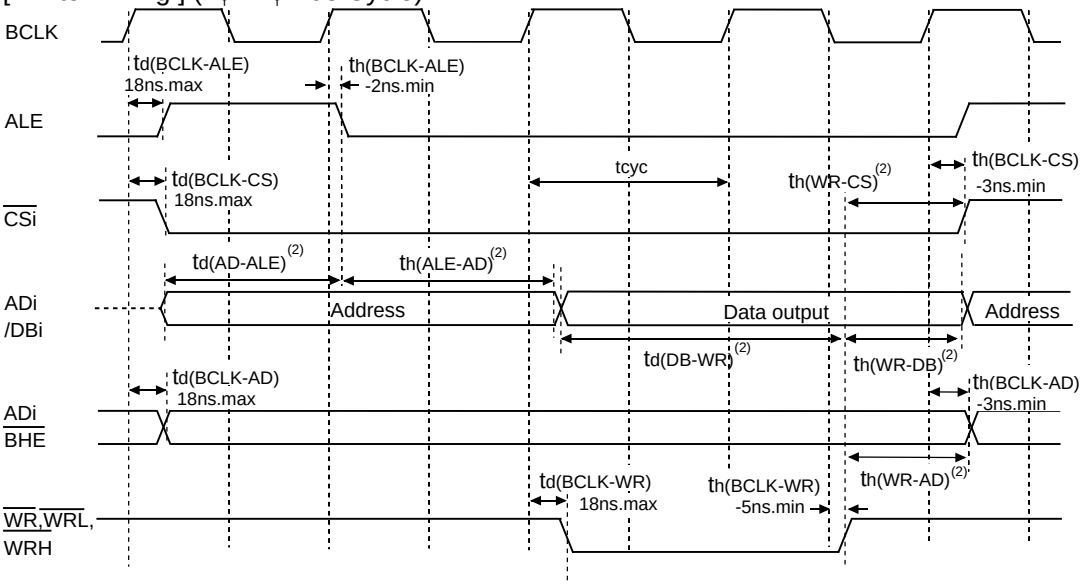
$t_{h(ALE-AD)}$=(tcyc/2 x n-10)ns.min (if external bus cycle is aϕ + bϕ, n=a)

$t_{h(RD-AD)}$=(tcyc/2-10)ns.min, $t_{h(RD-CS)}$=(tcyc/2-10)ns.min

$t_{ac2(RD-DB)}$=(tcyc/2 x m-35)ns.max (if external bus cycle is aϕ + bϕ, m=(b x 2)-1)

$t_{ac2(AD-DB)}$=(tcyc/2 x p-35)ns.max (if external bus cycle is aϕ + bϕ, p={(a+b-1) x 2}+1)

[Write Timing] (2ϕ +2ϕ Bus Cycle)



NOTES:

2. Varies with operation frequency:

$t_{d(AD-ALE)}$=(tcyc/2 x n - 20)ns.min

(if external bus cycle is aϕ + bϕ, n=a)

$t_{h(ALE-AD)}$=(tcyc/2 x n -10)ns.min

(if external bus cycle is aϕ + bϕ, n=a)

$t_{h(WR-AD)}$=(tcyc/2-10)ns.min,

$t_{h(WR-CS)}$=(tcyc/2-10)ns.min, $t_{h(WR-DB)}$=(tcyc/2-10)ns.min

$t_{d(DB-WR)}$=(tcyc/2 x m-25)ns.min

(if external bus cycle is aϕ + bϕ, m=(b x 2)-1)

Measurement Conditions:

- V_{CC1}=V_{CC2}=4.2 to 5.5V
- Input high and low voltage: V_{IH}=2.5V, V_{IL}=0.8V
- Output high and low voltage: V_{OH}=2.0V, V_{OL}=0.8V

$$tcyc = \frac{10^9}{f_{(BCLK)}}$$

Figure 5.4 V_{CC1}=V_{CC2}=5V Timing Diagram (2)

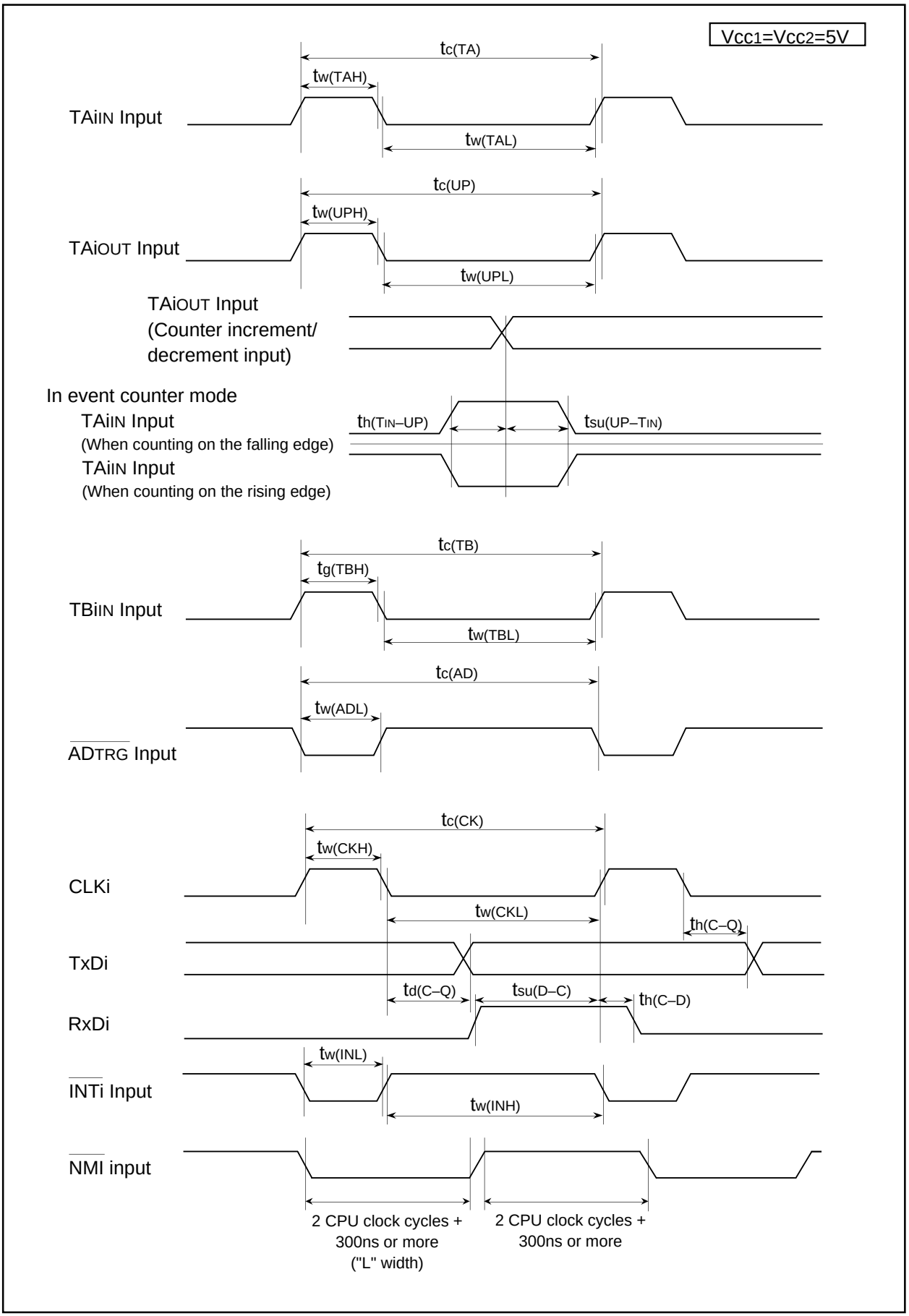


Figure 5.5 Vcc1=Vcc2=5V Timing Diagram (3)

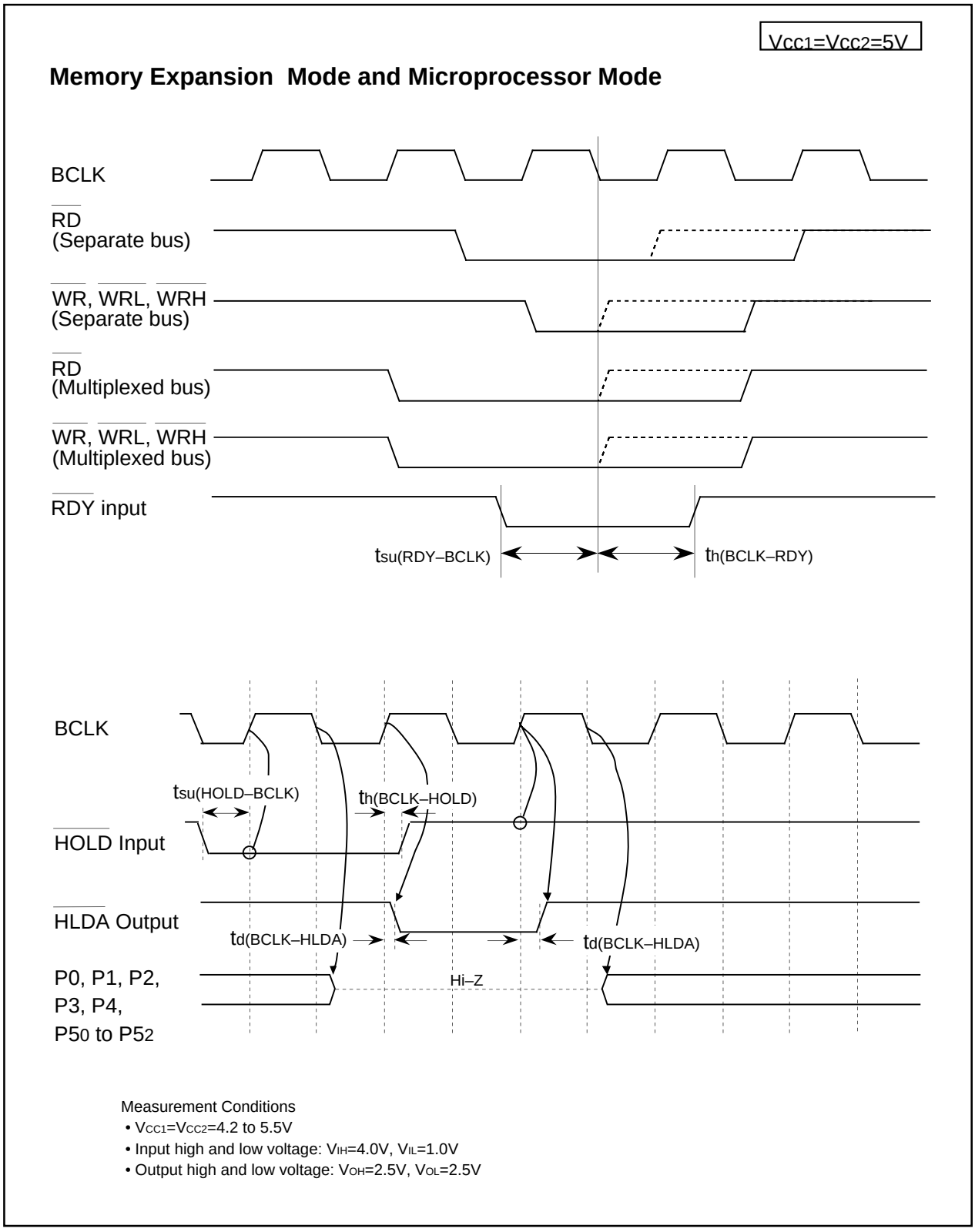


Figure 5.6 Vcc1=Vcc2=5V Timing Diagram (4)

$V_{CC1}=V_{CC2}=3.3V$

Table 5.24 Electrical Characteristics ($V_{CC1}=V_{CC2}=3.0$ to $3.6V$, $V_{SS}=0V$ at Topr = –20 to 85°C, f(BCLK)=24MHz unless otherwise specified)

Symbol	Parameter		Condition		Standard			Unit
					Min.	Typ.	Max.	
V_{OH}	Output High ("H") Voltage	$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$	I_{OH}=-1mA		V_{CC2}-0.6		V_{CC2}	V
		$P6_0$-$P6_7$, $P7_2$-$P7_7$, $P8_0$-$P8_4$, $P8_6$, $P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(1)			V_{CC1}-0.6		V_{CC1}	V
		X_{OUT}	I_{OH}=-0.1mA		2.7		V_{CC1}	V
		X_{COUT} High Power	No load applied			2.5		V
		X_{COUT} Low Power	No load applied			1.6		V
V_{OL}	Output Low ("L") Voltage	$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P6_0$-$P6_7$, $P7_0$-$P7_7$, $P8_0$-$P8_4$, $P8_6$, $P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(1)	I_{OL}=1mA				0.5	V
		X_{OUT}	I_{OL}=0.1mA				0.5	V
		X_{COUT} High Power	No load applied			0		V
		X_{COUT} Low Power	No load applied			0		V
V_{T+}-V_{T-}	Hysteresis	$\overline{HOLD}$, $\overline{RDY}$, $TA0_{IN}$-$TA4_{IN}$, $TB0_{IN}$-$TB5_{IN}$, $\overline{INT0}$-$\overline{INT5}$, $\overline{ADTRG}$, $\overline{CTS0}$-$\overline{CTS4}$, CLK0-CLK4, $TA0_{OUT}$-$TA4_{OUT}$, $\overline{NMI}$, $\overline{KI0}$-$\overline{KI3}$, RxD0-RxD4, SCL0-SCL4, SDA0-SDA4			0.2		1.0	V
		$\overline{RESET}$			0.2		1.8	V
I_{IH}	Input High ("H") Current	$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P6_0$-$P6_7$, $P7_0$-$P7_7$, $P8_0$-$P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(1), X_{IN}, $\overline{RESET}$, CNV_{SS}, BYTE	V_I=3V				4.0	µA
I_{IL}	Input Low ("L") Current	$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P6_0$-$P6_7$, $P7_0$-$P7_7$, $P8_0$-$P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(1), X_{IN}, $\overline{RESET}$, CNV_{SS}, BYTE	V_I=0V				-4.0	µA
R_{PULLUP}	Pull-up Resistance	$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P6_0$-$P6_7$, $P7_2$-$P7_7$, $P8_0$-$P8_4$, $P8_6$, $P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(1)	V_I=0V	Flash Memory	66	120	500	kΩ
				Masked ROM	40	70	500	kΩ
R_{fXIN}	Feedback Resistance	X_{IN}				3.0		MΩ
R_{fXCIN}	Feedback Resistance	X_{CIN}				20.0		MΩ
V_{RAM}	RAM Standby Voltage	in stop mode			2.0			V
I_{CC}	Power Supply Current	Measurement condition: In single-chip mode, output pins are left open and other pins are connected to V_{SS}.	f(BCLK)=24 MHz, Square wave, No division			22	35	mA
			f(BCLK)=32 kHz, In wait mode, Topr=25° C			10		µA
			While clock stops, Topr=25° C			0.8	5	µA
			While clock stops, Topr=85° C				50	µA

NOTES:

1. P11 to P15 are provided in the 144-pin package only.

$V_{CC1}=V_{CC2}=3.3V$

Table 5.25 A/D Conversion Characteristics ($V_{CC1}=V_{CC2}=AV_{CC}=V_{REF}$= 3.0 to 3.6V, $V_{SS}=AV_{SS}$=0V at Topr = –20 to 85°C, f(BCLK) = 24MHz unless otherwise specified)

Symbol	Parameter		Measurement Condition	Standard			Unit
				Min.	Typ.	Max.	
-	Resolution		$V_{REF}=V_{CC1}$			10	Bits
INL	Integral Nonlinearity Error	No S&H (8-bit)	$V_{CC1}=V_{CC2}=V_{REF}$=3.3V			±2	LSB
DNL	Differential Nonlinearity Error	No S&H (8-bit)				±1	LSB
-	Offset Error	No S&H (8-bit)				±2	LSB
-	Gain Error	No S&H (8-bit)				±2	LSB
R_{LADDER}	Resistor Ladder		$V_{REF}=V_{CC1}$	8		40	kΩ
t_{CONV}	8-bit Conversion Time(1, 2)			6.1			µs
V_{REF}	Reference Voltage			3		V_{CC1}	V
V_{IA}	Analog Input Voltage			0		V_{REF}	V

S&H: Sample and Hold

NOTES:
1. Divide f(X_{IN}), if exceeding 10 MHz, to keep ϕAD frequency at 10 MHz or less.
2. S&H not available.

Table 5.26 D/A Conversion Characteristics ($V_{CC1}=V_{CC2}=V_{REF}$=3.0 to 3.6V, $V_{SS}=AV_{SS}$=0V at Topr = –20 to 85°C, f(BCLK) = 24MHz unless otherwise specified)

Symbol	Parameter	Measurement Condition	Standard			Unit
			Min.	Typ.	Max.	
-	Resolution				8	Bits
-	Absolute Accuracy				1.0	%
t_{SU}	Setup Time				3	µs
R_O	Output Resistance		4	10	20	kΩ
I_{VREF}	Reference Power Supply Input Current	(Note 1)			1.0	mA

NOTES:
1. Measurement results when using one D/A converter. The DAi register (i=0, 1) of the D/A converter, not being used, is set to "00_{16}". The resistor ladder in the A/D converter is excluded.
I_{VREF} flows even if the VCUT bit in the AD0CON1 register is set to "0" (no V_{REF} connection).

$V_{CC1}=V_{CC2}=3.3V$

Timing Requirements

($V_{CC1}=V_{CC2}$= 3.0 to 3.6V, V_{SS} = 0V at Topr = –20 to 85°C unless otherwise specified)

Table 5.27 External Clock Input

Symbol	Parameter	Standard		Unit
		Min.	Max.	
tc	External Clock Input Cycle Time	41		ns
$t_{w(H)}$	External Clock Input High ("H") Width	18		ns
$t_{w(L)}$	External Clock Input Low ("L") Width	18		ns
tr	External Clock Rise Time		5	ns
tf	External Clock Fall Time		5	ns

Table 5.28 Memory Expansion Mode and Microprocessor Mode

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{ac1(RD-DB)}$	Data Input Access Time (RD standard)		(Note 1)	ns
$t_{ac1(AD-DB)}$	Data Input Access Time (AD standard, CS standard)		(Note 1)	ns
$t_{ac2(RD-DB)}$	Data Input Access Time (RD standard, when accessing a space with the multiplexed bus)		(Note 1)	ns
$t_{ac2(AD-DB)}$	Data Input Access Time (AD standard, when accessing a space with the multiplexed bus)		(Note 1)	ns
$t_{su(DB-BCLK)}$	Data Input Setup Time	30		ns
$t_{su(RDY-BCLK)}$	$\overline{RDY}$ Input Setup Time	40		ns
$t_{su(HOLD-BCLK)}$	$\overline{HOLD}$ Input Setup Time	60		ns
$t_{h(RD-DB)}$	Data Input Hold Time	0		ns
$t_{h(BCLK-RDY)}$	$\overline{RDY}$ Input Hold Time	0		ns
$t_{h(BCLK-HOLD)}$	$\overline{HOLD}$ Input Hold Time	0		ns
$t_{d(BCLK-HLDA)}$	$\overline{HLDA}$ Output Delay Time		25	ns

NOTES:

1. Values can be obtained from the following equations, according to BCLK frequecncy and external bus cycles. Insert a wait state or lower the operation frequency, $f_{(BCLK)}$, if the calculated value is negative.

$$t_{ac1(RD-DB)} = \frac{10^9 \times m}{f_{(BCLK)} \times 2} - 35 \quad \text{[ns] (if external bus cycle is a}\phi + \text{b}\phi\text{, m=(bx2)+1)}$$

$$t_{ac1(AD-DB)} = \frac{10^9 \times n}{f_{(BCLK)}} - 35 \quad \text{[ns] (if external bus cycle is a}\phi + \text{b}\phi\text{, n=a+b)}$$

$$t_{ac2(RD-DB)} = \frac{10^9 \times m}{f_{(BCLK)} \times 2} - 35 \quad \text{[ns] (if external bus cycle is a}\phi + \text{b}\phi\text{, m=(bx2)-1)}$$

$$t_{ac2(AD-DB)} = \frac{10^9 \times p}{f_{(BCLK)} \times 2} - 35 \quad \text{[ns] (if external bus cycle is a}\phi + \text{b}\phi\text{, p=\{(a+b-1)x2\}+1)}$$

$V_{CC1}=V_{CC2}=3.3V$

Timing Requirements

($V_{CC1}=V_{CC2}$= 3.0 to 3.6V, V_{SS}= 0V at Topr = –20 to 85°C unless otherwise specified)

Table 5.29 Timer A Input (Count Source Input in Event Counter Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TA)}$	TAi_{IN} Input Cycle Time	100		ns
$t_{w(TAH)}$	TAi_{IN} Input High ("H") Width	40		ns
$t_{w(TAL)}$	TAi_{IN} Input Low ("L") Width	40		ns

Table 5.30 Timer A Input (Gate Input in Timer Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TA)}$	TAi_{IN} Input Cycle Time	400		ns
$t_{w(TAH)}$	TAi_{IN} Input High ("H") Width	200		ns
$t_{w(TAL)}$	TAi_{IN} Input Low ("L") Width	200		ns

Table 5.31 Timer A Input (External Trigger Input in One-Shot Timer Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TA)}$	TAi_{IN} Input Cycle Time	200		ns
$t_{w(TAH)}$	TAi_{IN} Input High ("H") Width	100		ns
$t_{w(TAL)}$	TAi_{IN} Input Low ("L") Width	100		ns

Table 5.32 Timer A Input (External Trigger Input in Pulse Width Modulation Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{w(TAH)}$	TAi_{IN} Input High ("H") Width	100		ns
$t_{w(TAL)}$	TAi_{IN} Input Low ("L") Width	100		ns

Table 5.33 Timer A Input (Counter Increment/decrement Input in Event Counter Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(UP)}$	TAi_{OUT} Input Cycle Time	2000		ns
$t_{w(UPH)}$	TAi_{OUT} Input High ("H") Width	1000		ns
$t_{w(UPL)}$	TAi_{OUT} Input Low ("L") Width	1000		ns
$t_{su(UP-TIN)}$	TAi_{OUT} Input Setup Time	400		ns
$t_{h(TIN-UP)}$	TAi_{OUT} Input Hold Time	400		ns

$V_{CC1}=V_{CC2}=3.3V$

Timing Requirements

($V_{CC1}=V_{CC2}$= 3.0 to 3.6V, V_{SS} = 0V at Topr = –20 to 85°C unless otherwise specified)

Table 5.34 Timer B Input (Count Source Input in Event Counter Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TB)}$	TBi_{IN} Input Cycle Time (counted on one edge)	100		ns
$t_{w(TBH)}$	TBi_{IN} Input High ("H") Width (counted on one edge)	40		ns
$t_{w(TBL)}$	TBi_{IN} Input Low ("L") Width (counted on one edge)	40		ns
$t_{c(TB)}$	TBi_{IN} Input Cycle Time (counted on both edges)	200		ns
$t_{w(TBH)}$	TBi_{IN} Input High ("H") Width (counted on both edges)	80		ns
$t_{w(TBL)}$	TBi_{IN} Input Low ("L") Width (counted on both edges)	80		ns

Table 5.35 Timer B Input (Pulse Period Measurement Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TB)}$	TBi_{IN} Input Cycle Time	400		ns
$t_{w(TBH)}$	TBi_{IN} Input High ("H") Wdth	200		ns
$t_{w(TBL)}$	TBi_{IN} Input Low ("L") Width	200		ns

Table 5.36 Timer B Input (Pulse Width Measurement Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TB)}$	TBi_{IN} Input Cycle Time	400		ns
$t_{w(TBH)}$	TBi_{IN} Input High ("H") Width	200		ns
$t_{w(TBL)}$	TBi_{IN} Input Low ("L") Width	200		ns

Table 5.37 A/D Trigger Input

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(AD)}$	$\overline{ADTRG}$ Input Cycle Time (required for trigger)	1000		ns
$t_{w(ADL)}$	$\overline{ADTRG}$ Input Low ("L") Width	125		ns

Table 5.38 Serial I/O

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(CK)}$	CLKi Input Cycle Time	200		ns
$t_{w(CKH)}$	CLKi Input High ("H") Width	100		ns
$t_{w(CKL)}$	CLKi Input Low ("L") Width	100		ns
$t_{d(C-Q)}$	TxDi Output Delay Time		80	ns
$t_{h(C-Q)}$	TxDi Hold Time	0		ns
$t_{su(D-C)}$	RxDi Input Setup Time	30		ns
$t_{h(C-Q)}$	RxDi Input Hold Time	90		ns

Table 5.39 External Interrupt $\overline{INTi}$ Input

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{w(INH)}$	$\overline{INTi}$ Input High ("H") Width	250		ns
$t_{w(INL)}$	$\overline{INTi}$ Input Low ("L") Width	250		ns

$V_{CC1}=V_{CC2}=3.3V$

Switching Characteristics

($V_{CC1}=V_{CC2}$=3.0 to 3.6V, VSS = 0V at Topr = –20 to 85°C unless otherwise specified)

Table 5.40 Memory Expansion Mode and Microprocessor Mode (when accessing external memory space)

Symbol	Parameter	Measurement Condition	Standard		Unit
			Min.	Max.	
$t_{d(BCLK-AD)}$	Address Output Delay Time	See Figure 5.2		18	ns
$t_{h(BCLK-AD)}$	Address Output Hold Time (BCLK standard)		0		ns
$t_{h(RD-AD)}$	Address Output Hold Time (RD standard)(3)		0		ns
$t_{h(WR-AD)}$	Address Output Hold Time (WR standard)(3)		(Note 1)		ns
$t_{d(BCLK-CS)}$	Chip-Select Signal Output Delay Time			18	ns
$t_{h(BCLK-CS)}$	Chip-Select Signal Output Hold Time (BCLK standard)		0		ns
$t_{h(RD-CS)}$	Chip-Select Signal Output Hold Time (RD standard)(3)		0		ns
$t_{h(WR-CS)}$	Chip-Select Signal Output Hold Time (WR standard)(3)		(Note 1)		ns
$t_{d(BCLK-RD)}$	RD Signal Output Delay Time			18	ns
$t_{h(BCLK-RD)}$	RD Signal Output Hold Time		-3		ns
$t_{d(BCLK-WR)}$	WR Signal Output Delay Time			18	ns
$t_{h(BCLK-WR)}$	WR Signal Output Hold Time		0		ns
$t_{d(DB-WR)}$	Data Output Delay Time (WR standard)		(Note 2)		ns
$t_{h(WR-DB)}$	Data Output Hold Time (WR standard)(3)		(Note 1)		ns
$t_{w(WR)}$	WR Output Width		(Note 2)		ns

NOTES:

1. Values can be obtained from the following equations, according to BCLK frequency.

$$t_{h(WR-DB)} = \frac{10^9}{f_{(BCLK)} \times 2} - 20 \quad [ns]$$

$$t_{h(WR-AD)} = \frac{10^9}{f_{(BCLK)} \times 2} - 10 \quad [ns]$$

$$t_{h(WR-CS)} = \frac{10^9}{f_{(BCLK)} \times 2} - 10 \quad [ns]$$

2. Values can be obtained from the following equations, according to BCLK frequency and external bus cycles.

$$t_{w(WR)} = \frac{10^9 \times n}{f_{(BCLK)} \times 2} - 15 \quad [ns] \quad \text{(if external bus cycle is } a\phi + b\phi\text{, n=(b x 2)-1)}$$

$$t_{d(DB-WR)} = \frac{10^9 \times m}{f_{(BCLK)}} - 20 \quad [ns] \quad \text{(if external bus cycle is } a\phi + b\phi\text{, m=b)}$$

3. *tc* ns is added when recovery cycle is inserted.

$V_{CC1}=V_{CC2}=3.3V$

Switching Characteristics

(V_{CC1} = V_{CC2} = 3.0 to 3.6V, VSS = 0V at Topr = –20 to 85°C unless otherwise specified)

Table 5.41 Memory Expansion Mode and Microprocessor Mode (when accessing an external memory space with the multiplexed bus)

Symbol	Parameter	Measurement Condition	Standard		Unit
			Min.	Max.	
td(BCLK-AD)	Address Output Delay Time	See Figure 5.2		18	ns
th(BCLK-AD)	Address Output Hold Time (BCLK standard)		0		ns
th(RD-AD)	Address Output Hold Time (RD standard)(5)		(Note 1)		ns
th(WR-AD)	Address Output Hold Time (WR standard)(5)		(Note 1)		ns
td(BCLK-CS)	Chip-Select Signal Output Delay Time			18	ns
th(BCLK-CS)	Chip-Select Signal Output Hold Time (BCLK standard)		0		ns
th(RD-CS)	Chip-Select Signal Output Hold Time (RD standard)(5)		(Note 1)		ns
th(WR-CS)	Chip-Select Signal Output Hold Time (WR standard)(5)		(Note 1)		ns
td(BCLK-RD)	RD Signal Output Delay Time			18	ns
th(BCLK-RD)	RD Signal Output Hold Time		-3		ns
td(BCLK-WR)	WR Signal Output Delay Time			18	ns
th(BCLK-WR)	WR Signal Output Hold Time		0		ns
td(DB-WR)	Data Output delay Time (WR standard)		(Note 2)		ns
th(WR-DB)	Data Output Hold Time (WR standard)(5)		(Note 1)		ns
td(BCLK-ALE)	ALE Signal Output Delay Time (BCLK standard)			18	ns
th(BCLK-ALE)	ALE Signal Output Hold Time (BCLK standard)		-2		ns
td(AD-ALE)	ALE Signal Output Delay Time (address standard)		(Note 3)		ns
th(ALE-AD)	ALE Signal Output Hold Time (address standard)		(Note 4)		ns
tdz(RD-AD)	Address Output Float Start Time			8	ns

NOTES:

1. Values can be obtained by the following equations, according to BLCK frequency.

$$th(RD-AD) = \frac{10^9}{f(BCLK) \times 2} - 10 \quad [ns]$$

$$th(WR-AD) = \frac{10^9}{f(BCLK) \times 2} - 10 \quad [ns]$$

$$th(RD-CS) = \frac{10^9}{f(BCLK) \times 2} - 10 \quad [ns]$$

$$th(WR-CS) = \frac{10^9}{f(BCLK) \times 2} - 10 \quad [ns]$$

$$th(WR-DB) = \frac{10^9}{f(BCLK) \times 2} - 20 \quad [ns]$$

2. Values can be obtained by the following equations, according to BLCK frequency and external bus cycles.

$$td(DB-WR) = \frac{10^9 \times m}{f(BCLK) \times 2} - 25 \quad [ns]$$ (if external bus cycle is aφ + bφ, m=(b+2)-1)

3. Values can be obtained by the following equations, according to BLCK frequency and external bus cycles.

$$td(AD-ALE) = \frac{10^9 \times n}{f(BCLK) \times 2} - 20 \quad [ns]$$ (if external bus cycle is aφ + bφ, n=a)

4. Values can be obtained by the following equations, according to BLCK frequency and external bus cycles.

$$th(ALE-AD) = \frac{10^9 \times n}{f(BCLK) \times 2} - 10 \quad [ns]$$ (if external bus cycle is aφ + bφ, n=a)

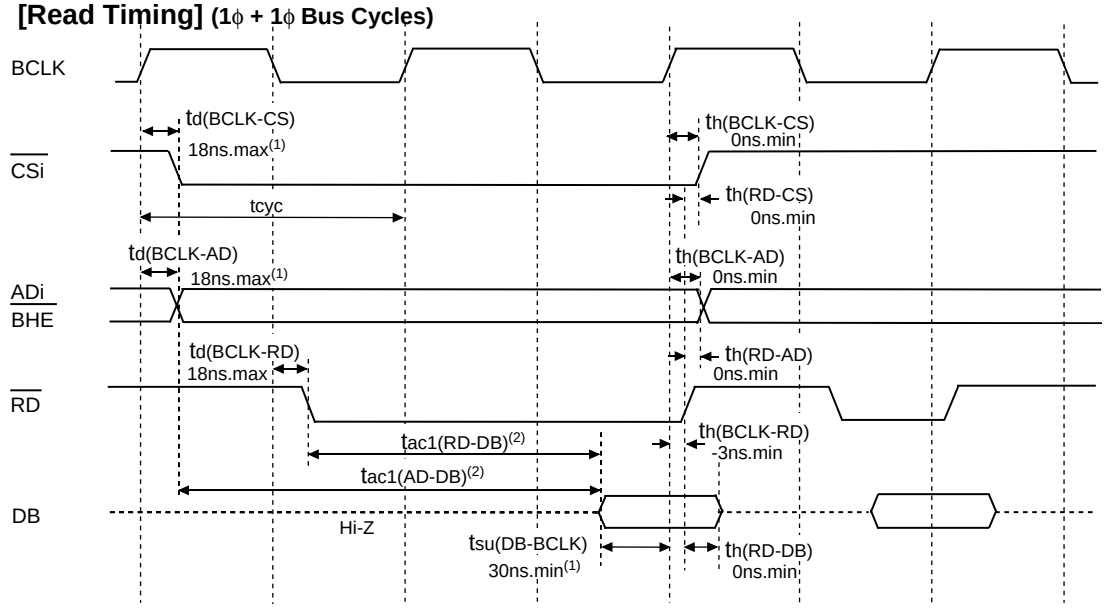
5. *tc* ns is added when recovery cycle is inserted.

Vcc1=Vcc2=3.3V

Memory Expansion Mode and Microprocessor Mode

(when accessing an external memory space)

[Read Timing] (1φ + 1φ Bus Cycles)



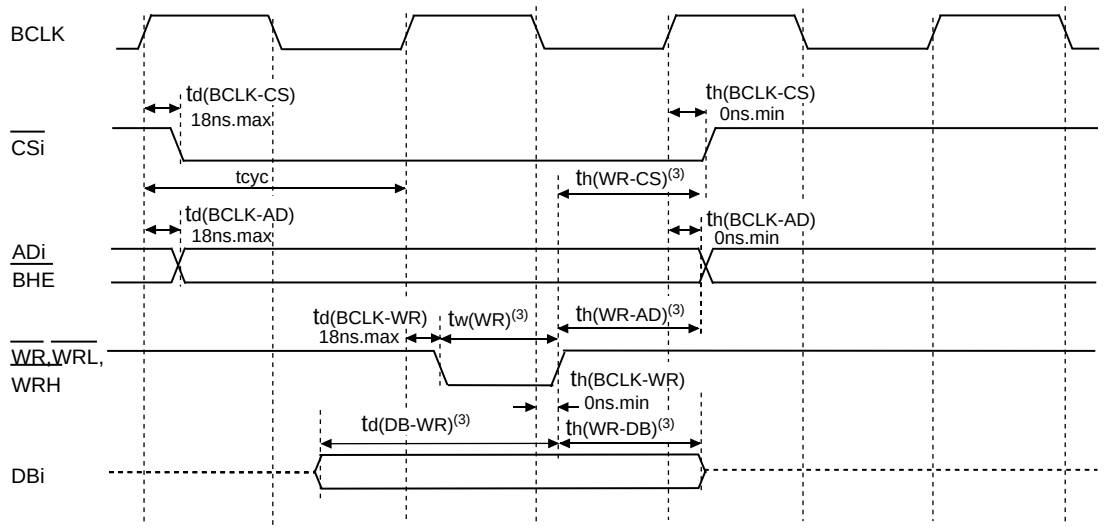
NOTES:

1. Values guaranteed only when the microcomputer is used independently.
   A maximum of 35ns is guaranteed for $t_{d(BCLK-AD)}+t_{su(DB-BCLK)}$.
2. Varies with operation frequency.

   $t_{ac1(RD-DB)}$=(tcyc/2 x m-35)ns.max (if external bus cycle is aφ + bφ, m=(b x 2) + 1)

   $t_{ac1(AD-DB)}$=(tcyc x n-35)ns.max (if external bus cycle is aφ + bφ, n = a + b)

[Write Timing] (1φ + 1φ Bus Cycles)



NOTES:

3. Varies with operation frequency.

   $t_{d(DB-WR)}$=(tcyc x m-20)ns.min

   (if external bus cycle is aφ + bφ, m=b)

   $t_{h(WR-DB)}$=(tcyc/2-20)ns.min

   $t_{h(WR-AD)}$=(tcyc/2-10)ns.min

   $t_{h(WR-CS)}$=(tcyc/2-10)ns.min

   $t_{w(WR)}$=(tcyc/2 x n-15)ns.min

   (if external bus cycle is aφ + bφ, n=(bx2)-1)

Measurement Conditions

- V_{CC1}=V_{CC2}=3.0 to 3.6V
- Input high and low voltage: V_{IH}=1.5V, V_{IL}=0.5V
- Output high and low voltage: V_{OH}=1.5V, V_{OL}=1.5V

$$tcyc = \frac{10^9}{f(BCLK)}$$

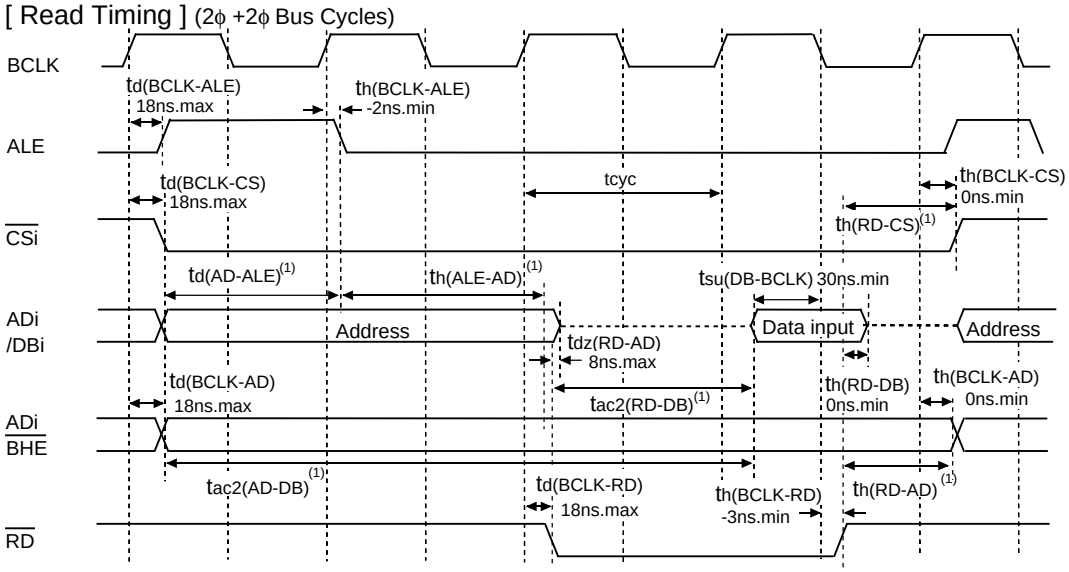
Figure 5.7 V_{CC1}=V_{CC2}=3.3V Timing Diagram (1)

Memory Expansion Mode and Microprocessor Mode

$V_{CC1}=V_{CC2}=3.3V$

(when accessing external memory space and using the multiplexed bus)

[Read Timing] (2φ +2φ Bus Cycles)



NOTES:

1. Varies with operation frequency:

$t_{d(AD-ALE)}$=(tcyc/2 x n-20)ns.min (if external bus cycle is aφ + bφ, n=a)

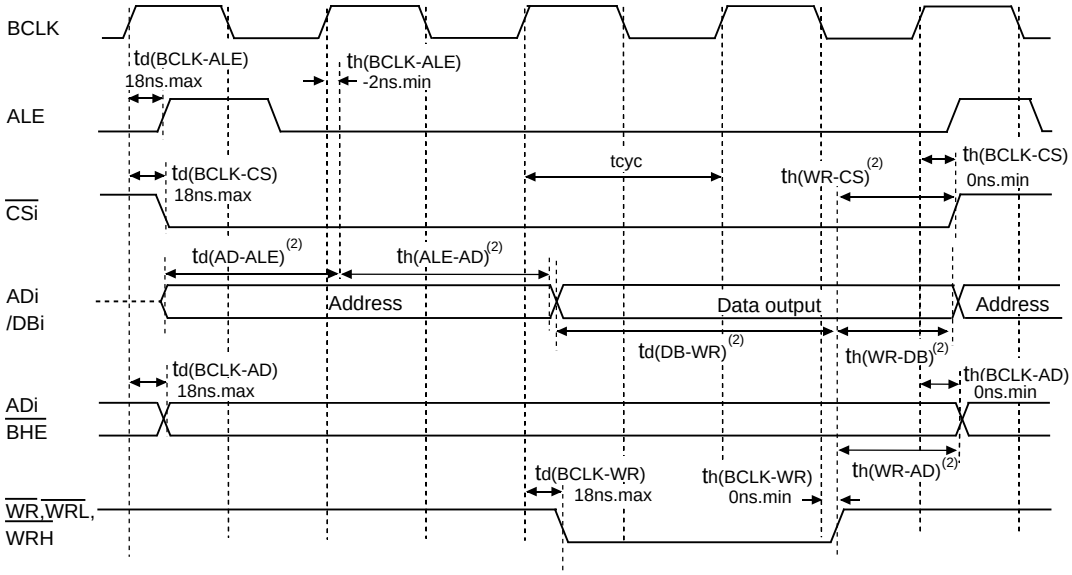
$t_{h(ALE-AD)}$=(tcyc/2 x n-10)ns.min (if external bus cycle is aφ + bφ, n=a)

$t_{h(RD-AD)}$=(tcyc/2-10)ns.min, $t_{h(RD-CS)}$=(tcyc/2-10)ns.min

$t_{ac2(RD-DB)}$=(tcyc/2 x m-35)ns.max (if external bus cycle is aφ + bφ, m=(b x 2)-1)

$t_{ac2(AD-DB)}$=(tcyc/2 x p-35)ns.max (if external bus cycle is aφ + bφ, p={(a+b-1) x 2}+1)

[Write Timing] (2φ +2φ Bus Cycles)



NOTES:

2. Varies with operation frequency:

$t_{d(AD-ALE)}$=(tcyc/2 x n - 20)ns.min

(if external bus cycle is aφ + bφ, n=a)

$t_{h(ALE-AD)}$=(tcyc/2 x n -10)ns.min

(if external bus cycle is aφ + bφ, n=a)

$t_{h(WR-AD)}$=(tcyc/2-10)ns.min,

$t_{h(WR-CS)}$=(tcyc/2-10)ns.min, $t_{h(WR-DB)}$=(tcyc/2-20)ns.min

$t_{d(DB-WR)}$=(tcyc/2 x m-25)ns.min

(if external bus cycle is aφ + bφ, m=(b x 2)-1)

Measurement Conditions:

- $V_{CC1}=V_{CC2}$=3.0 to 3.6V
- Input high and low voltage: V_{IH}=1.5V, V_{IL}=0.5V
- Output high and low voltage: V_{OH}=1.5V, V_{OL}=1.5V

$$tcyc=\frac{10^9}{f_{(BCLK)}}$$

Figure 5.8 $V_{CC1}=V_{CC2}$=3.3V Timing Diagram (2)

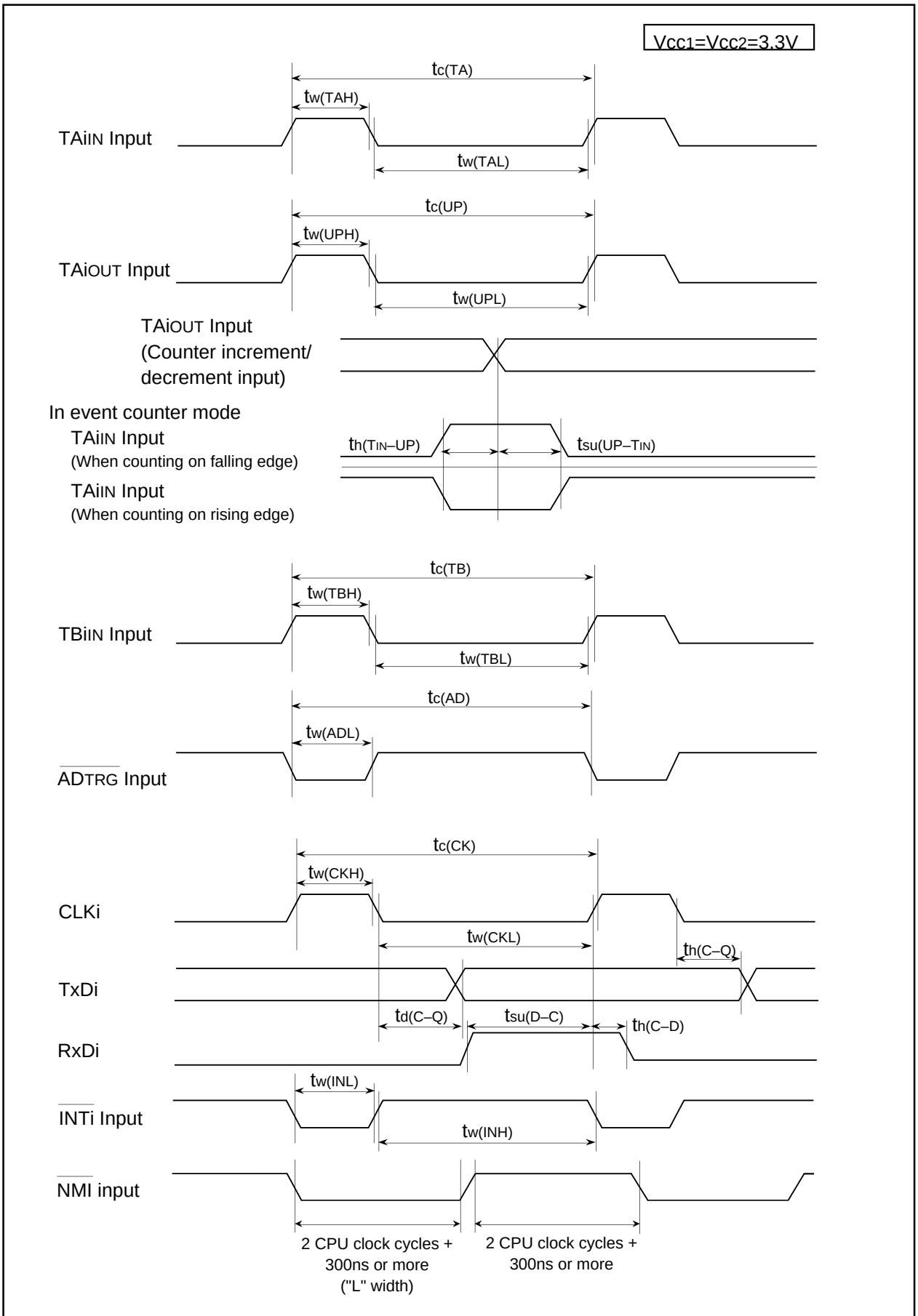
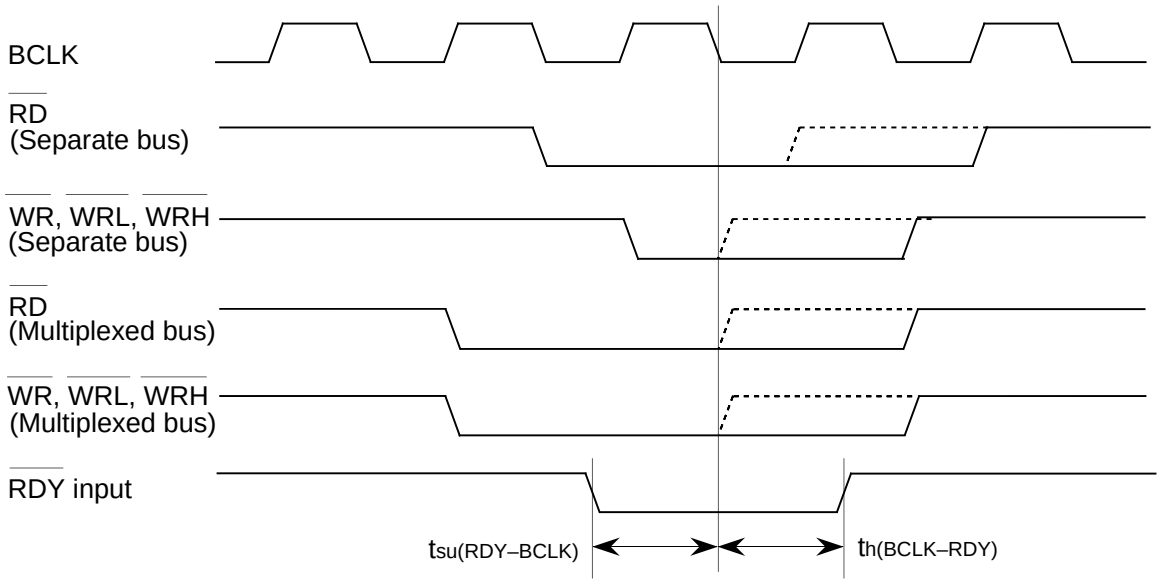
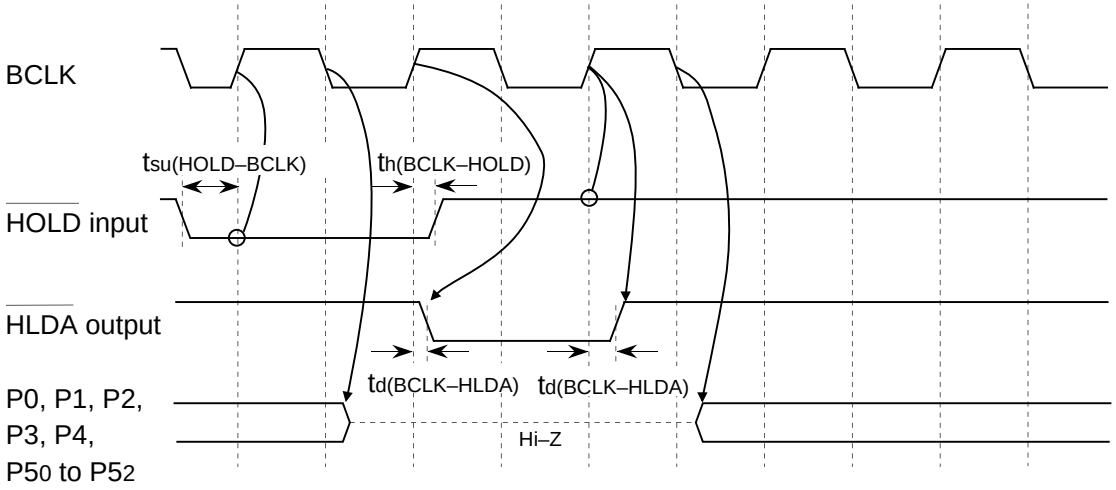


Figure 5.9 Vcc1=Vcc2=3.3V Timing Diagram (3)

$V_{CC1}=V_{CC2}=3.3V$

Memory Expansion Mode and Microprocessor Mode





Measurement Conditions:
- $V_{CC1}=V_{CC2}=3.0$ to 3.6V
- Input high and low voltage: $V_{IH}=2.4V$, $V_{IL}=0.6V$
- Output high and low voltage: $V_{OH}=1.5V$, $V_{OL}=1.5V$

Figure 5.10 $V_{CC1}=V_{CC2}=3.3V$ Timing Diagram (4)

5.2 Electrical Characteristics (M32C/84T)

Table 5.42 Absolute Maximum Ratings

Symbol	Parameter		Condition	Value	Unit
V_{CC1}, V_{CC2}	Supply Voltage		V_{CC1}=V_{CC2}=AVcc	-0.3 to 6.0	V
AVcc	Analog Supply Voltage		V_{CC1}=V_{CC2}=AVcc	-0.3 to 6.0	V
V_I	Input Voltage	$\overline{RESET}$, CNVss, BYTE, $P6_0$-$P6_7$, $P7_2$-$P7_7$, $P8_0$-$P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(1), V_{REF}, X_{IN}		-0.3 to V_{CC1}+0.3	V
		$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$(1)		-0.3 to V_{CC2}+0.3	
		$P7_0$, $P7_1$		-0.3 to 6.0	
V_O	Output Voltage	$P6_0$-$P6_7$, $P7_2$-$P7_7$, $P8_0$-$P8_4$, $P8_6$, $P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(1), X_{OUT}		-0.3 to V_{CC1}+0.3	V
		$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$(1)		-0.3 to V_{CC2}+0.3	
		$P7_0$, $P7_1$		-0.3 to 6.0	
Pd	Power Dissipation		Topr=25° C	500	mW
Topr	Operating Ambient Temperature	during CPU operation	T version	-40 to 85	° C
		during flash memory program and erase operation		0 to 60	
Tstg	Storage Temperature			-65 to 150	° C

NOTES:

1. P11 to P15 are provided in the 144-pin package only.

Table 5.43 Recommended Operating Conditions

(V_{CC1}=V_{CC2}=4.2 to 5.5V, V_{SS}=0V at Topr = -40 to 85°C (T version) unless otherwise specified)

Symbol	Parameter		Standard			Unit
			Min.	Typ.	Max.	
V_{CC1}, V_{CC2}	Supply Voltage (V_{CC1}≥ V_{CC2})		4.2	5.0	5.5	V
AVcc	Analog Supply Voltage			V_{CC1}		V
Vss	Supply Voltage			0		V
AVss	Analog Supply Voltage			0		V
V_{IH}	Input High ("H") Voltage	$P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$(4)	0.8V_{CC2}		V_{CC2}	V
		$P6_0$-$P6_7$, $P7_2$-$P7_7$, $P8_0$-$P8_7$(3), $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(4), X_{IN}, $\overline{RESET}$, CNVss, BYTE	0.8V_{CC1}		V_{CC1}	
		$P7_0$, $P7_1$	0.8V_{CC1}		6.0	
		$P0_0$-$P0_7$, $P1_0$-$P1_7$	0.8V_{CC2}		V_{CC2}	
V_{IL}	Input Low ("L") Voltage	$P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$(4)	0		0.2V_{CC2}	V
		$P6_0$-$P6_7$, $P7_0$-$P7_7$, $P8_0$-$P8_7$(3), $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(4), X_{IN}, $\overline{RESET}$, CNVss, BYTE	0		0.2V_{CC1}	
		$P0_0$-$P0_7$, $P1_0$-$P1_7$	0		0.2V_{CC2}	
$I_{OH(peak)}$	Peak Output High ("H") Current(2)	$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P6_0$-$P6_7$, $P7_2$-$P7_7$, $P8_0$-$P8_4$, $P8_6$, $P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(4)			-10.0	mA
$I_{OH(avg)}$	Average Output High ("H") Current(1)	$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P6_0$-$P6_7$, $P7_2$-$P7_7$, $P8_0$-$P8_4$, $P8_6$, $P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(4)			-5.0	mA
$I_{OL(peak)}$	Peak Output Low ("L") Current(2)	$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P6_0$-$P6_7$, $P7_0$-$P7_7$, $P8_0$-$P8_4$, $P8_6$, $P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(4)			10.0	mA
$I_{OL(avg)}$	Average Output Low ("L") Current(1)	$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P6_0$-$P6_7$, $P7_0$-$P7_7$, $P8_0$-$P8_4$, $P8_6$, $P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(4)			5.0	mA

NOTES:

1. Typical values when average output current is 100ms.
2. Total $I_{OL(peak)}$ for P0, P1, P2, $P8_6$, $P8_7$, P9, P10, P11, P14 and P15 must be 80mA or less.
   Total $I_{OL(peak)}$ for P3, P4, P5, P6, P7, $P8_0$ to $P8_4$, P12 and P13 must be 80mA or less.
   Total $I_{OH(peak)}$ for P0, P1, P2, and P11 must be -40mA or less.
   Total $I_{OH(peak)}$ for $P8_6$, $P8_7$, P9, P10, P14 and P15 must be -40mA or less.
   Total $I_{OH(peak)}$ for P3, P4, P5, P12 and P13 must be -40mA or less.
   Total $I_{OH(peak)}$ for P6, P7, and $P8_0$ to $P8_4$ must be -40mA or less.
3. V_{IH} and V_{IL} reference for $P8_7$ applies when $P8_7$ is used as a programmable input port.
   It does not apply when $P8_7$ is used as X_{CIN}.
4. P11 to P15 are provided in the 144-pin package only.

Table 5.43 Recommended Operating Conditions (Continued)

(V_{CC1}=V_{CC2}=4.2 to 5.5V, V_{SS}=0V at Topr = -40 to 85°C (T version) unless otherwise specified)

Symbol	Parameter		Standard			Unit
			Min.	Typ.	Max.	
$f(BCLK)$	CPU Input Frequency	V_{CC1}=4.2 to 5.5V	0		32	MHz
$f(X_{IN})$	Main Clock Input Frequency	V_{CC1}=4.2 to 5.5V	0		32	MHz
$f(X_{CIN})$	Sub Clock Frequency			32.768	50	kHz
$f(Ring)$	On-chip Oscillator Frequency (V_{CC1}=V_{CC2}=5.0V, Topr=25° C)		0.5	1	2	MHz
$f(PLL)$	PLL Clock Frequency	V_{CC1}=4.2 to 5.5V	10		32	MHz
$t_{SU(PLL)}$	Wait Time to Stabilize PLL Frequency Synthesizer	V_{CC1}=5.0V			5	ms

$V_{CC1}=V_{CC2}=5V$

Table 5.44 Electrical Characteristics

($V_{CC1}=V_{CC2}=4.2$ to 5.5V, $V_{SS}=0V$ at Topr = -40 to 85°C (T version), f(BCLK)=32MHz unless otherwise specified)

Symbol	Parameter		Condition	Standard			Unit
				Min.	Typ.	Max.	
V_{OH}	Output High ("H") Voltage	$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$	I_{OH}=-5mA	V_{CC2}-2.0		V_{CC2}	V
		$P6_0$-$P6_7$, $P7_2$-$P7_7$, $P8_0$-$P8_4$, $P8_6$, $P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(1)	I_{OH}=-5mA	V_{CC1}-2.0		V_{CC1}	
		$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$	I_{OH}=-200µA	V_{CC2}-0.3		V_{CC2}	V
		$P6_0$-$P6_7$, $P7_2$-$P7_7$, $P8_0$-$P8_4$, $P8_6$, $P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$,$P14_0$-$P14_6$, $P15_0$-$P15_7$(1)	I_{OH}=-200µA	V_{CC1}-0.3		V_{CC1}	
		X_{OUT}	I_{OH}=-1mA	3.0			V
		X_{COUT} High Power	No load applied		2.5		V
		X_{COUT} Low Power	No load applied		1.6		
V_{OL}	Output Low ("L") Voltage	$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P6_0$-$P6_7$, $P7_0$-$P7_7$, $P8_0$-$P8_4$, $P8_6$, $P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(1)	I_{OL}=5mA			2.0	V
		$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P6_0$-$P6_7$, $P7_0$-$P7_7$, $P8_0$-$P8_4$, $P8_6$, $P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(1)	I_{OL}=200µA			0.45	V
		X_{OUT}	I_{OL}=1mA			2.0	V
		X_{COUT} High Power	No load applied		0		V
		X_{COUT} Low Power	No load applied		0		
V_{T+}-V_{T-}	Hysteresis	$\overline{HOLD}$, $\overline{RDY}$, TA0IN-TA4IN, TB0IN-TB5IN, $\overline{INT0}$-$\overline{INT5}$, $\overline{ADTRG}$, $\overline{CTS0}$-$\overline{CTS4}$, CLK0-CLK4, TA0OUT-TA4OUT, $\overline{NMI}$, $\overline{KI0}$-$\overline{KI3}$, RxD0-RxD4, SCL0-SCL4, SDA0-SDA4		0.2		1.0	V
		$\overline{RESET}$		0.2		1.8	V
I_{IH}	Input High ("H") Current	$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P6_0$-$P6_7$, $P7_0$-$P7_7$, $P8_0$-$P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(1), X_{IN}, $\overline{RESET}$, CNV_{SS}, BYTE	V_I=5V			5.0	µA
I_{IL}	Input Low ("L") Current	$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P6_0$-$P6_7$, $P7_0$-$P7_7$, $P8_0$-$P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(1), X_{IN}, $\overline{RESET}$, CNV_{SS}, BYTE	V_I=0V			-5.0	µA
R_{PULLUP}	Pull-up Resistance	$P0_0$-$P0_7$, $P1_0$-$P1_7$, $P2_0$-$P2_7$, $P3_0$-$P3_7$, $P4_0$-$P4_7$, $P5_0$-$P5_7$, $P6_0$-$P6_7$, $P7_2$-$P7_7$, $P8_0$-$P8_4$, $P8_6$, $P8_7$, $P9_0$-$P9_7$, $P10_0$-$P10_7$, $P11_0$-$P11_4$, $P12_0$-$P12_7$, $P13_0$-$P13_7$, $P14_0$-$P14_6$, $P15_0$-$P15_7$(1)	V_I=0V Flash Memory	30	50	167	kΩ
Rf_{XIN}	Feedback Resistance	X_{IN}			1.5		MΩ
Rf_{XCIN}	Feedback Resistance	X_{CIN}			10		MΩ
V_{RAM}	RAM Standby Voltage	In stop mode		2.0			V

NOTES:

1. P11 to P15 are provided in the 144-pin package only.

$V_{CC1}=V_{CC2}=5V$

Table 5.44 Electrical Characteristics (Continued)
($V_{CC1}=V_{CC2}=4.2$ to 5.5V, $V_{SS}=0V$ at Topr = -40 to 85°C (T version), f(BCLK)=32MHz unless otherwise specified)

Symbol	Parameter	Measurement Condition		Standard			Unit
				Min.	Typ.	Max.	
I_{CC}	Power Supply Current	In single-chip mode, output pins are left open and other pins are connected to V_{SS}.	f(BCLK)=32 MHz, Square wave, No division		28	50	mA
			f(BCLK)=32 kHz, In low-power consumption mode, Program running on ROM		430		µA
			f(BCLK)=32 kHz, In low-power consumption mode, Program running on RAM(1)		25		µA
			f(BCLK)=32 kHz, In wait mode, Topr=25° C		10		µA
			While clock stops, Topr=25° C		0.8	5	µA
			While clock stops, Topr=85° C			50	µA

NOTES:
1. Value is obtained when setting the FMSTP bit in the FMR0 register to "1" (flash memory stopped).

$V_{CC1}=V_{CC2}=5V$

Table 5.45 A/D Conversion Characteristics ($V_{CC1}=V_{CC2}=4.2$ to 5.5V, $V_{SS}=0V$ at Topr= -40 to 85°C (T version), f(BCLK)=32MHz unless otherwise specified)

Symbol	Parameter	Measurement Condition		Standard			Unit
				Min.	Typ.	Max.	
-	Resolution	$V_{REF}=V_{CC1}$				10	Bits
INL	Integral Nonlinearity Error	$V_{REF}=V_{CC1}=V_{CC2}=5V$	AN_0 to AN_7, $AN0_0$ to $AN0_7$, $AN2_0$ to $AN2_7$, $AN15_0$ to $AN15_7$, ANEX0, ANEX1			±3	LSB
							LSB
			External op-amp connection mode			±7	LSB
							LSB
DNL	Differential Nonlinearity Error					±1	LSB
-	Offset Error					±3	LSB
-	Gain Error					±3	LSB
R_{LADDER}	Resistor Ladder	$V_{REF}=V_{CC1}$		8		40	kΩ
t_{CONV}	10-bit Conversion Time(1, 2)			2.06			µs
t_{CONV}	8-bit Conversion Time(1, 2)			1.75			µs
t_{SAMP}	Sampling Time(1)			0.188			µs
V_{REF}	Reference Voltage			2		V_{CC1}	V
V_{IA}	Analog Input Voltage			0		V_{REF}	V

NOTES:
1. Divide f(X_{IN}), if exceeding 16 MHz, to keep ϕAD frequency at 16 MHz or less.
2. With using the sample and hold function.

Table 5.46 D/A Conversion Characteristics ($V_{CC1}=V_{CC2}=4.2$ to 5.5V, $V_{SS}=0V$ at Topr= -40 to 85°C (T version), f(BCLK)=32MHz unless otherwise specified)

Symbol	Parameter	Measurement Condition	Standard			Unit
			Min.	Typ.	Max.	
-	Resolution				8	Bits
-	Absolute Accuracy				1.0	%
t_{SU}	Setup Time				3	µs
R_O	Output Resistance		4	10	20	kΩ
I_{VREF}	Reference Power Supply Input Current	(Note 1)			1.5	mA

NOTES:
1. Measurement when using one D/A converter. The DAi register (i=0, 1) of the D/A converter, not being used, is set to "00_{16}". The resistor ladder in the A/D converter is excluded.
I_{VREF} flows even if the VCUT bit in the AD0CON1 register is set to "0" (no V_{REF} connection).

$V_{CC1}=V_{CC2}=5V$

Table 5.47 Flash Memory Version Electrical Characteristics

(V_{CC1}=4.5 to 5.5V, 3.3 to 3.6V at Topr= 0 to 60°C unless otherwise specified)

Symbol	Parameter		Standard			Unit
			Min.	Typ.	Max.	
-	Program and Erase Endurance(2)		100			cycles
-	Word Program Time (V_{CC1}=5.0V, Topr=25° C)			25	200	µs
-	Lock Bit Program Time			25	200	µs
-	Block Erase Time (V_{CC1}=5.0V, Topr=25° C)	4-Kbyte Block		0.3	4	s
		8-Kbyte Block		0.3	4	s
		32-Kbyte Block		0.5	4	s
		64-Kbyte Block		0.8	4	s
-	All-Unlocked-Block Erase Time(1)				4 x *n*	s
t_{PS}	Wait Time to Stabilize Flash Memory Circuit				15	µs
-	Data Hold Time (Topr=-40 to 85 ° C)		10			years

NOTES:
1. *n* denotes the number of block to be erased.
2. Number of program-erase cycles per block.
   If Program and Erase Endurance is *n* cycle (*n*=100), each block can be erased and programmed *n* cycles. For example, if a 4-Kbyte block A is erased after programming a word data 2,048 times, each to a different address, this counts as one program and erase endurance. Data can not be programmed to the same address more than once without erasing the block. (rewrite prohibited).

Table 5.48 Power Supply Timing

Symbol	Parameter	Measurement Condition	Standard			Unit
			Min.	Typ.	Max.	
td(P-R)	Wait Time to Stabilize Internal Supply Voltage when Power-on	V_{CC1}=3.0 to 5.5V			2	ms

$t_{d(P-R)}$
Wait Time to Stabilize Internal Supply Voltage when Power-on

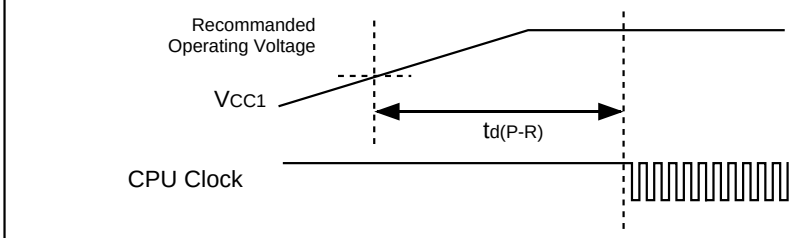


Figure 5.11 Power Supply Timing Diagram

$V_{CC1}=V_{CC2}=5V$

Timing Requirements

($V_{CC1}=V_{CC2}=4.2$ to 5.5V, $V_{SS}=0V$ at Topr= -40 to 85°C (T version) unless otherwise specified)

Table 5.49 External Clock Input

Symbol	Parameter	Standard		Unit
		Min.	Max.	
tc	External Clock Input Cycle Time	31.25		ns
$tw_{(H)}$	External Clock Input High ("H") Width	13.75		ns
$tw_{(L)}$	External Clock Input Low ("L") Width	13.75		ns
tr	External Clock Rise Time		5	ns
tf	External Clock Fall Time		5	ns

$V_{CC1}=V_{CC2}=5V$

Timing Requirements

($V_{CC1}=V_{CC2}=4.2$ to 5.5V, $V_{SS}=0V$ at Topr= -40 to 85°C (T version) unless otherwise specified)

Table 5.50 Timer A Input (Count Source Input in Event Counter Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TA)}$	TAi_{IN} Input Cycle Time	100		ns
$t_{w(TAH)}$	TAi_{IN} Input High ("H") Width	40		ns
$t_{w(TAL)}$	TAi_{IN} Input Low ("L") Width	40		ns

Table 5.51 Timer A Input (Gate Input in Timer Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TA)}$	TAi_{IN} Input Cycle Time	400		ns
$t_{w(TAH)}$	TAi_{IN} Input High ("H") Width	200		ns
$t_{w(TAL)}$	TAi_{IN} Input Low ("L") Width	200		ns

Table 5.52 Timer A Input (External Trigger Input in One-Shot Timer Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TA)}$	TAi_{IN} Input Cycle Time	200		ns
$t_{w(TAH)}$	TAi_{IN} Input High ("H") Width	100		ns
$t_{w(TAL)}$	TAi_{IN} Input Low ("L") Width	100		ns

Table 5.53 Timer A Input (External Trigger Input in Pulse Width Modulation Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{w(TAH)}$	TAi_{IN} Input High ("H") Width	100		ns
$t_{w(TAL)}$	TAi_{IN} Input Low ("L") Width	100		ns

Table 5.54 Timer A Input (Counter Increment/Decrement Input in Event Counter Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(UP)}$	TAi_{OUT} Input Cycle Time	2000		ns
$t_{w(UPH)}$	TAi_{OUT} Input High ("H") Width	1000		ns
$t_{w(UPL)}$	TAi_{OUT} Input Low ("L") Width	1000		ns
$t_{su(UP-TIN)}$	TAi_{OUT} Input Setup Time	400		ns
$t_{h(TIN-UP)}$	TAi_{OUT} Input Hold Time	400		ns

$V_{CC1}=V_{CC2}=5V$

Timing Requirements

($V_{CC1}=V_{CC2}=4.2$ to 5.5V, $V_{SS}=0V$ at Topr= -40 to 85°C (T version) unless otherwise specified)

Table 5.55 Timer B Input (Count Source Input in Event Counter Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TB)}$	TBi_{IN} Input Cycle Time (counted on one edge)	100		ns
$t_{w(TBH)}$	TBi_{IN} Input High ("H") Width (counted on one edge)	40		ns
$t_{w(TBL)}$	TBi_{IN} Input Low ("L") Width (counted on one edge)	40		ns
$t_{c(TB)}$	TBi_{IN} Input Cycle Time (counted on both edges)	200		ns
$t_{w(TBH)}$	TBi_{IN} Input High ("H") Width (counted on both edges)	80		ns
$t_{w(TBL)}$	TBi_{IN} Input Low ("L") Width (counted on both edges)	80		ns

Table 5.56 Timer B Input (Pulse Period Measurement Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TB)}$	TBi_{IN} Input Cycle Time	400		ns
$t_{w(TBH)}$	TBi_{IN} Input High ("H") Width	200		ns
$t_{w(TBL)}$	TBi_{IN} Input Low ("L") Width	200		ns

Table 5.57 Timer B Input (Pulse Width Measurement Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TB)}$	TBi_{IN} Input Cycle Time	400		ns
$t_{w(TBH)}$	TBi_{IN} Input High ("H") Width	200		ns
$t_{w(TBL)}$	TBi_{IN} Input Low ("L") Width	200		ns

Table 5.58 A/D Trigger Input

Symbol	Parameter	Standard		Unit
		Min.	Max	
$t_{c(AD)}$	$\overline{ADTRG}$ Input Cycle Time (required for trigger)	1000		ns
$t_{w(ADL)}$	$\overline{ADTRG}$ Input Low ("L") Pulse Width	125		ns

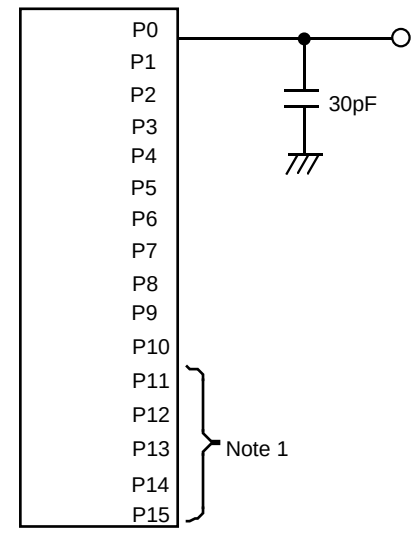
Table 5.59 Serial I/O

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(CK)}$	CLKi Input Cycle Time	200		ns
$t_{w(CKH)}$	CLKi Input High ("H") Width	100		ns
$t_{w(CKL)}$	CLKi Input Low ("L") Width	100		ns
$t_{d(C-Q)}$	TxDi Output Delay Time		80	ns
$t_{h(C-Q)}$	TxDi Hold Time	0		ns
$t_{su(D-C)}$	RxDi Input Setup Time	30		ns
$t_{h(C-Q)}$	RxDi Input Hold Time	90		ns

Table 5.60 External Interrupt $\overline{INTi}$ Input

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{w(INH)}$	$\overline{INTi}$ Input High ("H") Width	250		ns
$t_{w(INL)}$	$\overline{INTi}$ Input Low ("L") Width	250		ns

$V_{CC1}=V_{CC2}=5V$



NOTES:
1. P11 to P15 are provided in the 144-pin package only.

Figure 5.12 P0 to P15 Measurement Circuit

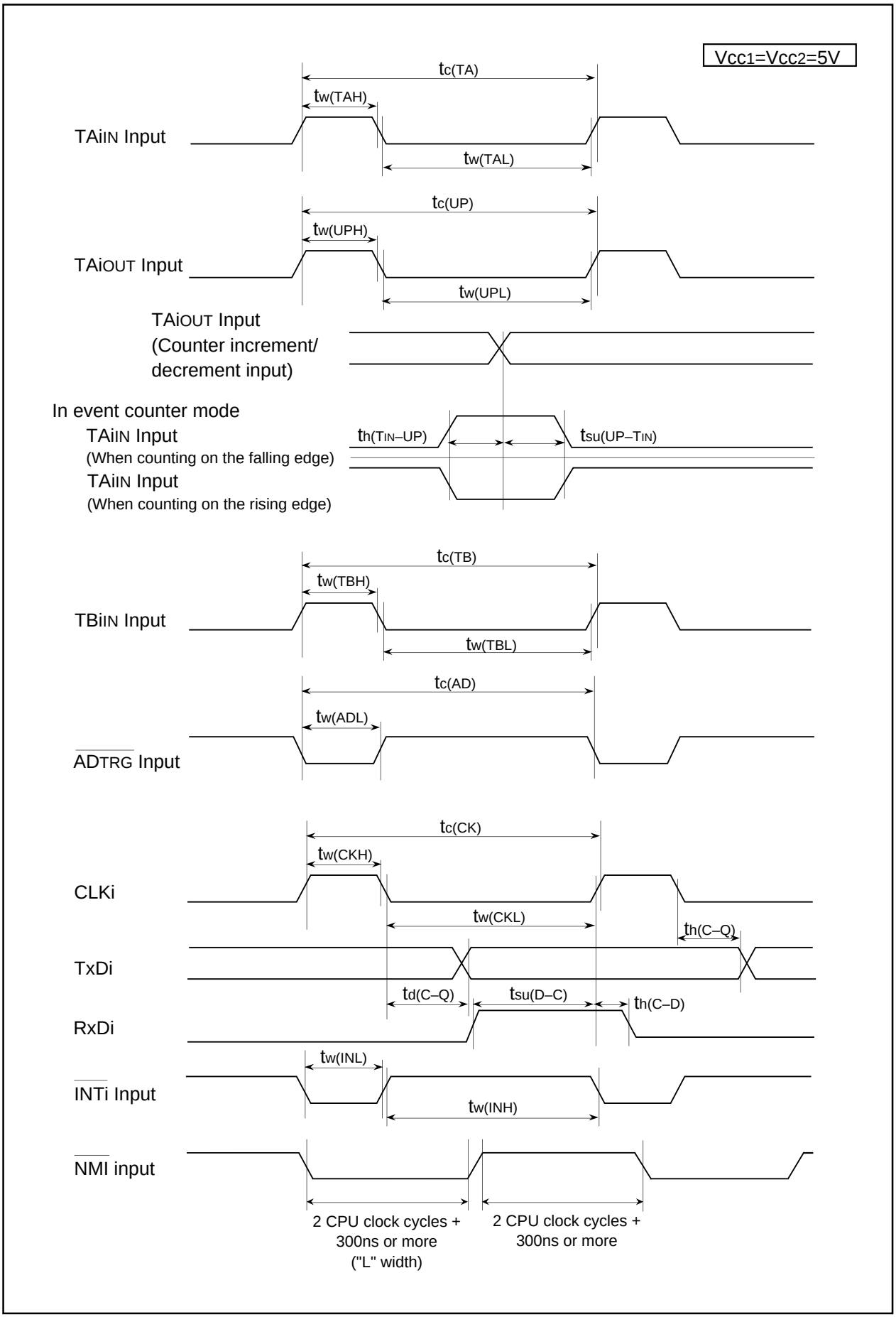


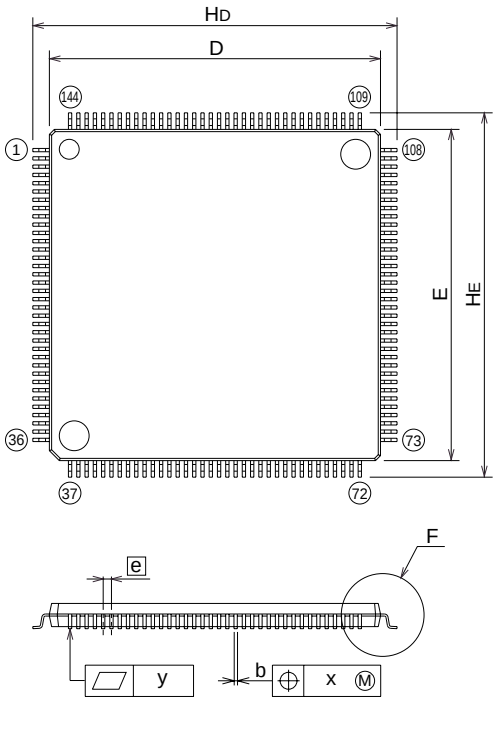
Figure 5.13 Vcc1=Vcc2=5V Timing Diagram

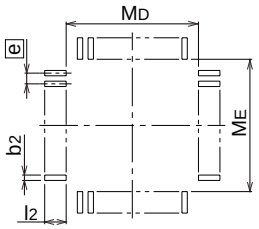
Package Dimensions

PLQP0144KA-A (144P6Q-A)

Plastic 144pin 20×20mm body LQFP

JEITA Package Code	RENESAS Code	Previous Code	Mass[Typ.]
P-LQFP144-20x20-0.50	PLQP0144KA-A	144P6Q-A	1.2g





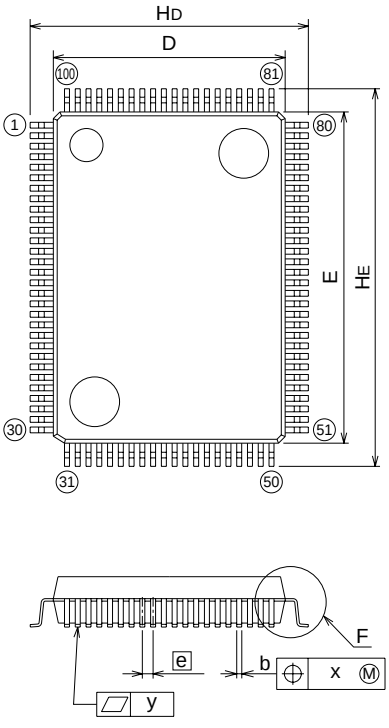
Recommended Mount Pad

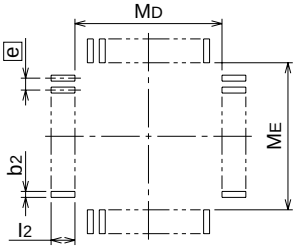
Symbol	Dimension in Millimeters		
	Min	Nom	Max
A	–	–	1.7
A1	0.05	0.125	0.2
A2	–	1.4	–
b	0.17	0.22	0.27
c	0.105	0.125	0.175
D	19.9	20.0	20.1
E	19.9	20.0	20.1
e	–	0.5	–
HD	21.8	22.0	22.2
HE	21.8	22.0	22.2
L	0.35	0.5	0.65
L1	–	1.0	–
Lp	0.45	0.6	0.75
A3	–	0.25	–
x	–	–	0.08
y	–	–	0.1
θ	0°	–	8°
b2	–	0.225	–
l2	0.95	–	–
MD	–	20.4	–
ME	–	20.4	–

PRQP0100JB-A (100P6S-A)

Plastic 100pin 14×20mm body QFP

JEITA Package Code	RENESAS Code	Previous Code	Mass[Typ.]
P-QFP100-14x20-0.65	PRQP0100JB-A	100P6S-A	1.6g





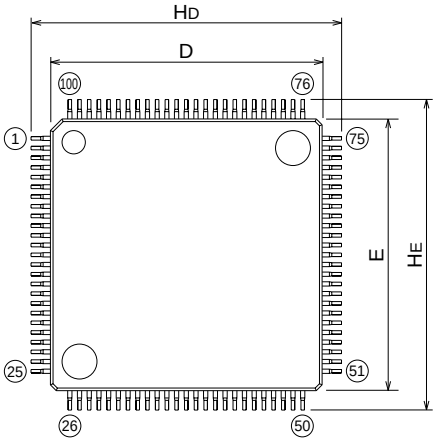
Recommended Mount Pad

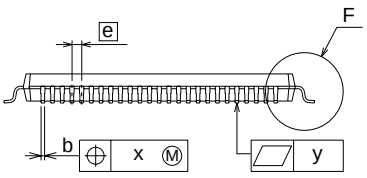
Symbol	Dimension in Millimeters		
	Min	Nom	Max
A	–	–	3.05
A1	0	0.1	0.2
A2	–	2.8	–
b	0.25	0.3	0.4
c	0.13	0.15	0.2
D	13.8	14.0	14.2
E	19.8	20.0	20.2
e	–	0.65	–
HD	16.5	16.8	17.1
HE	22.5	22.8	23.1
L	0.4	0.6	0.8
L1	–	1.4	–
x	–	–	0.13
y	–	–	0.1
θ	0°	–	10°
b2	–	0.35	–
l2	1.3	–	–
MD	–	14.6	–
ME	–	20.6	–

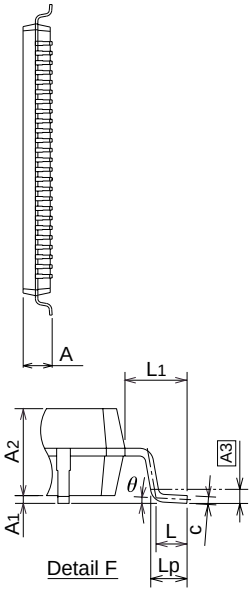
PLQP0100KB-A (100P6Q-A)

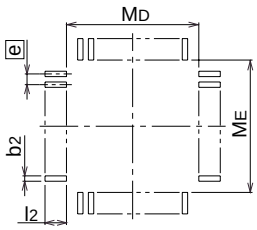
Plastic 100pin 14×14mm body LQFP

JEITA Package Code	RENESAS Code	Previous Code	Mass[Typ.]
P-LQFP100-14x14-0.50	PLQP0100KB-A	100P6Q-A	0.6g









Recommended Mount Pad

Symbol	Dimension in Millimeters		
	Min	Nom	Max
A	–	–	1.7
A1	0	0.1	0.2
A2	–	1.4	–
b	0.13	0.18	0.28
c	0.105	0.125	0.175
D	13.9	14.0	14.1
E	13.9	14.0	14.1
e	–	0.5	–
HD	15.8	16.0	16.2
HE	15.8	16.0	16.2
L	0.3	0.5	0.7
L1	–	1.0	–
Lp	0.45	0.6	0.75
A3	–	0.25	–
x	–	–	0.08
y	–	–	0.1
θ	0°	–	10°
b2	–	0.225	–
l2	0.9	–	–
MD	–	14.4	–
ME	–	14.4	–

REVISION HISTORY	M32C/84 Group (M32C/84, M32C/84T) Datasheet

Rev.	Date	Description	
		Page	Summary
0.40	Sep. 30, 2003	–	New Document
0.50	Feb. 05, 2004		**Overview**
		2, 3	• **Table 1.1** and **Table 1.2 M32C/84 Group Performance** Values for Shortest Instruction Execution Time and Power Consumption" modified
		5	• **Figure 1.2 ROM/RAM Capacity** Products added
			• **Table 1.3 M32C/84 Group** Products added
		6	• **Figure 1.3 Product Numbering System** 128-Kbytes added to ROM capacity Memory
		23	• **Figure 3.1 Memory Map** Diagram modified; products added
			SFR
		24	• "Values after RESET" for the PM1, PM2, D4INT, G0IRF, G1IRF, IDB0 to IDB1, TA0MR to TA4MR, TCSPR, DM0SL to DM3SL registers revised
			• The IPSA register added to address 0179_{16}
			• NOTES added to the PM0 and TCSPR register
			Electrical Characteristics
		44	• Newly added
0.51	Feb. 09, 2004		**Electrical Characteristics**
		50	• **Table 5.6 Flash Memory Version Electrical Characteristics** Note 4 revised
		57	• **Figure 5.2 V_{CC1}=V_{CC2}=5V Timing Diagram (1)** Notes 1 and 2 revised
		68	• **Figure 5.3 V_{CC1}=V_{CC2}=5V Timing Diagram (2)** Notes 1, 2, and 3 revised
		68	• **Figure 5.6 V_{CC1}=V_{CC2}=3.3V Timing Diagram (1)** Notes 1, 2, and 3 revised
		69	• **Figure 5.7 V_{CC1}=V_{CC2}=3.3V Timing Diagram (2)** Notes 1 and 2 revised
0.52	Mar.12, 2004		**Overview**
		2, 3	•**Table 1.1 and 1.2 M32C/84 Group Performance** Values for Power Consumption modified
			Electrical Characteristics
		48	• **Table 5.3 Electrical Characteristics** Maximum values for Power Supply Current modified
		50	• **Table 5.6 Flash Memory Version Electrical Characteristics** Note 1. 100-cycle Products (D3, D5, U3, U5) deleted; Note 4 modified
			• **Table 5.7 Flash Memory Version Program and Erase Voltage and Read Operation Voltage Characteristics (at Topr=0 to 60°C)** deleted
		61	• **Table 5.22 Electrical Characteristics** Maximum values for Power Supply Consumption modified and standard values when "Topr=85°C while clock is stopped" deleted

REVISION HISTORY	M32C/84 Group (M32C/84, M32C/84T) Datasheet

Rev.	Date	Description	
		Page	Summary
1.00	Jun.01, 2004	-	**M32C/84T (High-reliability version)** added
		All Pages	Words standardized: On-chip oscillator, A/D converter and D/A converter
			Overview
		1	• **1.1 Applications** Automobiles added
		2, 3	• **Table 1.1** and **Table 1.2 M32C/84 Group (M32C/84, M32C/84T) Performance** M32C/84T added; note 3 added
		4	• **Figure 1.1 M32C/84 Group (M32C/84, M32C/84T) Block Diagram** Note 3 added
		5	• **1.4 Product Information** Description modified
			• **Figure 1.2 ROM/RAM Capacity** figure modified
		6	• **Table 1.3 M32C/84 Group** M32C/84T added
		6	• **Figure 1.3 Product Numbering System** M32C/84T added
		7	• **Figure 1.4 Pin Assignment for 144-Pin Package** Note 3 added
		12	• **Figure 1.6 Pin Assignment for 100-Pin Pacakage** Note 5 added
		8 to 10	• **Table 1.5 Pin Characteristics for 144-Pin Package** Note 1 added
		13, 14	• **Table 1.6 Pin Characteristics for 100-Pin Package** Note 1 added
		15 to 18	• **Table 1.7 Pin Description** Notes added
			Memory
		22	• **Figure 3.1 Memory Map** Tables of internal ROM/internal RAM modified; note 2 modified; notes 4 and 5 added
			SFR
		23	• Note 2 added
		24	• PWCR0 and PWCR1 registers deleted
			• "Values after RESET" of the masked ROM version added to the FMR0 register
			• Note 1 added
			Electrical Characteristics
		44	• **Table 5.2 Recommended Operating Conditions** $f_{(ripple)}$, $V_{p-p(ripple)}$, V_{CC}, SV_{CC} and note 1 deleted
		47	• **Table 5.3 Electrical Characteristics** R_{PULLUP} value for the masked ROM version added
		48	• **Table 5.4 A/D Conversion Characteristics** t_{SMP} value modified; note 1 added
		50	• **Table 5.7 Low Voltage Detect Circuit Electrical Characteristics** added
			• **Table 5.8 Power Supply Timing** added
			• **Figure 5.1 Power Supply Timing Diagram** added
		55	• **Table 5.23 Memory Expassion Mode and Microprocessor Mode** $t_{h(BCLK-ALE)}$ value modified
		61	• **Table 5.24 Electrical Characteristics** R_{PULLUP} value for the masked ROM version added
		62	• **Table 5.25 A/D Conversion Characteristics** t_{CONV} value modified

Rev.	Date	Description	
		Page	Summary
		63	• **Table 5.28 Memory Expassion Mode and Microprocessor Mode** tsu(DB-BCLK), tsu(RDY-BCLK) and tsu(HOLD-BCLK) value modified
		66	• **Table 5.40 Memory Expassion Mode and Microprocessor Mode** equetion of th(WR-DB) modified
		67	• **Table 5.41 Memory Expassion Mode and Microprocessor Mode** th(BCLK-ALE) value modified; equetion of th(WR-DB) modified
		72	• **5.2 Electrical Characteristics (M32C/84T)** added
1.10	Jun.28, 2004	-	**High-reliability version (U version)** deleted
			Overview
		5	• **Table 1.3 M32C/84 Group (1) (2)** development status modified
		6	• **Figure 1.2 Product Numbering System** figure modified
1.20	Apr.18, 2005		**Overview**
		2, 3	• **Table 1.1** and **Table 1.2 M32C/84 Group (M32C/84, M32C/84T) Performance** Note 4 added
		6	• **Table 1.3 M32C/84 Group (1) (2)** Information updated
		16, 17	• **Table 1.6 Pin Description** Note 2 deleted
			Memory
		22	• **Figure 3.1 Memory Map** Description added to Note 3
			SFR
		24	• The PWCR0 and PWCR1 registers newly added to address $004C_{16}$ and $004D_{16}$
			• "Values after RESET" for the G0RB, G1BCR1, G1RB, IDB0, IDB1, DM0SL to DM3SL and PSC registers revised
			Electrical Characteristics
		46	• **Table 5.3 Electrical Characteristics** ICC standard value revised
		49	• **Table 5.6 Flash Memory Electrical Characteristics** Topr value modified
		50	• **Table 5.7 Voltage Detection Circuit Electrical Characteristics** VCC1 value modified
		58	• **Figure 5.4 VCC1=VCC2=5V Timing Diagram (2)** Diagram modified
		61	• **Table 5.24 Electrical Characteristics** ICC standard value revised
		63	• **Table 5.28 Memory Expansion Mode and Microprocessor Mode** tac1(AD-DB) expression modified
		75	• **Table 5.44 Electrical Characteristics** ICC standard value revised
		78	• **Table 5.47 Flash Memory Electrical Characteristics** Topr value modified
1.21	Jul.08, 2005		**Special Function Register (SFR)**
		37	• The TCSPR register Value after reset modified
			Electrical Characteristics
		45	• **Table 5.2 Electrical Characteristics** Parameter f(BCLK) and its values added
		51	• **Table 5.10 Memory Expansion Mode and Microprocessor Mode** *tac1(RD-DB)* expression on Note 1 modified; *tac2(RD-DB)* expression on Note 1 added

Rev.	Date	Description	
		Page	Summary
		57	• **Figure 5.3 V_{CC1}=V_{CC2}=5V Timing Diagram (1)** *tw(ER)* expression on Note 3 modified; *tcyc* expression added
		58	• **Figure 5.4 V_{CC1}=V_{CC2}=5V Timing Diagram (2)** *tac2(AD-DB)* expression on Note 1 modified; *th(ALE-AD)* expressions on Notes 1 and 2 modified; *tcyc* expression added
		63	• **Table 5.28 Memory Expansion Mode and Microprocessor Mode** *tac1(RD-DB)* expression on Note 1 modified; *tac2(RD-DB)* expression on Note 1 added
		68	• **Figure 5.7 V_{CC1}=V_{CC2}=3.3V Timing Diagram (1)** *tw(ER)* expression on Note 3 modified; *tcyc* expression added
		69	• **Figure 5.8 V_{CC1}=V_{CC2}=3.3V Timing Diagram (2)** *tac2(RD-DB)* expression on Note 1 modified; *th(ALE-AD)* expressions on Notes 1 and 2 modified; *th(WR-CS)* expression on Note 2 modified; *tcyc* expression added
		74	• **Table 5.43 Electrical Characteristics** Parameter f(BCLK) and its values added
		78	• **Table 5.47 Flash Memory Version Electrical Characteristics** Mesurement condition changed

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